Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

Send any inquiries to http://www.renesas.com/inquiry.



Notice

- 1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
- Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights
 of third parties by or arising from the use of Renesas Electronics products or technical information described in this document.
 No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights
 of Renesas Electronics or others.
- 3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
- 4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- 5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
- 6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
- 7. Renesas Electronics products are classified according to the following three quality grades: "Standard", "High Quality", and "Specific". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as "Specific" without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as "Specific" or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is "Standard" unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.
 - "Specific": Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
- 8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
- 9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
- 10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.
- (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note: Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp. Customer Support Dept. April 1, 2003



MITSUBISHI MICROCOMPUTERS 4513/4514 Group

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

DESCRIPTION

The 4513/4514 Group is a 4-bit single-chip microcomputer designed with CMOS technology. Its CPU is that of the 4500 series using a simple, high-speed instruction set. The computer is equipped with serial I/O, four 8-bit timers (each timer has a reload register), and 10-bit A-D converter.

The various microcomputers in the 4513/4514 Group include variations of the built-in memory type and package as shown in the table below.

FEATURES

- Supply voltage
- Middle-speed mode
 - 2.5 V to 5.5 V (at 4.2 MHz oscillation frequency, for Mask ROM version and One Time PROM version)
 - 2.0 V to 5.5 V (at 3.0 MHz oscillation frequency, for Mask ROM version)
 - (Operation voltage of A-D conversion: 2.7 V to 5.5 V)
- High-speed mode
 - 4.0 V to 5.5 V (at 4.2 MHz oscillation frequency, for Mask ROM version and One Time PROM version)
 - 2.5 V to 5.5 V (at 2.0 MHz oscillation frequency, for Mask ROM version and One Time PROM version)
 - 2.0 V to 5.5 V (at 1.5 MHz oscillation frequency, for Mask ROM version)

(Operation voltage of A-D conversion: 2.7 V to 5.5 V)

Timer 1	8-bit timer with a reload register
Timer 2	8-bit timer with a reload register
Timer 3	8-bit timer with a reload register
Timer 4	8-bit timer with a reload register
●Interrupt	8 sources
●Serial I/O	8 bit-wide

- Voltage drop detection circuit
- Clock generating circuit (ceramic resonator)
- ●LED drive directly enabled (port D)

APPLICATION

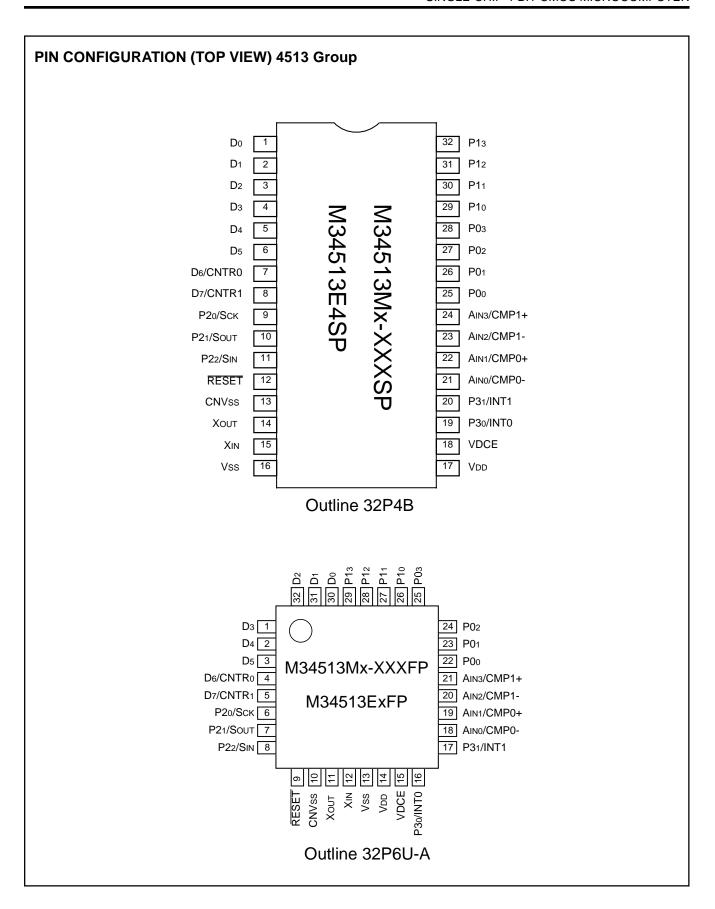
Timers

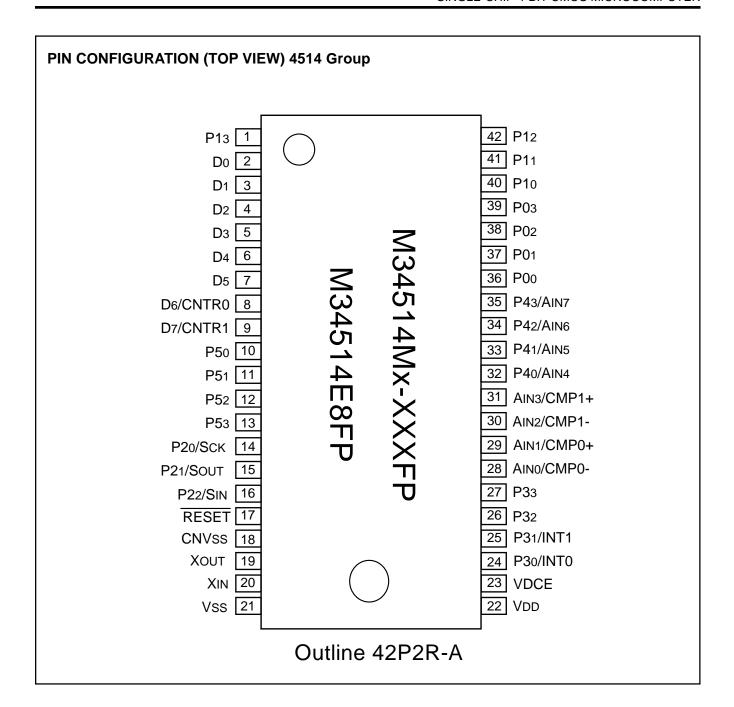
Electrical household appliance, consumer electronic products, office automation equipment, etc.

Product	ROM (PROM) size (X 10 bits)	RAM size (X 4 bits)	Package	ROM type
M34513M2-XXXSP/FP	2048 words	128 words	SP: 32P4B FP: 32P6U-A	Mask ROM
M34513M4-XXXSP/FP	4096 words	256 words	SP: 32P4B FP: 32P6U-A	Mask ROM
M34513E4SP/FP (Note)	4096 words	256 words	SP: 32P4B FP: 32P6U-A	One Time PROM
M34513M6-XXXFP	6144 words	384 words	32P6U-A	Mask ROM
M34513M8-XXXFP	8192 words	384 words	32P6U-A	Mask ROM
M34513E8FP (Note)	8192 words	384 words	32P6U-A	One Time PROM
M34514M6-XXXFP	6144 words	384 words	42P2R-A	Mask ROM
M34514M8-XXXFP	8192 words	384 words	42P2R-A	Mask ROM
M34514E8FP (Note)	8192 words	384 words	42P2R-A	One Time PROM

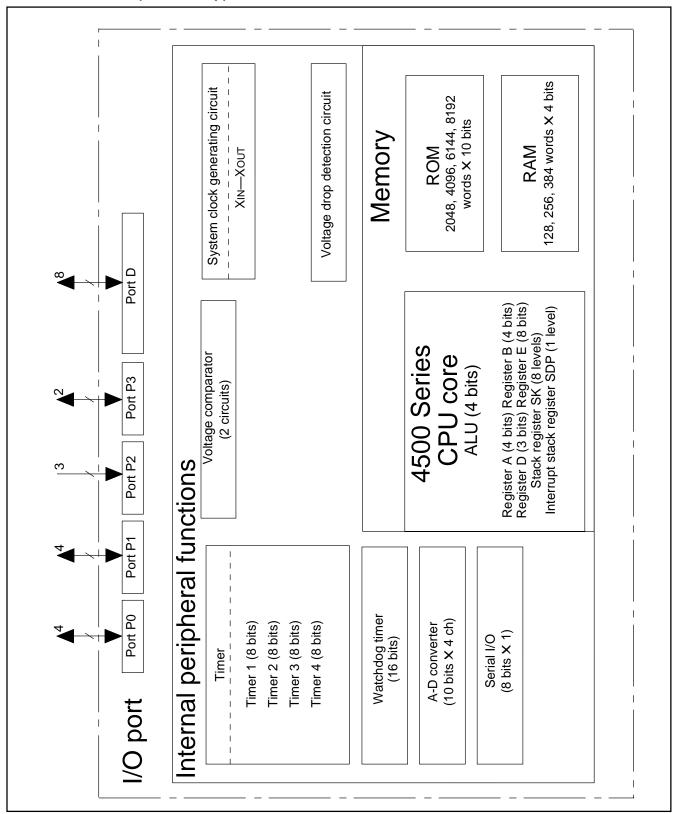
Note: shipped in blank



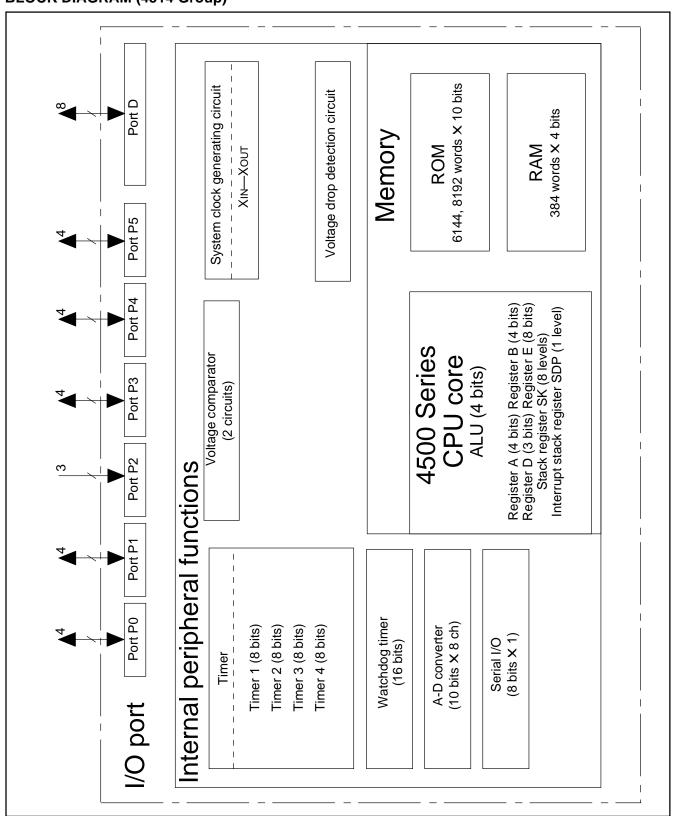




BLOCK DIAGRAM (4513 Group)



BLOCK DIAGRAM (4514 Group)



PERFORMANCE OVERVIEW

	Paramete	r	Function			
Number of 4513 Group		4513 Group	123			
basic instructions 4514 Group			128			
Minimum instruction execution time			0.75 μs (at 4.0 MHz oscillation frequency, in high-speed mode)			
Memory sizes		M34513M2	2048 words X 10 bits			
		M34513M4/E4				
		M34513M6	6144 words X 10 bits			
			8192 words X 10 bits			
		M34514M6	6144 words X 10 bits			
			8192 words X 10 bits			
	RAM	M34513M2	128 words X 4 bits			
	I W dw	M34513M4/E4				
		M34513M6	384 words X 4 bits			
			384 words X 4 bits			
		M34514M6	384 words X 4 bits			
La sa est / Oceation est	Do D7	M34514M8/E8				
Input/Output ports	D0-D7	I/O (Input is examined by skip decision)	Eight independent I/O ports; ports D6 and D7 are also used as CNTR0 and CNTR1, respectively.			
	P00-P03	I/O	4-bit I/O port; each pin is equipped with a pull-up function and a key-on wakeup function. Both functions can be switched by software.			
	P10-P13	I/O	4-bit I/O port; each pin is equipped with a pull-up function and a key-on wakeup function. Both functions can be switched by software.			
	P20-P22	Input	3-bit input port; ports P20, P21 and P22 are also used as SCK, SOUT and SIN, respectively.			
	P30-P33	I/O	4-bit I/O port (2-bit I/O port for the 4513 Group); ports P30 and P31 are also used as INT0 and INT1, respectively. The 4513 Group does not have ports P32, P33.			
	P40-P43	I/O	4-bit I/O port; The 4513 Group does not have this port.			
	P50-P53	I/O	4-bit I/O port with a direction register; The 4513 Group does not have this port.			
	CNTR0	I/O	1-bit I/O; CNTR0 pin is also used as port D6.			
	CNTR1	I/O	1-bit I/O; CNTR1 pin is also used as port D7.			
	INT0	Input	1-bit input; INT0 pin is also used as port P30 and equipped with a key-on wakeup function.			
	INT1	Input	1-bit input; INT1 pin is also used as port P31 and equipped with a key-on wakeup function.			
Timers	Timer 1		8-bit programmable timer with a reload register.			
	Timer 2		8-bit programmable timer with a reload register is also used as an event counter.			
	Timer 3		8-bit programmable timer with a reload register.			
	Timer 4		8-bit programmable timer with a reload register is also used as an event counter.			
A-D converter	•		10-bit wide, This is equipped with an 8-bit comparator function.			
Voltage compa	arator		2 circuits (CMP0, CMP1)			
Serial I/O			8-bit X 1			
Interrupt	Sources		8 (two for external, four for timer, one for A-D, and one for serial I/O)			
	Nesting		1 level			
Subroutine nes			8 levels			
Device structu			CMOS silicon gate			
Package	4513 Gro	up	32-pin plastic molded SDIP (32P4B)/LQFP(32P6U-A)			
. a.c.i.g.	4514 Gro		42-pin plastic molded SSOP (42P2R-A)			
Operating temperature range		·	-20 °C to 85 °C			
Supply voltage		<u></u>	2.0 V to 5.5 V for Mask ROM version, 2.5 V to 5.5 V for One Time PROM version (Refer to the electrical characteristics because the supply voltage depends on the oscillation frequency.)			
Power dissipation	Active mo	ode	1.8 mA (at VDD = 5.0 V, 4.0 MHz oscillation frequency, in middle- speed mode, output transistors in the cut-off state)			
(typical value)			3.0 mA (at VDD = 5.0 V, 4.0 MHz oscillation frequency, in high-speed mode, output transistors in the cut-off state)			
	RAM bac	k-up mode	0.1 μ A (at room temperature, VDD = 5 V, output transistors in the cut-off state)			



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

PIN DESCRIPTION

Pin	Name	Input/Output	Function
VDD	Power supply	_	Connected to a plus power supply.
Vss	Ground	_	Connected to a 0 V power supply.
VDCE	Voltage drop detection circuit enable	Input	VDCE pin is used to control the operation/stop of the voltage drop detection circuit. When "H" level is input to this pin, the circuit is operating. When "L" level is input to this pin, the circuit is stopped.
CNVss	CNVss	_	Connect CNVss to Vss and apply "L" (0V) to CNVss certainly.
RESET	Reset input	I/O	An N-channel open-drain I/O pin for a system reset. When the watchdog timer causes the system to be reset or system reset is performed by the voltage drop detection circuit, the RESET pin outputs "L" level.
XIN	System clock input	Input	I/O pins of the system clock generating circuit. XIN and XOUT can be connected to
Xout	System clock output	Output	ceramic resonator. A feedback resistor is built-in between them.
D0-D7	I/O port D (Input is examined by skip decision.)	I/O	Each pin of port D has an independent 1-bit wide I/O function. Each pin has an output latch. For input use, set the latch of the specified bit to "1." The output structure is N-channel open-drain. Ports D6 and D7 are also used as CNTR0 and CNTR1, respectively.
P00-P03	I/O port P0	I/O	Each of ports P0 and P1 serves as a 4-bit I/O port, and it can be used as inputs when the output latch is set to "1." The output structure is N-channel open-drain.
P10-P13	I/O port P1	I/O	Every pin of the ports has a key-on wakeup function and a pull-up function. Both functions can be switched by software.
P20-P22	Input port P2	Input	3-bit input port. Ports P20, P21 and P22 are also used as SCK, SOUT and SIN, respectively.
P30-P33	I/O port P3	I/O	4-bit I/O port (2-bit I/O port for the 4513 Group). For input use, set the latch of the specified bit to "1." The output structure is N-channel open-drain. Ports P30 and P31 are also used as INT0 and INT1, respectively. The 4513 Group does not have ports P32, P33.
P40-P43	I/O port P4	I/O	4-bit I/O port. For input use, set the latch of the specified bit to "1." The output structure is N-channel open-drain. Ports P40–P43 are also used as analog input pins AIN4–AIN7, respectively. The 4513 Group does not have port P4.
P50-P53	I/O port P5	I/O	4-bit I/O port. Each pin has a direction register and an independent 1-bit wide I/O function. For input use, set the direction register to "0." For output use, set the direction regiser to "1." The output structure is CMOS. The 4513 Group does not have port P5.
AIN0-AIN7	Analog input	Input	Analog input pins for A-D converter. AIN0–AIN3 are also used as voltage comparator input pins and AIN4–AIN7 are also used as port P4. The 4513 Group does not have AIN4–AIN7.
CNTR0	Timer input/output	I/O	CNTR0 pin has the function to input the clock for the timer 2 event counter, and to output the timer 1 underflow signal divided by 2. CNTR0 pin is also used as port D6.
CNTR1	Timer input/output	I/O	CNTR1 pin has the function to input the clock for the timer 4 event counter, and to output the timer 3 underflow signal divided by 2. CNTR1 pin is also used as port D7.
INTO, INT1	Interrupt input	Input	INT0, INT1 pins accept external interrupts. They also accept the input signal to return the system from the RAM back-up state. INT0, INT1 pins are also used as ports P30 and P31, respectively.
SIN	Serial data input	Input	SIN pin is used to input serial data signals by software. SIN pin is also used as port P22.
Sout	Serial data output	Output	Sout pin is used to output serial data signals by software. Sout pin is also used as port P21.
Sck	Serial I/O clock input/output	I/O	SCK pin is used to input and output synchronous clock signals for serial data transfer by software. SCK pin is also used as port P20.
CMP0- CMP0+	Voltage comparator input	Input	CMP0-, CMP0+ pins are used as the voltage comparator input pin when the voltage comparator function is selected by software. CMP0-, CMP0+ pins are also used as AIN0 and AIN1.
CMP1- CMP1+	Voltage comparator input	Input	CMP1-, CMP1+ pins are used as the voltage comparator input pin when the voltage comparator function is selected by software. CMP1-, CMP1+ pins are also used as AIN2 and AIN3.



MULTIFUNCTION

Pin	Multifunction	Pin	Multifunction	Pin	Multifunction	Pin	Multifunction
D6	CNTR0	CNTR0	D6	AIN0	CMP0-	CMP0-	AIN0
D7	CNTR1	CNTR1	D7	AIN1	CMP0+	CMP0+	AIN1
P20	Sck	Sck	P20	AIN2	CMP1-	CMP1-	AIN2
P21	Sout	Sout	P21	AIN3	CMP1+	CMP1+	AIN3
P22	SIN	SIN	P22	P40	AIN4	AIN4	P40
P30	INT0	INT0	P30	P41	AIN5	AIN5	P41
P31	INT1	INT1	P31	P42	AIN6	AIN6	P42
				P43	AIN7	AIN7	P43

Notes 1: Pins except above have just single function.

- 2: The input of D6, D7, P20–P22, CMP0-, CMP0+, CMP1-, CMP1+ and the input/output of P30, P31, P40–P43 can be used even when CNTR0, CNTR1, SCK, SOUT, SIN, INT0, INT1, and AIN0–AIN7 are selected.
- 3: The 4513 Group does not have P40/AIN4-P43/AIN7.

CONNECTIONS OF UNUSED PINS

Pin	Connection
Хоит	Open (when using an external clock).
VDCE	Connect to Vss.
D0-D5 D6/CNTR0 D7/CNTR1	Connect to Vss, or set the output latch to "0" and open.
P20/SCK P21/SOUT P22/SIN	Connect to Vss.
P30/INT0 P31/INT1 P32, P33	Connect to Vss, or set the output latch to "0" and open.
P40/AIN4-P43/AIN7	Connect to Vss, or set the output latch to "0" and open.
P50–P53 (Note 1)	When the input mode is selected by software, pull-up to VDD through a resistor or pull-down to VDD. When selecting the output mode, open.
AIN0/CMP0- AIN1/CMP0+ AIN2/CMP1- AIN3/CMP1+	Connect to Vss.
P00-P03	Open or connect to Vss (Note 2)
P10-P13	Open or connect to Vss (Note 2)

Notes 1: After system is released from reset, port P5 is in an input mode (direction register FR0 = 00002)

2: When the P00–P03 and P10–P13 are connected to Vss, turn off their pull-up transistors (register PU0i="0") and also invalidate the key-on wakeup functions (register K0i="0") by software. When these pins are connected to Vss while the key-on wakeup functions are left valid, the system fails to return from RAM back-up state. When these pins are open, turn on their pull-up transistors (register PU0i="1") by software, or set the output latch to "0." Be sure to select the key-on wakeup functions and the pull-up functions with every two pins. If only one of the two pins for the key-on wakeup function is used, turn on their pull-up transistors by software and also disconnect the other pin. (i = 0, 1, 2, or 3.)

(Note when the output latch is set to "0" and pins are open)

- After system is released from reset, port is in a high-impedance state until it is set the output latch to "0" by software. Accordingly, the voltage level of pins is undefined and the excess of the supply current may occur while the port is in a high-impedance state.
- To set the output latch periodically by software is recommended because value of output latch may change by noise or a program run away (caused by noise).

(Note when connecting to Vss and VDD)

 Connect the unused pins to Vss and VDD using the thickest wire at the shortest distance against noise.



PORT FUNCTION

Port	Pin	Input Output	Output structure	I/O unit	Control instructions	Control registers	Remark
Port D	D0-D5 D6/CNTR0 D7/CNTR1	I/O (8)	N-channel open-drain	1	SD, RD SZD CLD	W6	
Port P0	P00-P03	I/O (4)	N-channel open-drain	4	OP0A IAP0	PU0, K0	Built-in programmable pull-up functions Key-on wakeup functions (programmable)
Port P1	P10-P13	I/O (4)	N-channel open-drain	4	OP1A IAP1	PU0, K0	Built-in programmable pull-up functions Key-on wakeup functions (programmable)
Port P2	P20/SCK P21/SOUT P22/SIN	Input (3)		3	IAP2	J1	
Port P3 (Note 1)	P30/INT0 P31/INT1 P32, P33	I/O (4)	N-channel open-drain	4	OP3A IAP3	l1, l2	Built-in key-on wakeup function (P30/INT0, P31/INT1)
Port P4 (Note 2)	P40/AIN4 -P43/AIN7	I/O (4)	N-channel open-drain	4	OP4A IAP4	Q2	
Port P5 (Note 2)	P50-P53	I/O (4)	CMOS	4	OP5A IAP5	FR0	

Notes 1: The 4513 Group does not have P32 and P33.

DEFINITION OF CLOCK AND CYCLE

System clock

The system clock is the basic clock for controlling this product. The system clock is selected by the bit 3 of the clock control register MR.

Table Selection of system clock

Register MR MR3	System clock	
0	f(XIN)	
1	f(XIN)/2	

Note: f(XIN)/2 is selected after system is released from reset.

Instruction clock

The instruction clock is a signal derived by dividing the system clock by 3. The one instruction clock cycle generates the one machine cycle.

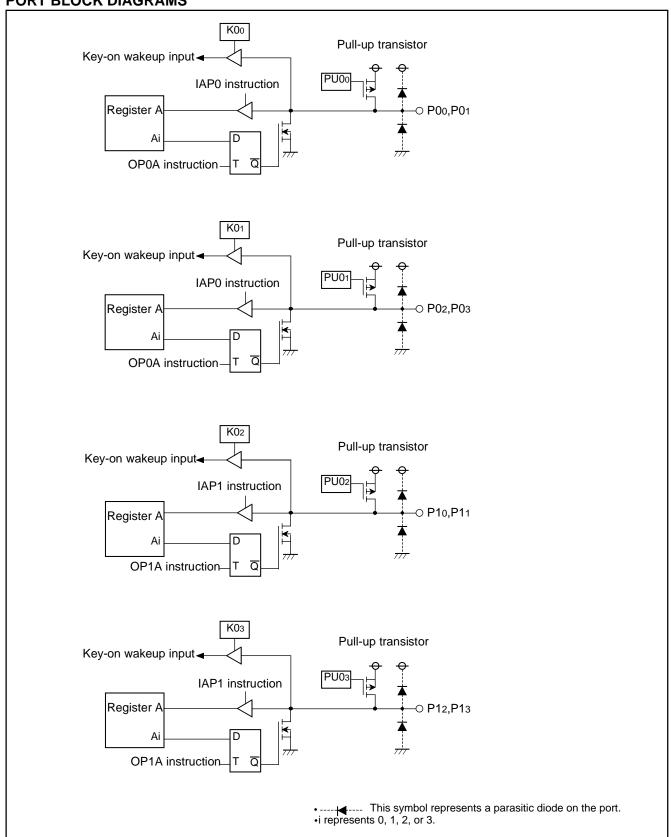
Machine cycle

The machine cycle is the standard cycle required to execute the instruction.



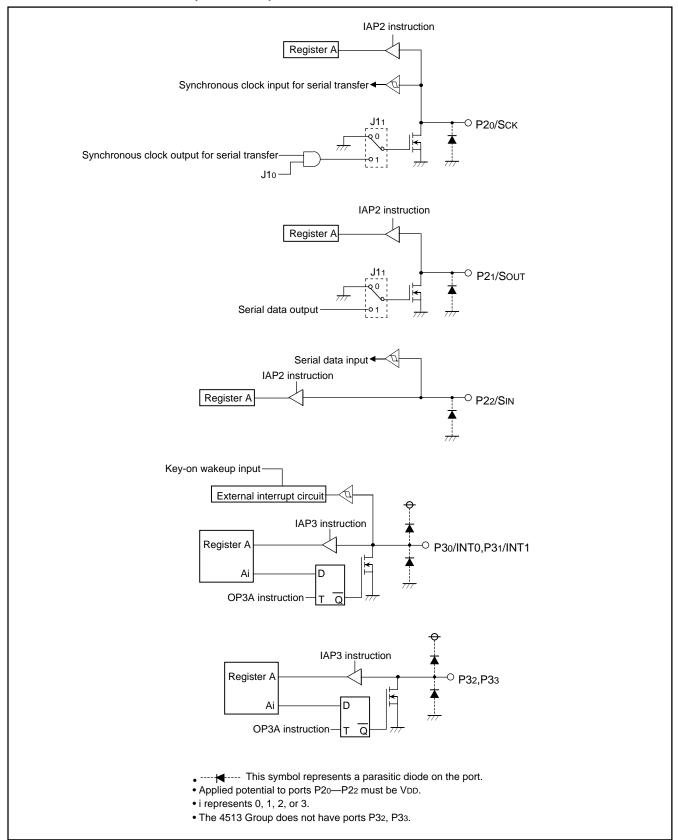
^{2:} The 4513 Group does not have these ports.

PORT BLOCK DIAGRAMS

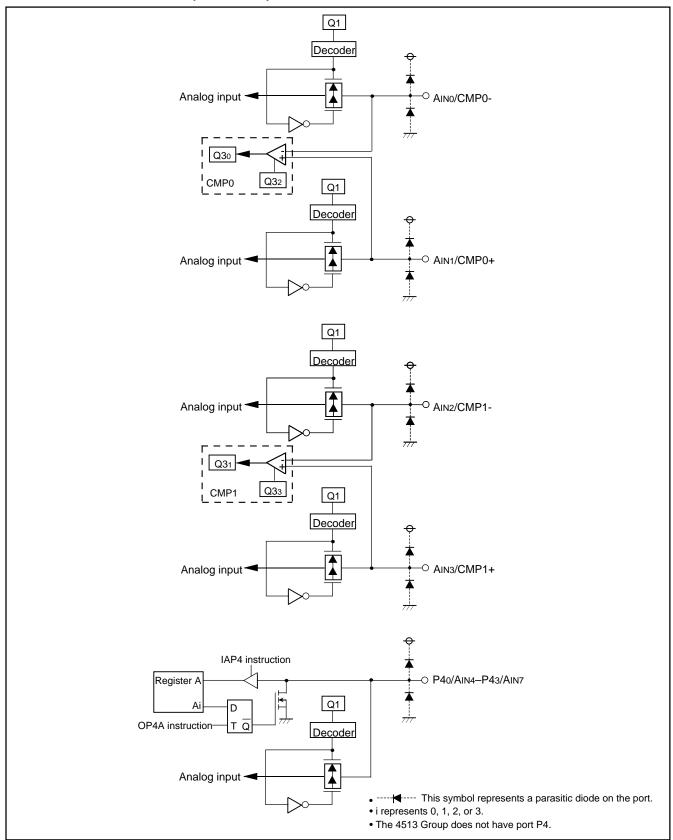




PORT BLOCK DIAGRAMS (continued)

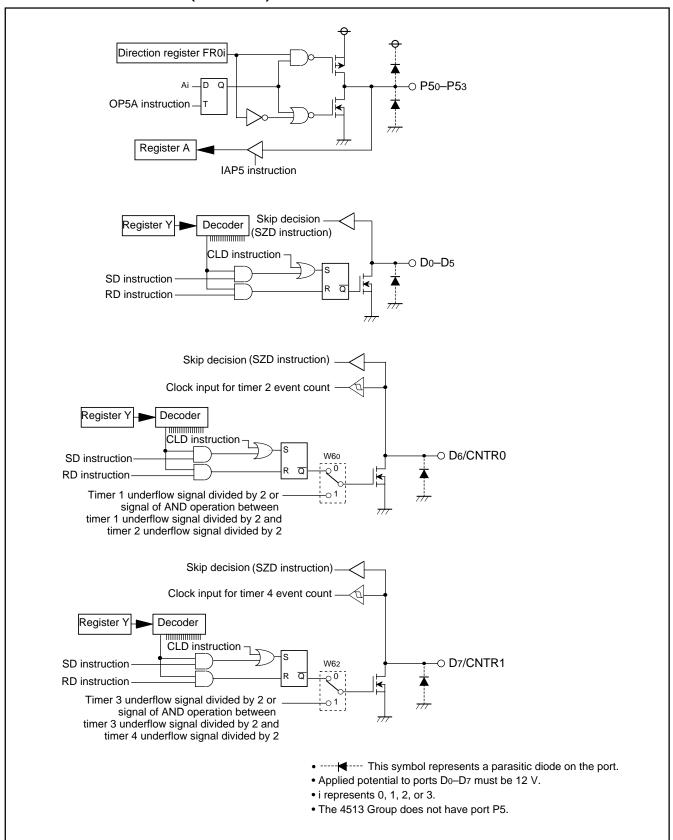


PORT BLOCK DIAGRAMS (continued)

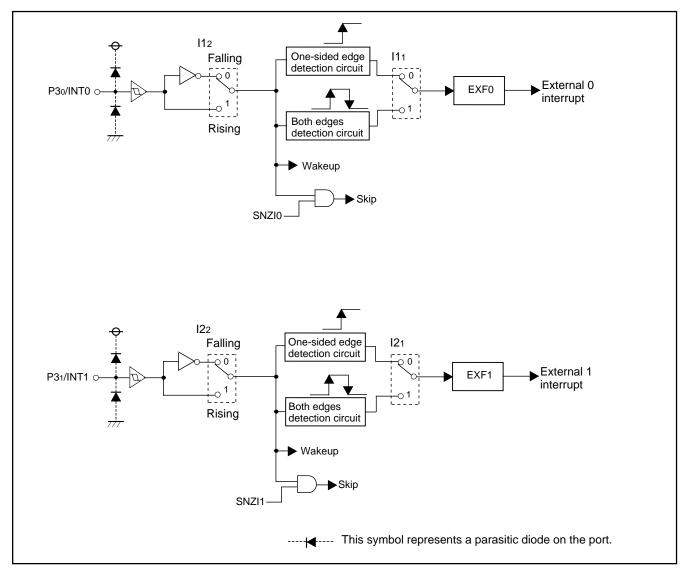




PORT BLOCK DIAGRAMS (continued)







External interrupt circuit structure

FUNCTION BLOCK OPERATIONS CPU

(1) Arithmetic logic unit (ALU)

The arithmetic logic unit ALU performs 4-bit arithmetic such as 4-bit data addition, comparison, AND operation, OR operation, and bit manipulation.

(2) Register A and carry flag

Register A is a 4-bit register used for arithmetic, transfer, exchange, and I/O operation.

Carry flag CY is a 1-bit flag that is set to "1" when there is a carry with the AMC instruction (Figure 1).

It is unchanged with both A n instruction and AM instruction. The value of Ao is stored in carry flag CY with the RAR instruction (Figure 2).

Carry flag CY can be set to "1" with the SC instruction and cleared to "0" with the RC instruction.

(3) Registers B and E

Register B is a 4-bit register used for temporary storage of 4-bit data, and for 8-bit data transfer together with register A.

Register E is an 8-bit register. It can be used for 8-bit data transfer with register B used as the high-order 4 bits and register A as the low-order 4 bits (Figure 3).

(4) Register D

Register D is a 3-bit register.

It is used to store a 7-bit ROM address together with register A and is used as a pointer within the specified page when the TABP p, BLA p, or BMLA p instruction is executed (Figure 4).

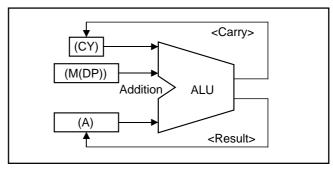


Fig. 1 AMC instruction execution example

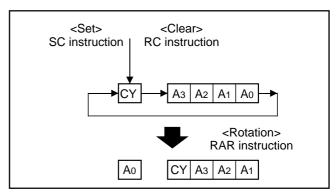


Fig. 2 RAR instruction execution example

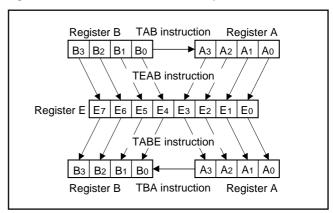


Fig. 3 Registers A, B and register E

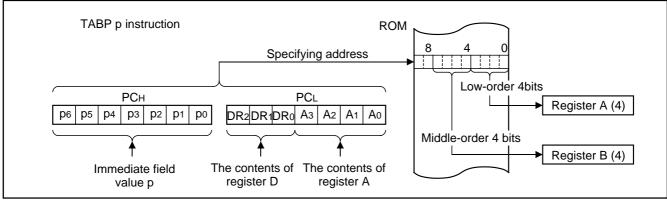


Fig. 4 TABP p instruction execution example



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(5) Stack registers (SKs) and stack pointer (SP)

Stack registers (SKs) are used to temporarily store the contents of program counter (PC) just before branching until returning to the original routine when;

- branching to an interrupt service routine (referred to as an interrupt service routine),
- · performing a subroutine call, or
- executing the table reference instruction (TABP p).

Stack registers (SKs) are eight identical registers, so that subroutines can be nested up to 8 levels. However, one of stack registers is used respectively when using an interrupt service routine and when executing a table reference instruction. Accordingly, be careful not to over the stack when performing these operations together. The contents of registers SKs are destroyed when 8 levels are exceeded.

The register SK nesting level is pointed automatically by 3-bit stack pointer (SP). The contents of the stack pointer (SP) can be transferred to register A with the TASP instruction.

Figure 5 shows the stack registers (SKs) structure.

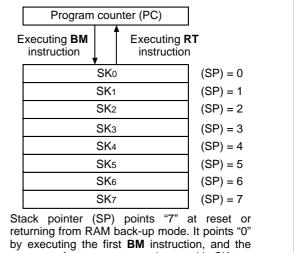
Figure 6 shows the example of operation at subroutine call.

(6) Interrupt stack register (SDP)

Interrupt stack register (SDP) is a 1-stage register. When an interrupt occurs, this register (SDP) is used to temporarily store the contents of data pointer, carry flag, skip flag, register A, and register B just before an interrupt until returning to the original routine. Unlike the stack registers (SKs), this register (SDP) is not used when executing the subroutine call instruction and the table reference instruction.

(7) Skip flag

Skip flag controls skip decision for the conditional skip instructions and continuous described skip instructions. When an interrupt occurs, the contents of skip flag is stored automatically in the interrupt stack register (SDP) and the skip condition is retained.



returning from RAM back-up mode. It points "0" by executing the first **BM** instruction, and the contents of program counter is stored in SKo. When the **BM** instruction is executed after eight stack registers are used ((SP) = 7), (SP) = 0 and the contents of SKo is destroyed.

Fig. 5 Stack registers (SKs) structure

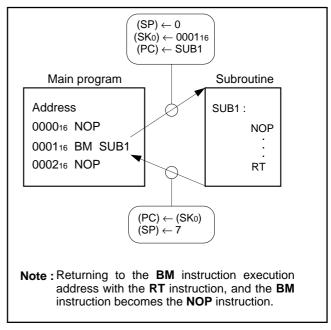


Fig. 6 Example of operation at subroutine call



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(8) Program counter (PC)

Program counter (PC) is used to specify a ROM address (page and address). It determines a sequence in which instructions stored in ROM are read. It is a binary counter that increments the number of instruction bytes each time an instruction is executed. However, the value changes to a specified address when branch instructions, subroutine call instructions, return instructions, or the table reference instruction (TABP p) is executed.

Program counter consists of PCH (most significant bit to bit 7) which specifies to a ROM page and PCL (bits 6 to 0) which specifies an address within a page. After it reaches the last address (address 127) of a page, it specifies address 0 of the next page (Figure 7).

Make sure that the PCH does not specify after the last page of the built-in ROM.

(9) Data pointer (DP)

Data pointer (DP) is used to specify a RAM address and consists of registers Z, X, and Y. Register Z specifies a RAM file group, register X specifies a file, and register Y specifies a RAM digit (Figure 8)

Register Y is also used to specify the port D bit position.

When using port D, set the port D bit position to register Y certainly and execute the SD, RD, or SZD instruction (Figure 9).

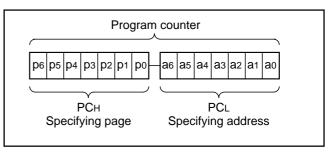


Fig. 7 Program counter (PC) structure

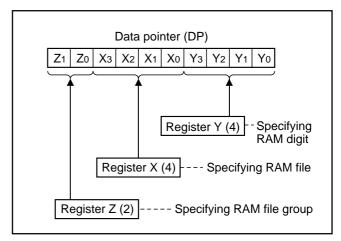


Fig. 8 Data pointer (DP) structure

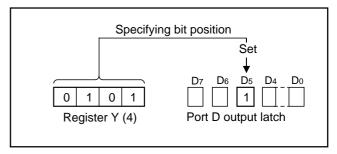


Fig. 9 SD instruction execution example



PROGRAM MEMOY (ROM)

The program memory is a mask ROM. 1 word of ROM is composed of 10 bits. ROM is separated every 128 words by the unit of page (addresses 0 to 127). Table 1 shows the ROM size and pages. Figure 10 shows the ROM map of M34514M8/E8.

Table 1 ROM size and pages

Product	ROM size (X 10 bits)	Pages
M34513M2	2048 words	16 (0 to 15)
M34513M4/E4	4096 words	32 (0 to 31)
M34513M6	6144 words	48 (0 to 47)
M34513M8/E8	8192 words	64 (0 to 63)
M34514M6	6144 words	48 (0 to 47)
M34514M8/E8	8192 words	64 (0 to 63)

A part of page 1 (addresses 008016 to 00FF16) is reserved for interrupt addresses (Figure 11). When an interrupt occurs, the address (interrupt address) corresponding to each interrupt is set in the program counter, and the instruction at the interrupt address is executed. When using an interrupt service routine, write the instruction generating the branch to that routine at an interrupt address.

Page 2 (addresses 010016 to 017F16) is the special page for subroutine calls. Subroutines written in this page can be called from any page with the 1-word instruction (BM). Subroutines extending from page 2 to another page can also be called with the BM instruction when it starts on page 2.

ROM pattern (bits 7 to 0) of all addresses can be used as data areas with the TABP p instruction.

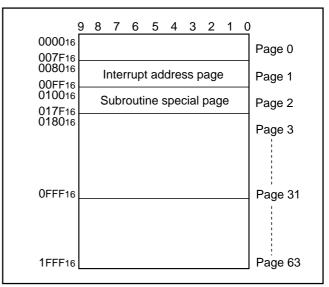


Fig. 10 ROM map of M34514M8/E8

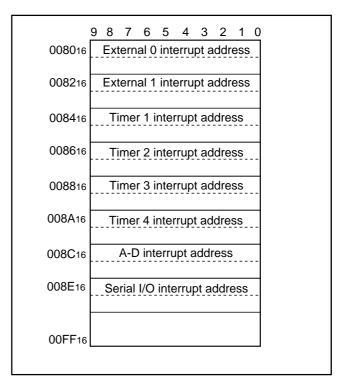


Fig. 11 Page 1 (addresses 008016 to 00FF16) structure



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

DATA MEMORY (RAM)

1 word of RAM is composed of 4 bits, but 1-bit manipulation (with the SB j, RB j, and SZB j instructions) is enabled for the entire memory area. A RAM address is specified by a data pointer. The data pointer consists of registers Z, X, and Y. Set a value to the data pointer certainly when executing an instruction to access RAM.

Table 2 shows the RAM size. Figure 12 shows the RAM map.

Table 2 RAM size

Product	RAM size
M34513M2	128 words X 4 bits (512 bits)
M34513M4/E4	256 words X 4 bits (1024 bits)
M34513M6	384 words X 4 bits (1536 bits)
M34513M8/E8	384 words X 4 bits (1536 bits)
M34514M6	384 words X 4 bits (1536 bits)
M34514M8/E8	384 words X 4 bits (1536 bits)

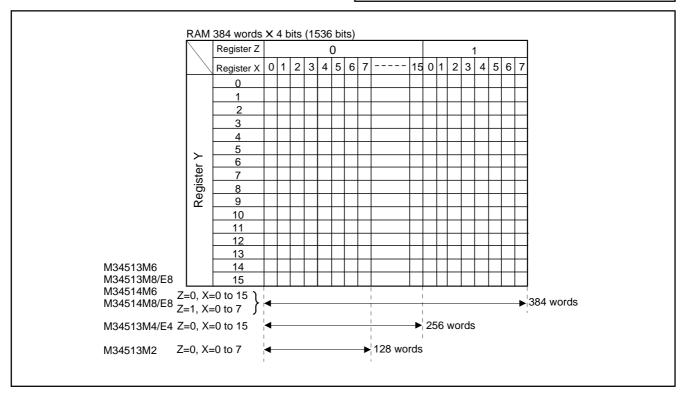


Fig. 12 RAM map



INTERRUPT FUNCTION

The interrupt type is a vectored interrupt branching to an individual address (interrupt address) according to each interrupt source. An interrupt occurs when the following 3 conditions are satisfied.

- An interrupt activated condition is satisfied (request flag = "1")
- Interrupt enable bit is enabled ("1")
- Interrupt enable flag is enabled (INTE = "1")

Table 3 shows interrupt sources. (Refer to each interrupt request flag for details of activated conditions.)

(1) Interrupt enable flag (INTE)

The interrupt enable flag (INTE) controls whether the every interrupt enable/disable. Interrupts are enabled when INTE flag is set to "1" with the EI instruction and disabled when INTE flag is cleared to "0" with the DI instruction. When any interrupt occurs, the INTE flag is automatically cleared to "0," so that other interrupts are disabled until the EI instruction is executed.

(2) Interrupt enable bit

Use an interrupt enable bit of interrupt control registers V1 and V2 to select the corresponding interrupt or skip instruction.

Table 4 shows the interrupt request flag, interrupt enable bit and skip instruction.

Table 5 shows the interrupt enable bit function.

(3) Interrupt request flag

When the activated condition for each interrupt is satisfied, the corresponding interrupt request flag is set to "1." Each interrupt request flag is cleared to "0" when either;

- an interrupt occurs, or
- the next instruction is skipped with a skip instruction.

Each interrupt request flag is set when the activated condition is satisfied even if the interrupt is disabled by the INTE flag or its interrupt enable bit. Once set, the interrupt request flag retains set until a clear condition is satisfied.

Accordingly, an interrupt occurs when the interrupt disable state is released while the interrupt request flag is set.

If more than one interrupt request flag is set when the interrupt disable state is released, the interrupt priority level is as follows shown in Table 3.

Table 3 Interrupt sources

Priority level	Interrupt name	Activated condition	Interrupt address
1	External 0 interrupt	Level change of INT0 pin	Address 0 in page 1
2	External 1 interrupt	Level change of INT1 pin	Address 2 in page 1
3	Timer 1 interrupt	Timer 1 underflow	Address 4 in page 1
4	Timer 2 interrupt	Timer 2 underflow	Address 6 in page 1
5	Timer 3 interrupt	Timer 3 underflow	Address 8 in page 1
6	Timer 4 interrupt	Timer 4 underflow	Address A in page 1
7	A-D interrupt	Completion of A-D conversion	Address C in page 1
8	Serial I/O interrupt	Completion of serial I/O transfer	Address E in page 1

Table 4 Interrupt request flag, interrupt enable bit and skip instruction

Interrupt name	Request flag	Skip instruction	Enable bit
External 0 interrupt	EXF0	SNZ0	V10
External 1 interrupt	EXF1	SNZ1	V11
Timer 1 interrupt	T1F	SNZT1	V12
Timer 2 interrupt	T2F	SNZT2	V13
Timer 3 interrupt	T3F	SNZT3	V20
Timer 4 interrupt	T4F	SNZT4	V21
A-D interrupt	ADF	SNZAD	V22
Serial I/O interrupt	SIOF	SNZSI	V23

Table 5 Interrupt enable bit function

Interrupt enable bit	Occurrence of interrupt	Skip instruction
1	Enabled	Invalid
0	Disabled	Valid



(4) Internal state during an interrupt

The internal state of the microcomputer during an interrupt is as follows (Figure 14).

- Program counter (PC)
 - An interrupt address is set in program counter. The address to be executed when returning to the main routine is automatically stored in the stack register (SK).
- Interrupt enable flag (INTE)
 INTE flag is cleared to "0" so that interrupts are disabled.
- Interrupt request flag
 Only the request flag for the current interrupt source is cleared to "0."
- Data pointer, carry flag, skip flag, registers A and B
 The contents of these registers and flags are stored automatically in the interrupt stack register (SDP).

(5) Interrupt processing

When an interrupt occurs, a program at an interrupt address is executed after branching a data store sequence to stack register. Write the branch instruction to an interrupt service routine at an interrupt address.

Use the RTI instruction to return from an interrupt service routine. Interrupt enabled by executing the EI instruction is performed after executing 1 instruction (just after the next instruction is executed). Accordingly, when the EI instruction is executed just before the RTI instruction, interrupts are enabled after returning the main routine. (Refer to Figure 13)

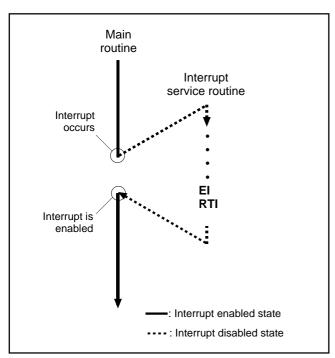


Fig. 13 Program example of interrupt processing

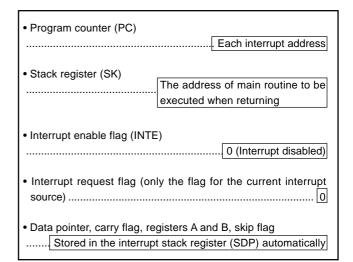


Fig. 14 Internal state when interrupt occurs

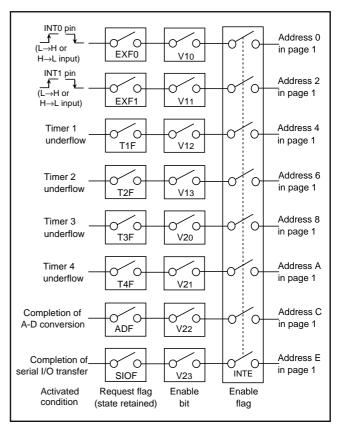


Fig. 15 Interrupt system diagram



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(6) Interrupt control registers

- Interrupt control register V1
 Interrupt enable bits of external 0, external 1, timer 1 and timer 2
 are assigned to register V1. Set the contents of this register
 through register A with the TV1A instruction. The TAV1 instruction
 can be used to transfer the contents of register V1 to register A.
- Interrupt control register V2
 Interrupt enable bits of timer 3, timer 4, A-D and serial I/O are assigned to register V2. Set the contents of this register through register A with the TV2A instruction. The TAV2 instruction can be used to transfer the contents of register V2 to register A.

Table 6 Interrupt control registers

	Interrupt control register V1	at	reset : 00002	at RAM back-up : 00002	R/W		
V13	Timer 2 interrupt enable bit	0	Interrupt disabled ((SNZT2 instruction is valid)			
V 13	Timer 2 interrupt enable bit	1	Interrupt enabled (SNZT2 instruction is invalid)				
V12	Timer 1 interrupt enable bit	0	Interrupt disabled (SNZT1 instruction is valid)				
V 12	Timer Timerrupt enable bit	1	Interrupt enabled (SNZT1 instruction is invalid)	invalid)		
V11	External 1 interrupt enable bit	0	Interrupt disabled (SNZ1 instruction is valid)				
V 11	External Tillerrupt enable bit	1	Interrupt enabled (SNZ1 instruction is invalid)			
V10	External 0 interrupt enable bit	0	Interrupt disabled ((SNZ0 instruction is valid)			
V 10	External o interrupt enable bit	1	Interrupt enabled (SNZ0 instruction is invalid)			
	Interrupt control register V2	at	reset : 00002	at RAM back-up : 00002	R/W		
V23	Social I/O interrupt anable hit	0	Interrupt disabled (SNZSI instruction is valid)				
V23	Serial I/O interrupt enable bit	1	Interrupt enabled (SNZSI instruction is invalid)				
V22	A D interrupt enable bit	0	Interrupt disabled (SNZAD instruction is valid)				
V Z Z	A-D interrupt enable bit	1	Interrupt enabled (SNZAD instruction is invalid)			
V21	Timer 4 interrupt enable bit	0	Interrupt disabled (SNZT4 instruction is valid)				
VZ1		1	Interrupt enabled (SNZT4 instruction is invalid)			
1/20	Timor 2 interrupt anable hit	0	Interrupt disabled ((SNZT3 instruction is valid)			
V20	Timer 3 interrupt enable bit		Interrupt enabled (SNZT3 instruction is invalid)			

Note: "R" represents read enabled, and "W" represents write enabled.



(7) Interrupt sequence

Interrupts only occur when the respective INTE flag, interrupt enable bits (V10–V13 and V20–V23), and interrupt request flag are "1." The interrupt actually occurs 2 to 3 machine cycles after the cycle in which all three conditions are satisfied. The interrupt oc-

curs after 3 machine cycles only when the three interrupt conditions are satisfied on execution of other than one-cycle instructions (Refer to Figure 16).

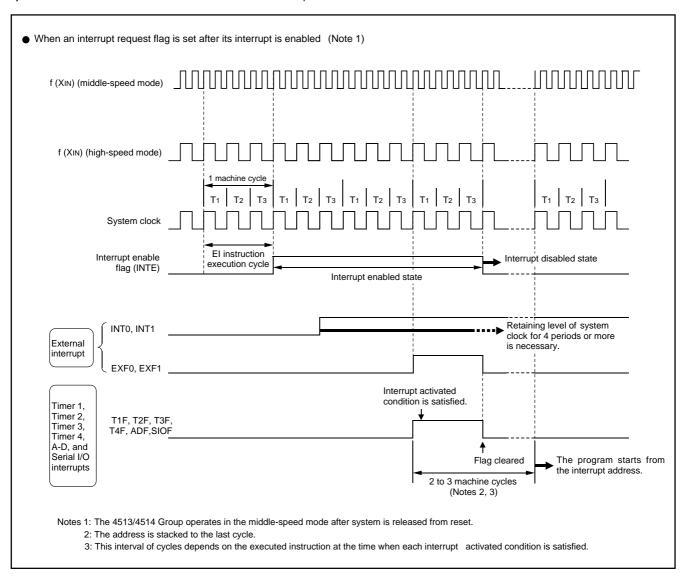


Fig. 16 Interrupt sequence



EXTERNAL INTERRUPTS

The 4513/4514 Group has two external interrupts (external 0 and external 1). An external interrupt request occurs when a valid waveform is input to an interrupt input pin (edge detection).

The external interrupts can be controlled with the interrupt control registers I1 and I2.

Table 7 External interrupt activated conditions

Name	Input pin	Activated condition	Valid waveform selection bit
External 0 interrupt	P30/INT0	When the next waveform is input to P30/INT0 pin	l111
		Falling waveform ("H"→"L")	l12
		Rising waveform ("L"→"H")	
		Both rising and falling waveforms	
External 1 interrupt	P31/INT1	When the next waveform is input to P31/INT1 pin	I21
		Falling waveform ("H"→"L")	122
		Rising waveform ("L"→"H")	
		Both rising and falling waveforms	

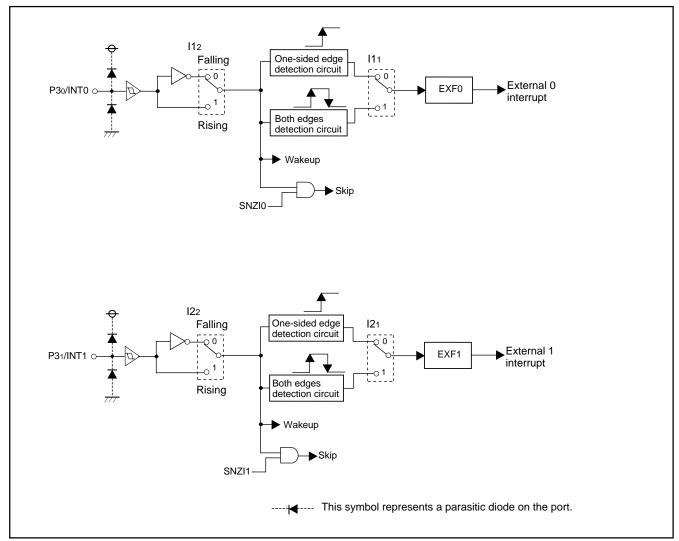


Fig. 17 External interrupt circuit structure



(1) External 0 interrupt request flag (EXF0)

External 0 interrupt request flag (EXF0) is set to "1" when a valid waveform is input to P3o/INT0 pin.

The valid waveforms causing the interrupt must be retained at their level for 4 clock cycles or more of the system clock (Refer to Figure 16).

The state of EXF0 flag can be examined with the skip instruction (SNZ0). Use the interrupt control register V1 to select the interrupt or the skip instruction. The EXF0 flag is cleared to "0" when an interrupt occurs or when the next instruction is skipped with the skip instruction

The P30/INT0 pin need not be selected the external interrupt input INT0 function or the normal I/O port P30 function. However, the EXF0 flag is set to "1" when a valid waveform is input even if it is used as an I/O port P30.

- External 0 interrupt activated condition
 - External 0 interrupt activated condition is satisfied when a valid waveform is input to P3o/INT0 pin.
 - The valid waveform can be selected from rising waveform, falling waveform or both rising and falling waveforms. An example of how to use the external 0 interrupt is as follows.
- ① Select the valid waveform with the bits 1 and 2 of register I1.
- 2 Clear the EXF0 flag to "0" with the SNZ0 instruction.
- ③ Set the NOP instruction for the case when a skip is performed with the SNZ0 instruction.
- Set both the external 0 interrupt enable bit (V10) and the INTE flag to "1."

The external 0 interrupt is now enabled. Now when a valid waveform is input to the P30/INT0 pin, the EXF0 flag is set to "1" and the external 0 interrupt occurs.

(2) External 1 interrupt request flag (EXF1)

External 1 interrupt request flag (EXF1) is set to "1" when a valid waveform is input to P31/INT1 pin.

The valid waveforms causing the interrupt must be retained at their level for 4 clock cycles or more of the system clock (Refer to Figure 16).

The state of EXF1 flag can be examined with the skip instruction (SNZ1). Use the interrupt control register V1 to select the interrupt or the skip instruction. The EXF1 flag is cleared to "0" when an interrupt occurs or when the next instruction is skipped with the skip instruction

The P31/INT1 pin need not be selected the external interrupt input INT1 function or the normal I/O port P31 function. However, the EXF1 flag is set to "1" when a valid waveform is input even if it is used as an I/O port P31.

- External 1 interrupt activated condition
 - External 1 interrupt activated condition is satisfied when a valid waveform is input to P31/INT1 pin.
 - The valid waveform can be selected from rising waveform, falling waveform or both rising and falling waveforms. An example of how to use the external 1 interrupt is as follows.
- ① Select the valid waveform with the bits 1 and 2 of register I2.
- ② Clear the EXF1 flag to "0" with the SNZ1 instruction.
- Set the NOP instruction for the case when a skip is performed
 with the SNZ1 instruction.
- Set both the external 1 interrupt enable bit (V11) and the INTE flag to "1."

The external 1 interrupt is now enabled. Now when a valid waveform is input to the P31/INT1 pin, the EXF1 flag is set to "1" and the external 1 interrupt occurs.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(3) External interrupt control registers

• Interrupt control register I1

Register I1 controls the valid waveform for the external 0 interrupt. Set the contents of this register through register A with the TI1A instruction. The TAI1 instruction can be used to transfer the contents of register I1 to register A.

• Interrupt control register I2

Register I2 controls the valid waveform for the external 1 interrupt. Set the contents of this register through register A with the TI2A instruction. The TAI2 instruction can be used to transfer the contents of register I2 to register A.

Table 8 External interrupt control registers

	Interrupt control register I1	at	reset : 00002	at RAM back-up : state retained	R/W	
l13	Not used	0	This bit has no fun	ction, but read/write is enabled.		
		1	The sit has no fariotion, sat road, while to oridinate			
	Interrupt valid waveform for INT0 pin/		Falling waveform ("L" level of INT0 pin is recognized with the SNZI0 instruction)/"L" level			
I12	return level selection bit (Note 2)	1	Rising waveform ("H" level of INT0 pin is recognized with the SNZI0 instruction)/"H" level			
		0	One-sided edge de			
l11	INT0 pin edge detection circuit control bit	1	Both edges detected			
	INT0 pin	0	Disabled	54		
I1 0	timer 1 control enable bit	1	Enabled			
	Interrupt control register I2	at	reset: 00002	at RAM back-up : state retained	R/W	
123	Not used	0	This bit has no function, but read/write is enabled			
10-	Interrupt valid waveform for INT1 pin/	0	Falling waveform (instruction)/"L" leve	"L" level of INT1 pin is recognized w	vith the SNZI1	
122	return level selection bit (Note 3)		Rising waveform ("H" level of INT1 pin is recognized with the SNZI1 instruction)/"H" level			
I2 ₁	INITA pip adge detection circuit control bit	0	One-sided edge detected			
127	INT1 pin edge detection circuit control bit	1	Both edges detected	ed		
120	INT1 pin	0	Disabled			
120	timer 3 control enable bit	1	Enabled			

Notes 1: "R" represents read enabled, and "W" represents write enabled.

- 2: When the contents of 112 is changed, the external interrupt request flag EXF0 may be set. Accordingly, clear EXF0 flag with the SNZ0 instruction.
- 3: When the contents of 122 is changed, the external interrupt request flag EXF1 may be set. Accordingly, clear EXF1 flag with the SNZ1 instruction.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

TIMERS

The 4513/4514 Group has the programmable timers.

• Programmable timer

The programmable timer has a reload register and enables the frequency dividing ratio to be set. It is decremented from a setting value n. When it underflows (count to n+1), a timer interrupt request flag is set to "1," new data is loaded from the reload register, and count continues (auto-reload function).

Fixed dividing frequency timer
 The fixed dividing frequency timer has the fixed frequency dividing ratio (n). An interrupt request flag is set to "1" after every n count of a count pulse.

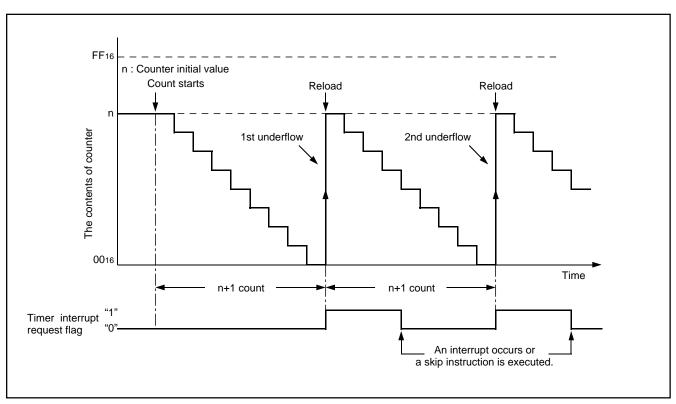


Fig. 18 Auto-reload function



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

The 4513/4514 Group timer consists of the following circuits.

• Prescaler : frequency divider

• Timer 1 : 8-bit programmable timer

• Timer 2: 8-bit programmable timer

• Timer 3: 8-bit programmable timer

Timer 4 : 8-bit programmable timer

(Timers 1 to 4 have the interrupt function, respectively)

• 16-bit timer

Prescaler and timers 1 to 4 can be controlled with the timer control registers W1 to W6. The 16-bit timer is a free counter which is not controlled with the control register.

Each function is described below.

Table 9 Function related timers

Circuit	Structure	Count source	Frequency dividing ratio	Use of output signal	Control register
Prescaler	Frequency divider	Instruction clock	4, 16	• Timer 1, 2, 3 and 4 count sources	W1
Timer 1	8-bit programmable	Prescaler output (ORCLK)	1 to 256	Timer 2 count source	W1
	binary down counter			CNTR0 output	W6
	(link to P30/INT0 input)			Timer 1 interrupt	
Timer 2	8-bit programmable	Timer 1 underflow	1 to 256	Timer 3 count source	W2
	binary down counter	Prescaler output (ORCLK)		Timer 2 interrupt	W6
		CNTR0 input		CNTR0 output	
		16-bit timer underflow			
Timer 3	8-bit programmable	Timer 2 underflow	1 to 256	Timer 4 count source	W3
	binary down counter	Prescaler output (ORCLK)		Timer 3 interrupt	W6
	(link to P31/INT1 input)			CNTR1 output	
Timer 4	8-bit programmable	Timer 3 underflow	1 to 256	Timer 4 interrupt	W4
	binary down counter	Prescaler output (ORCLK)		CNTR1 output	W6
		CNTR1 input			
16-bit timer	16-bit fixed dividing	Instruction clock	65536	Watchdog timer	
	frequency			(The 15th bit is counted twice)	
				Timer 2 count source	
				(16-bit timer underflow)	



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

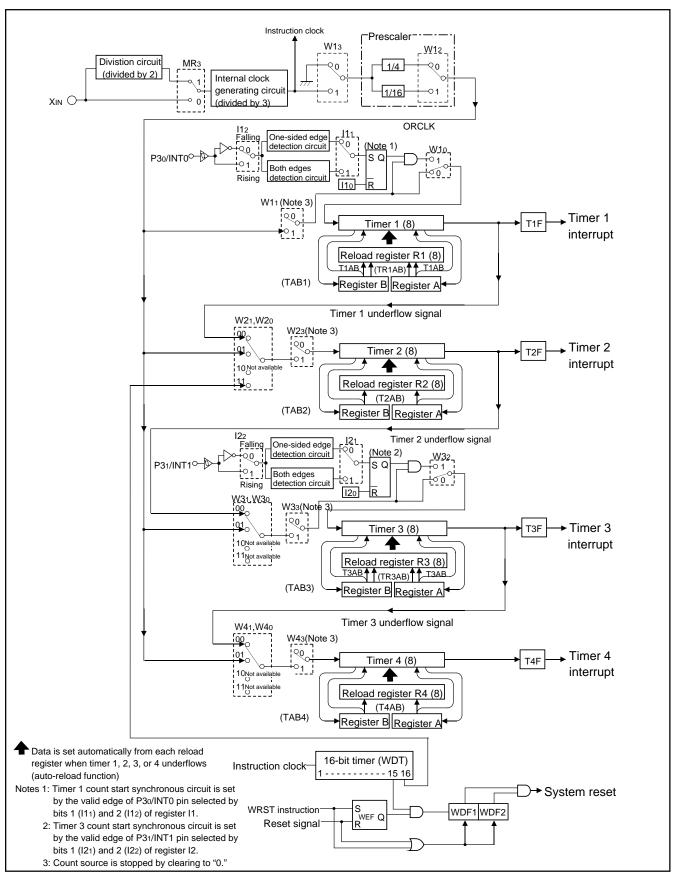


Fig. 19 Timers structure



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

Table 10 Timer control registers

Timer control register W1			at reset : 00002		at RAM back-up: 00002	R/W
W13	Prescaler control bit	0	0 Stop (state initialized)			
		1		Operating		
W12	Prescaler dividing ratio selection bit	0)	Instruction clock di		
	1 Toosaler arriang ratio colocien bit	1	1 Instruction clock divided by 16			
W11	Timer 1 control bit	C	0 Stop (state retained)			
••••	Timer 1 definite bit	1	1 Operating			
W10	Timer 1 count start synchronous circuit	C	Count start synchronous circuit not selected			
VV 10	control bit	1		Count start synchr	onous circuit selected	
	Timer control register W2		at reset : 00002 at RAM back-up : state retained		R/W	
W23	Timer 2 control bit)	Stop (state retaine	d)	
VV25	Timer 2 control bit	1	1	Operating		
W22	Not used	1	1	This bit has no function, but read/write is enabled.		
		W21	21 W20 Count source			
W21		0	0	Timer 1 underflow signal		
	Timer 2 count source selection bits	0	1	Prescaler output		
W20		1	0	CNTR0 input		
		1	1	16 bit timer (WDT)	underflow signal	
	Timer control register W3		at	reset : 00002	at RAM back-up : state retained	R/W
W33	Times 2 central hit)	Stop (state retaine	d)	
VV 3 3	Timer 3 control bit	1	1 Operating			
\\/O ₀	Timer 3 count start synchronous circuit)	Count start synchr	onous circuit not selected	
W32	control bit	,	1	Count start synchronous circuit selected		
		W31	31 W30 Count source			
W31		0				
	Timer 3 count source selection bits	0	1	Prescaler output		
W30		1	0	Not available		
*****		1	1	Not available		
	Timer control register W4		at	reset : 00002	at RAM back-up : state retained	
					at 10 th back up . State Tetamea	R/W
\\/ / 10	Timer 4 central hit	(Stop (state retaine	·	R/W
W43	Timer 4 control bit			Stop (state retaine	·	R/W
W43 W42	Timer 4 control bit Not used	1)	Operating	·	R/W
W42		1) 1	Operating	d)	R/W
		1) 1)	Operating	ction, but read/write is enabled. Count source	R/W
W42		(W41) 1) 1 W40	Operating This bit has no fun	ction, but read/write is enabled. Count source	R/W
W42 W41	Not used	W41 0	0 1 0 1 W40 0	Operating This bit has no fun Timer 3 underflow	ction, but read/write is enabled. Count source	R/W
W42	Not used	W41 0	0 1 0 1 W40 0	Operating This bit has no fun Timer 3 underflow Prescaler output	ction, but read/write is enabled. Count source	R/W
W42 W41	Not used	W41 0 0	0 1 0 1 W40 0 1 0	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input	ction, but read/write is enabled. Count source	
W42 W41 W40	Not used Timer 4 count source selection bits Timer control register W6	W41 0 0 1	0 1 0 1 W40 0 1 0	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input Not available reset: 00002	ction, but read/write is enabled. Count source signal	
W42 W41	Not used Timer 4 count source selection bits	W41 0 0 1 1	0 1 0 1 W40 0 1 0 1	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input Not available reset: 00002 Timer 3 underflow	ction, but read/write is enabled. Count source signal at RAM back-up : state retained signal output divided by 2	R/W
W42 W41 W40	Not used Timer 4 count source selection bits Timer control register W6 CNTR1 output control bit	0 1 W41 0 0 1 1	0 1 0 1 W40 0 1 0 1 at	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input Not available reset: 00002 Timer 3 underflow CNTR1 output cor	ction, but read/write is enabled. Count source signal at RAM back-up : state retained signal output divided by 2 strol by timer 4 underflow signal divided	R/W
W42 W41 W40	Not used Timer 4 count source selection bits Timer control register W6	0 0 1 0 1 1	0 1 0 1 at 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input Not available reset: 00002 Timer 3 underflow CNTR1 output cor D7(I/O)/CNTR1 input	ction, but read/write is enabled. Count source signal at RAM back-up : state retained signal output divided by 2 atrol by timer 4 underflow signal divided by the cout	R/W
W42 W41 W40 W63	Not used Timer 4 count source selection bits Timer control register W6 CNTR1 output control bit D7/CNTR1 function selection bit	W41 0 0 1 1 1	0 1 W40 0 1 at 0 1 0 1 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input Not available reset: 00002 Timer 3 underflow CNTR1 output cor D7(I/O)/CNTR1 input CNTR1 (I/O)/D7(int)	ction, but read/write is enabled. Count source signal at RAM back-up : state retained signal output divided by 2 atrol by timer 4 underflow signal divided but	R/W
W42 W41 W40	Not used Timer 4 count source selection bits Timer control register W6 CNTR1 output control bit	W41 0 0 1 1 1	0 1 1 W40 0 1 at at 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 0 1 1 0	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input Not available reset: 00002 Timer 3 underflow CNTR1 output cor D7(I/O)/CNTR1 input CNTR1 (I/O)/D7(int) Timer 1 underflow	ction, but read/write is enabled. Count source signal at RAM back-up : state retained signal output divided by 2 atrol by timer 4 underflow signal divided but put) signal output divided by 2	R/W
W42 W41 W40 W63	Not used Timer 4 count source selection bits Timer control register W6 CNTR1 output control bit D7/CNTR1 function selection bit	W41 0 0 1 1 1	0 1 W40 0 1 at 0 1 0 1 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0	Operating This bit has no fun Timer 3 underflow Prescaler output CNTR1 input Not available reset: 00002 Timer 3 underflow CNTR1 output cor D7(I/O)/CNTR1 input CNTR1 (I/O)/D7(int) Timer 1 underflow	ction, but read/write is enabled. Count source signal at RAM back-up : state retained signal output divided by 2 atrol by timer 4 underflow signal divided by 1 signal output divided by 2	R/W

Note: "R" represents read enabled, and "W" represents write enabled.



(1) Timer control registers

• Timer control register W1

Register W1 controls the count operation of timer 1, the selection of count start synchronous circuit, and the frequency dividing ratio and count operation of prescaler. Set the contents of this register through register A with the TW1A instruction. The TAW1 instruction can be used to transfer the contents of register W1 to register A.

• Timer control register W2

Register W2 controls the count operation and count source of timer 2. Set the contents of this register through register A with the TW2A instruction. The TAW2 instruction can be used to transfer the contents of register W2 to register A.

• Timer control register W3

Register W3 controls the count operation and count source of timer 3 and the selection of count start synchronous circuit. Set the contents of this register through register A with the TW3A instruction. The TAW3 instruction can be used to transfer the contents of register W3 to register A.

• Timer control register W4

Register W4 controls the count operation and count source of timer 4. Set the contents of this register through register A with the TW4A instruction. The TAW4 instruction can be used to transfer the contents of register W4 to register A.

• Timer control register W6

Register W6 controls the D6/CNTR0 pin and D7/CNTR1 functions, the selection and operation of the CNTR0 and CNTR1 output. Set the contents of this register through register A with the TW6A instruction. The TAW6 instruction can be used to transfer the contents of register W6 to register A.

(2) Precautions

Note the following for the use of timers.

Prescaler

Stop the prescaler operation to change its frequency dividing ra-

Count source

Stop timer 1, 2, 3, or 4 counting to change its count source.

· Reading the count value

Stop timer 1, 2, 3, or 4 counting and then execute the TAB1, TAB2, TAB3, or TAB4 instruction to read its data.

• Writing to reload registers R1 and R3

When writing data to reload registers R1 or R3 while timer 1 or timer 3 is operating, avoid a timing when timer 1 or timer 3 underflows.

(3) Prescaler

Prescaler is a frequency divider. Its frequency dividing ratio can be selected. The count source of prescaler is the instruction clock. Use the bit 2 of register W1 to select the prescaler dividing ratio and the bit 3 to start and stop its operation. Prescaler is initialized, and the output signal (ORCLK) stops when the bit 3 of register W1 is cleared to "0."

(4) Timer 1 (interrupt function)

Timer 1 is an 8-bit binary down counter with the timer 1 reload register (R1). Data can be set simultaneously in timer 1 and the reload register (R1) with the T1AB instruction. Data can be written to reload register (R1) with the TR1AB instruction.

When writing data to reload register R1 with the TR1AB instruction, the downcount after the underflow is started from the setting value of reload register R1.

Timer 1 starts counting after the following process;

① set data in timer 1, and

2 set the bit 1 of register W1 to "1."

However, P30/INT0 pin input can be used as the start trigger for timer 1 count operation by setting the bit 0 of register W1 to "1."

When a value set in timer 1 is n, timer 1 divides the count source signal by n + 1 (n = 0 to 255).

Once count is started, when timer 1 underflows (the next count pulse is input after the contents of timer 1 becomes "0"), the timer 1 interrupt request flag (T1F) is set to "1," new data is loaded from reload register R1, and count continues (auto-reload function).

Data can be read from timer 1 with the TAB1 instruction. When reading the data, stop the counter and then execute the TAB1 instruction. Timer 1 underflow signal divided by 2 can be output from D6/CNTR0 pin.

(5) Timer 2 (interrupt function)

Timer 2 is an 8-bit binary down counter with the timer 2 reload register (R2). Data can be set simultaneously in timer 2 and the reload register (R2) with the T2AB instruction.

Timer 2 starts counting after the following process;

1) set data in timer 2,

② select the count source with the bits 0 and 1 of register W2, and ③ set the bit 3 of register W2 to "1."

When a value set in timer 2 is n, timer 2 divides the count source signal by n + 1 (n = 0 to 255).

Once count is started, when timer 2 underflows (the next count pulse is input after the contents of timer 2 becomes "0"), the timer 2 interrupt request flag (T2F) is set to "1," new data is loaded from reload register R2, and count continues (auto-reload function).

Data can be read from timer 2 with the TAB2 instruction. When reading the data, stop the counter and then execute the TAB2 instruction. The output from D6/CNTR0 pin by timer 2 underflow signal divided by 2 can be controlled.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(6) Timer 3 (interrupt function)

Timer 3 is an 8-bit binary down counter with the timer 3 reload register (R3). Data can be set simultaneously in timer 3 and the reload register (R3) with the T3AB instruction. Data can be written to reload register (R3) with the TR3AB instruction.

When writing data to reload register R3 with the TR3AB instruction, the downcount after the underflow is started from the setting value of reload register R3.

Timer 3 starts counting after the following process;

- ① set data in timer 3.
- ② select the count source with the bits 0 and 1 of register W3, and ③ set the bit 3 of register W3 to "1."

However, P31/INT1 pin input can be used as the start trigger for timer 3 count operation by setting the bit 2 of register W3 to "1."

When a value set in timer 3 is n, timer 3 divides the count source signal by n + 1 (n = 0 to 255).

Once count is started, when timer 3 underflows (the next count pulse is input after the contents of timer 3 becomes "0"), the timer 3 interrupt request flag (T3F) is set to "1," new data is loaded from reload register R3, and count continues (auto-reload function).

Data can be read from timer 3 with the TAB3 instruction. When reading the data, stop the counter and then execute the TAB3 instruction. Timer 3 underflow signal divided by 2 can be output from D7/CNTR1 pin.

(7) Timer 4 (interrupt function)

Timer 4 is an 8-bit binary down counter with the timer 4 reload register (R4). Data can be set simultaneously in timer 4 and the reload register (R4) with the T4AB instruction.

Timer 4 starts counting after the following process;

- ① set data in timer 4.
- ② select the count source with the bits 0 and 1 of register W4, and ③ set the bit 3 of register W4 to "1."

When a value set in timer 4 is n, timer 4 divides the count source signal by n + 1 (n = 0 to 255).

Once count is started, when timer 4 underflows (the next count pulse is input after the contents of timer 4 becomes "0"), the timer 4 interrupt request flag (T4F) is set to "1," new data is loaded from reload register R4, and count continues (auto-reload function).

Data can be read from timer 4 with the TAB4 instruction. When reading the data, stop the counter and then execute the TAB4 instruction. The output from D7/CNTR1 pin by timer 4 underflow signal divided by 2 can be controlled.

(8) Timer interrupt request flags (T1F, T2F, T3F, and T4F)

Each timer interrupt request flag is set to "1" when each timer underflows. The state of these flags can be examined with the skip instructions (SNZT1, SNZT2, SNZT3, and SNZT4).

Use the interrupt control registers V1, V2 to select an interrupt or a skip instruction.

An interrupt request flag is cleared to "0" when an interrupt occurs or when the next instruction is skipped with a skip instruction.

(9) Timer I/O pin (D6/CNTR0, D7/CNTR1)

D6/CNTR0 pin has functions to input the timer 2 count source, and to output the timer 1 and timer 2 underflow signals divided by 2. D7/CNTR1 pin has functions to input the timer 4 count source, and to output the timer 3 and timer 4 underflow signals divided by 2.

The selection of D6/CNTR0 pin function can be controlled with the bit 0 of register W6. The selection of D7/CNTR1 pin function can be controlled with the bit 2 of register W6.

The following signals can be selected for the CNTR0 output signal with the bit 1 of register W6.

- timer 1 underflow signal divided by 2
- the signal of AND operation between timer 1 underflow signal divided by 2 and timer 2 underflow signal divide by 2

The following signals can be selected for the CNTR1 output signal with the bit 3 of register W6.

- timer 3 underflow signal divided by 2
- the signal of AND operation between timer 3 underflow signal divided by 2 and timer 4 underflow signal divide by 2

Timer 2 counts the rising waveform of CNTR0 input when the CNTR0 input is selected as the count source.

Timer 4 counts the rising waveform of CNTR1 input when the CNTR1 input is selected as the count source.

(10) Count start synchronous circuit (timer 1 and 3)

Each of timer 1 and timer 3 has the count start synchronous circuit which synchronizes P30/INT0 pin and P31/INT1 pin, respectively, and can start the timer count operation.

Timer 1 count start synchronous circuit function is selected by setting the bit 0 of register W1 to "1." The control by P3o/INT0 pin input can be performed by setting the bit 0 of register I1 to "1."

The count start synchronous circuit is set by level change ("H" \rightarrow "L" or "L" \rightarrow "H") of P30/INT0 pin input. This valid waveform is selected by bits 1 (I11) and 2 (I12) of register I1 as follows;

- I11 = "0": Synchronized with one-sided edge (falling or rising)
- I11 = "1": Synchronized with both edges (both falling and rising)

When register I11="0" (synchronized with the one-sided edge), the rising or falling waveform can be selected by bit 2 of register I1;

- I12 = "0": Falling waveform
- I12 = "1": Rising waveform

Timer 3 count start synchronous circuit function is selected by setting the bit 2 of register W3 to "1." The control by P31/INT1 pin input can be performed by setting the bit 0 of register I2 to "1."

The count start synchronous circuit is set by level change ("H"\to "L" or "L"\to "H") of P31/INT1 pin input. This valid waveform is selected by bits 1 (I21) and 2 (I22) of register I2 as follows;

- I21 = "0": Synchronized with one-sided edge (falling or rising)
- I21 = "1": Synchronized with both edges (both falling and rising)

When register I21="0" (synchronized with the one-sided edge), the rising or falling waveform can be selected by bit 2 of register I2;

- I22 = "0": Falling waveform
- I22 = "1": Rising waveform

When timer 1 and timer 3 count start synchronous circuits are used, the count start synchronous circuits are set, the count source is input to each timer by inputting valid waveform to P30/INT0 pin and P31/INT1 pin. Once set, the count start synchronous circuit is cleared by clearing the bit I10 or I20 to "0" or reset.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

WATCHDOG TIMER

Watchdog timer provides a method to reset the system when a program runs wild. Watchdog timer consists of a 16-bit timer (WDT), watchdog timer enable flag (WEF), and watchdog timer flags (WDF1, WDF2).

The timer WDT downcounts the instruction clocks as the count source. The underflow signal is generated when the count value reaches "000016." This underflow signal can be used as the timer 2 count source.

When the WRST instruction is executed after system is released from reset, the WEF flag is set to "1". At this time, the watchdog timer starts operating.

When the count value of timer WDT reaches "BFFF16" or "3FFF16," the WDF1 flag is set to "1." If the WRST instruction is never executed while timer WDT counts 32767, WDF2 flag is set to "1," and the RESET pin outputs "L" level to reset the microcomputer. Execute the WRST instruction at each period of 32766 machine cycle or less by software when using watchdog timer to keep the microcomputer operating normally.

To prevent the WDT stopping in the event of misoperation, WEF flag is designed not to initialize once the WRST instruction has been executed. Note also that, if the WRST instruction is never executed, the watchdog timer does not start.

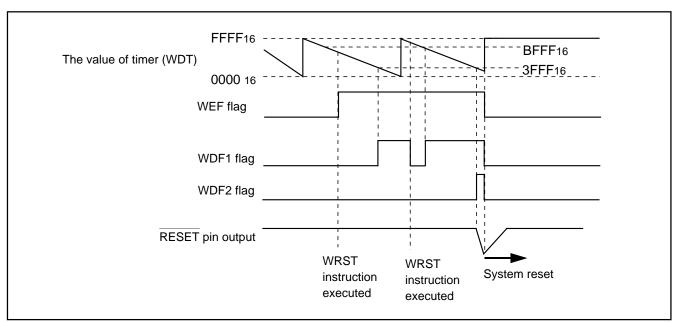


Fig. 20 Watchdog timer function

The contents of WEF, WDF1 and WDF2 flags and timer WDT are initialized at the RAM back-up mode.

If WDF2 flag is set to "1" at the same time that the microcomputer enters the RAM back-up state, system reset may be performed. When using the watchdog timer and the RAM back-up mode, initialize the WDF1 flag with the WRST instruction just before the microcomputer enters the RAM back-up state (refer to Figure 21)

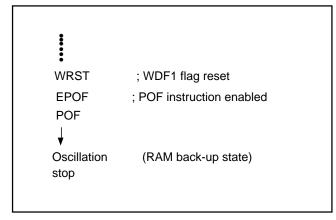


Fig. 21 Program example to enter the RAM back-up mode when using the watchdog timer



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

SERIAL I/O

The 4513/4514 Group has a built-in clock synchronous serial I/O which can serially transmit or receive 8-bit data.

Serial I/O consists of;

- serial I/O register SI
- serial I/O mode register J1
- serial I/O transmission/reception completion flag (SIOF)
- serial I/O counter

Registers A and B are used to perform data transfer with internal CPU, and the serial I/O pins are used for external data transfer.

The pin functions of the serial I/O pins can be set with the register ${\sf J1}.$

Table 11 Serial I/O pins

Pin	Pin function when selecting serial I/O			
P20/SCK	Clock I/O (Sck)			
P21/SOUT	Serial data output (Sout)			
P22/SIN	Serial data input (SIN)			

Note: Input ports P20-P22 can be used regardless of register J1.

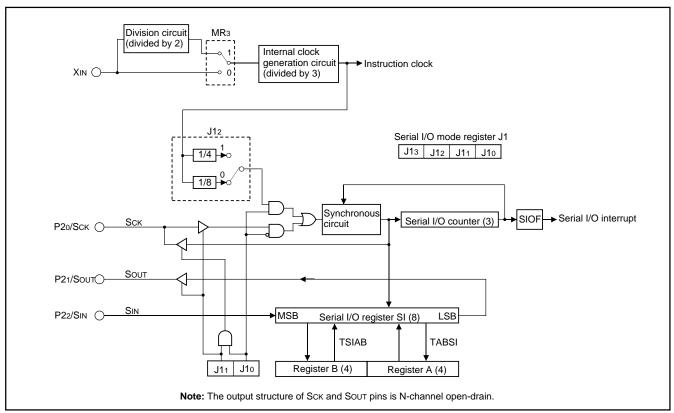


Fig. 22 Serial I/O structure

Table 12 Serial I/O mode register

Table 12 C	Table 12 Serial I/O IIIode register				
	Serial I/O mode register J1		at reset : 00002	at RAM back-up : state retained	R/W
14.0	J13 Not used		This bit has no function, but read/write is enabled.		
J13					
140	J12 Serial I/O internal clock dividing ratio selection bit		Instruction clock sig	nal divided by 8	
J12			Instruction clock sig	nal divided by 4	
114	J11 Serial I/O port selection bit		Input ports P20, P21	1, P22 selected	
J11			Serial I/O ports Sck	, Sout, Sin/input ports P20, P21, P22 s	elected
J10	Carial I/O average resource alock and artists hit	0	External clock		
310	Serial I/O synchronous clock selection bit	1	Internal clock (instru	uction clock divided by 4 or 8)	

Note: "R" represents read enabled, and "W" represents write enabled.



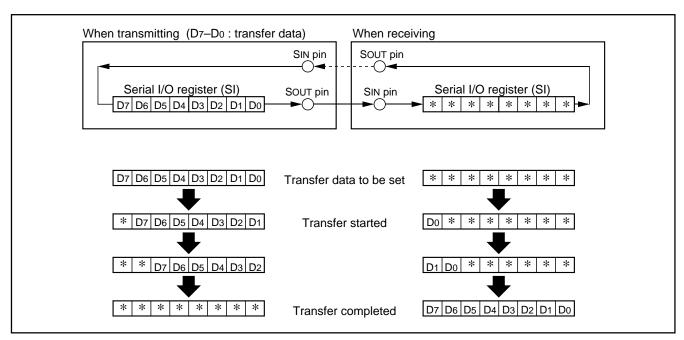


Fig. 23 Serial I/O register state when transferring

(1) Serial I/O register SI

Serial I/O register SI is the 8-bit data transfer serial/parallel conversion register. Data can be set to register SI through registers A and B with the TSIAB instruction. The contents of register A is transmitted to the low-order 4 bits of register SI, and the contents of register B is transmitted to the high-order 4 bits of register SI.

During transmission, each bit data is transmitted LSB first from the lowermost bit (bit 0) of register SI, and during reception, each bit data is received LSB first to register SI starting from the topmost bit (bit 7).

When register SI is used as a work register without using serial I/O, pull up the SCK pin or set the pin function to an input port P20.

(2) Serial I/O transmission/reception completion flag (SIOF)

Serial I/O transmission/reception completion flag (SIOF) is set to "1" when serial data transmission or reception completes. The state of SIOF flag can be examined with the skip instruction (SNZSI). Use the interrupt control register V2 to select the interrupt or the skip instruction.

The SIOF flag is cleared to "0" when the interrupt occurs or when the next instruction is skipped with the skip instruction.

(3) Serial I/O start instruction (SST)

When the SST instruction is executed, the SIOF flag is cleared to "0" and then serial I/O transmission/reception is started.

(4) Serial I/O mode register J1

Register J1 controls the synchronous clock, P20/SCK, P21/SOUT and P22/SIN pin function. Set the contents of this register through register A with the TJ1A instruction. The TAJ1 instruction can be used to transfer the contents of register J1 to register A.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(5) How to use serial I/O

Figure 24 shows the serial I/O connection example. Serial I/O interrupt is not used in this example. In the actual wiring, pull up the

wiring between each pin with a resistor. Figure 25 shows the data transfer timing and Table 13 shows the data transfer sequence.

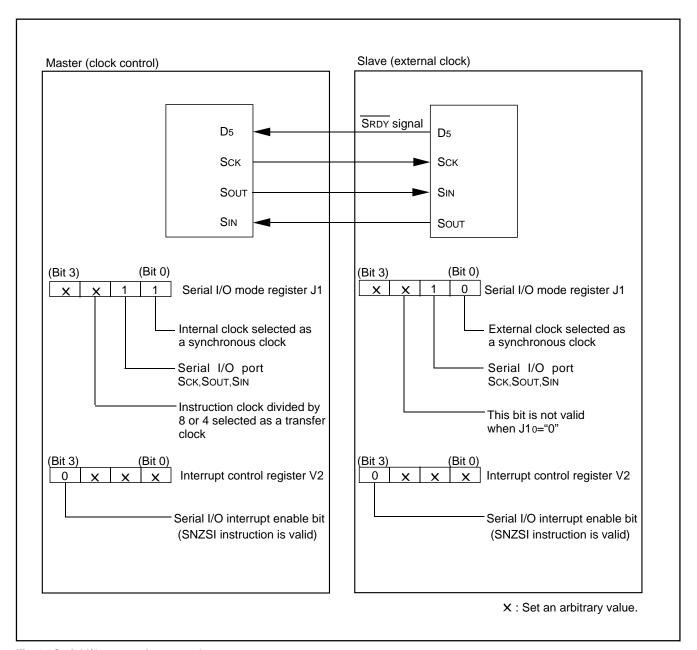


Fig. 24 Serial I/O connection example

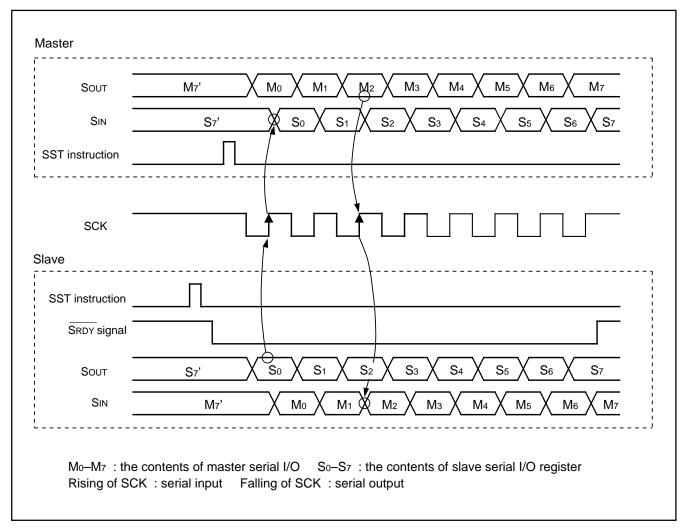


Fig. 25 Timing of serial I/O data transfer

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

Table 13 Processing sequence of data transfer from master to slave

Master (transmission)	Slave (reception)
[Initial setting]	[Initial setting]
• Setting the serial I/O mode register J1 and interrupt control register V2 shown in Figure 24.	• Setting serial I/O mode register J1, and interrupt control register V2 shown in Figure 24.
TJ1A and TV2A instructions	TJ1A and TV2A instructions
Setting the port received the reception enable signal (SRDY) to the input mode.	• Setting the port transmitted the reception enable signal (SRDY) and outputting "H" level (reception impossible).
(Port D5 is used in this example)	(Port D5 is used in this example)
SD instruction	SD instruction
* [Transmission enable state]	*[Reception enable state]
• Storing transmission data to serial I/O register SI.	The SIOF flag is cleared to "0."
TSIAB instruction	SST instruction
	• "L" level (reception possible) is output from port D5.
	RD instruction
[Transmission]	[Reception]
•Check port D5 is "L" level.	
SZD instruction	
Serial transfer starts.	
SST instruction	
•Check transmission completes.	Check reception completes.
SNZSI instruction	SNZSI instruction
•Wait (timing when continuously transferring)	• "H" level is output from port D5.
	SD instruction
	[Data processing]

1-byte data is serially transferred on this process. Subsequently, data can be transferred continuously by repeating the process from *. When an external clock is selected as a synchronous clock, the clock is not controlled internally. Control the clock externally because serial transfer is performed as long as clock is externally input. (Unlike an internal clock, an external clock is not stopped when serial transfer is completed.) However, the SIOF flag is set to "1" when the clock is counted 8 times after executing the SST instruction. Be sure to set the initial level of the external clock to "H."



A-D CONVERTER

The 4513/4514 Group has a built-in A-D conversion circuit that performs conversion by 10-bit successive comparison method. Table 14 shows the characteristics of this A-D converter. This A-D converter can also be used as an 8-bit comparator to compare analog voltages input from the analog input pin with preset values.

Table 14 A-D converter characteristics

Parameter	Characteristics
Conversion format	Successive comparison method
Resolution	10 bits
Relative accuracy	Linearity error: ±2LSB
	Non-linearity error: ±0.9LSB
Conversion speed	46.5 μ s (High-speed mode at 4.0 MHz oscillation frequency)
Analog input pin	4 for 4513 Group
	8 for 4514 Group

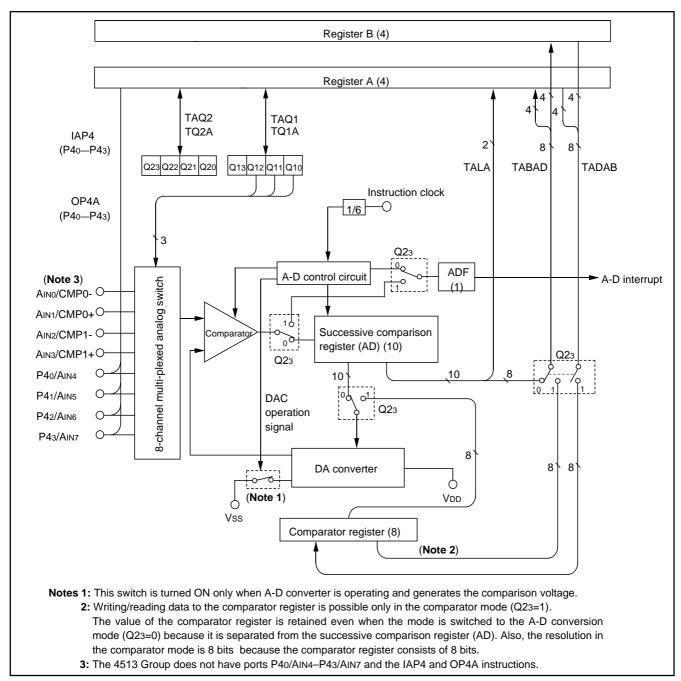


Fig. 26 A-D conversion circuit structure



Table 15 A-D control registers

A-D control register Q1		at reset : 00002		reset : 00002	at RAM back-up : state retained	R/W		
Q13	Not used		0		This bit has no function, but read/write is enabled.			
			1			·		
		Q1 2	Q11	Q1 0	Selected pins			
Q12		0	0	0	AIN0			
		0	0	1	AIN1			
		0	1	0	AIN2			
Q11	Analog input pin selection bits (Note 2)	0	1	1	AIN3			
		1	0	0	AIN4 (Not available	AIN4 (Not available for the 4513 Group)		
		1	0	1	AIN5 (Not available	AIN5 (Not available for the 4513 Group)		
Q10		1	1	0	AIN6 (Not available for the 4513 Group)			
		1	1	1	AIN7 (Not available	for the 4513 Group)		
A-D control register Q2				at	reset : 00002	at RAM back-up : state retained	R/W	
Q23	A D energian made calcution hit		0 A-D conversion mode		de			
Q23	A-D operation mode selection bit		1		Comparator mode			
P43/AIN7 and P42/AIN6 pin function selec-			0		P43, P42	(read/write enabled for the 4513 Group)		
tion bit (Not used for the 4513 Group)			1		AIN7, AIN6/P43, P42	(read/write enabled for the 4513 Group)		
P41/AIN5 pin function selection bit			0		P41	(read/write enabled for the 4513 Group)		
Q21	(Not used for the 4513 Group)		1		AIN5/P41	(read/write enabled for the 4513 Group)		
020	P40/AIN4 pin function selection bit		0		P40	(read/write enabled for the 4513 Group)		
Q20	(Not used for the 4513 Group)		1		AIN4/P40	(read/write enabled for the 4513 Group)		

Notes 1: "R" represents read enabled, and "W" represents write enabled.

(1) Operating at A-D conversion mode

The A-D conversion mode is set by setting the bit 3 of register Q2 to "0."

(2) Successive comparison register AD

Register AD stores the A-D conversion result of an analog input in 10-bit digital data format. The contents of the high-order 8 bits of this register can be stored in register B and register A with the TABAD instruction. The contents of the low-order 2 bits of this register can be stored into the high-order 2 bits of register A with the TALA instruction. However, do not execute this instruction during A-D conversion.

When the contents of register AD is n, the logic value of the comparison voltage V_{ref} generated from the built-in DA converter can be obtained with the reference voltage VDD by the following formula:

$$Vref = \frac{V_{DD}}{1024} \times n$$

n: The value of register AD (n = 0 to 1023)

(3) A-D conversion completion flag (ADF)

A-D conversion completion flag (ADF) is set to "1" when A-D conversion completes. The state of ADF flag can be examined with the skip instruction (SNZAD). Use the interrupt control register V2 to select the interrupt or the skip instruction.

The ADF flag is cleared to "0" when the interrupt occurs or when the next instruction is skipped with the skip instruction.

(4) A-D conversion start instruction (ADST)

A-D conversion starts when the ADST instruction is executed. The conversion result is automatically stored in the register AD.

(5) A-D control register Q1

Register Q1 is used to select one of analog input pins. The 4513 Group does not have AIN4–AIN7. Accordingly, do not select these pins with register Q1.

(6) A-D control register Q2

Register Q2 is used to select the pin function of P40/AIN4, P41/AIN5, P42/AIN6, and P43/AIN7. The A-D conversion mode is selected when the bit 3 of register Q2 is "0," and the comparator mode is selected when the bit 3 of register Q2 is "1." After set this register, select the analog input with register Q1.

Even when register Q2 is used to set the pins for analog input, P40/AIN4–P43/AIN7 continue to function as P40–P43 I/O. Accordingly, when any of them are used as I/O port P4 and others are used as analog input pins, make sure to set the outputs of pins that are set for analog input to "1." Also, for the port input, the port input function of the pin functions as analog input is undefined.



^{2:} Select AIN4-AIN7 with register Q1 after setting register Q2.

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(7) Operation description

A-D conversion is started with the A-D conversion start instruction (ADST). The internal operation during A-D conversion is as follows:

- ① When A-D conversion starts, the register AD is cleared to "00016."
- ② Next, the topmost bit of the register AD is set to "1," and the comparison voltage V_{ref} is compared with the analog input voltage V_{IN}.

The 4513/4514 Group repeats this operation to the lowermost bit of the register AD to convert an analog value to a digital value. A-D conversion stops after 62 machine cycles (46.5 μ s when f(XIN) = 4.0 MHz in high-speed mode) from the start, and the conversion result is stored in the register AD. An A-D interrupt activated condition is satisfied and the ADF flag is set to "1" as soon as A-D conversion completes (Figure 27).

Table 16 Change of successive comparison register AD during A-D conversion

At starting conversion	Change of successive comparison register AD Comparison voltage (Vref) value
1st comparison	1 0 0 0 0 0 <u>VDD</u>
2nd comparison	*1 1 0 0 0 0 0 VDD ± VDD 4
3rd comparison	*1 *2 1 0 0 0 0 2 ± 4 ± 8
After 10th comparison	A-D conversion result VDD + VDD
completes	*1 *2 *3 *8 *9 *A 2 ± ± 1024

*1: 1st comparison result
*2: 2nd comparison result
*3: 3rd comparison result
*8: 8th comparison result
*9: 9th comparison result
*A: 10th comparison result



(8) A-D conversion timing chart

Figure 27 shows the A-D conversion timing chart.

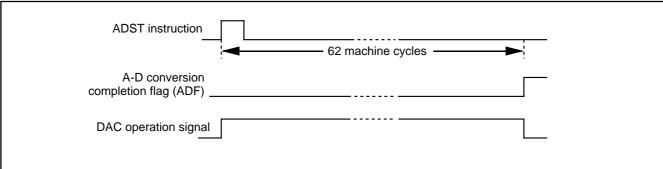


Fig. 27 A-D conversion timing chart

(9) How to use A-D conversion

How to use A-D conversion is explained using as example in which the analog input from P40/AIN4 pin is A-D converted, and the high-order 4 bits of the converted data are stored in address M(Z, X, Y) = (0, 0, 0), the middle-order 4 bits in address M(Z, X, Y) = (0, 0, 1), and the low-order 2 bits in address M(Z, X, Y) = (0, 0, 2) of RAM. The A-D interrupt is not used in this example.

- ① After selecting the AIN4 pin function with the bit 0 of the register Q2, select AIN4 pin and A-D conversion mode with the register Q1 (refer to Figure 28).
- ② Execute the ADST instruction and start A-D conversion.
- ③ Examine the state of ADF flag with the SNZAD instruction to determine the end of A-D conversion.
- Transfer the low-order 2 bits of converted data to the high-order 2 bits of register A (TALA instruction).
- © Transfer the high-order 8 bits of converted data to registers A and B (TABAD instruction).
- ® Transfer the contents of register B to register A, and then, store into M(Z, X, Y) = (0, 0, 0).

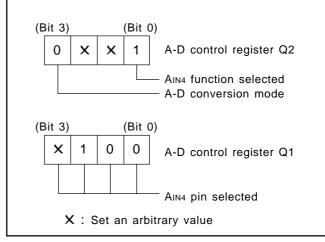


Fig. 28 Setting registers

(10) Operation at comparator mode

The A-D converter is set to comparator mode by setting bit 3 of the register Q2 to "1."

Below, the operation at comparator mode is described.

(11) Comparator register

In comparator mode, the built-in DA comparator is connected to the comparator register as a register for setting comparison voltages. The contents of register B is stored in the high-order 4 bits of the comparator register and the contents of register A is stored in the low-order 4 bits of the comparator register with the TADAB instruction.

When changing from A-D conversion mode to comparator mode, the result of A-D conversion (register AD) is undefined.

However, because the comparator register is separated from register AD, the value is retained even when changing from comparator mode to A-D conversion mode. Note that the comparator register can be written and read at only comparator mode.

If the value in the comparator register is n, the logic value of comparison voltage V_{ref} generated by the built-in DA converter can be determined from the following formula:

Logic value of comparison voltage Vref
$$Vref = \frac{VDD}{256} \times n$$
n: The value of register AD (n = 0 to 255)

(12) Comparison result store flag (ADF)

In comparator mode, the ADF flag, which shows completion of A-D conversion, stores the results of comparing the analog input voltage with the comparison voltage. When the analog input voltage is lower than the comparison voltage, the ADF flag is set to "1." The state of ADF flag can be examined with the skip instruction (SNZAD). Use the interrupt control register V2 to select the interrupt or the skip instruction.

The ADF flag is cleared to "0" when the interrupt occurs or when the next instruction is skipped with the skip instruction.

(13) Comparator operation start instruction (ADST instruction)

In comparator mode, executing ADST starts the comparator operating.

The comparator stops 8 machine cycles after it has started (6 μ s at f(XIN) = 4.0 MHz in high-speed mode). When the analog input voltage is lower than the comparison voltage, the ADF flag is set to "1."

(14) Notes for the use of A-D conversion 1

Note the following when using the analog input pins also for I/O port P4 functions:

- Even when P40/AIN4—P43/AIN7 are set to pins for analog input, they continue to function as P40—P43 I/O. Accordingly, when any of them are used as I/O port P4 and others are used as analog input pins, make sure to set the outputs of pins that are set for analog input to "1." Also, the port input function of the pin functions as an analog input is undefined.
- TALA instruction

When the TALA instruction is executed, the low-order 2 bits of register AD is transferred to the high-order 2 bits of register A, simultaneously, the low-order 2 bits of register A is "0."

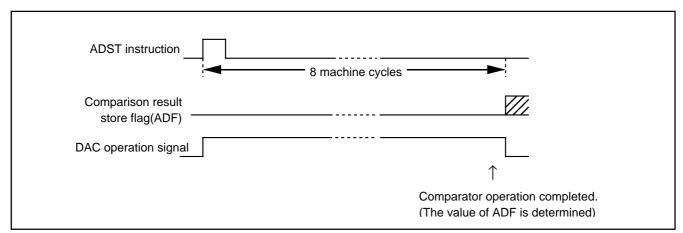


Fig. 29 Comparator operation timing chart



(15) Notes for the use of A-D conversion 2

Do not change the operating mode (both A-D conversion mode and comparator mode) of A-D converter with bit 3 of register Q2 while A-D converter is operating.

When the operating mode of A-D converter is changed from the comparator mode to A-D conversion mode with the bit 3 of register Q2, note the following:

- Clear bit 2 of register V2 to "0" to change the operating mode of the A-D converter from the comparator mode to A-D conversion mode with the bit 3 of register Q2.
- The A-D conversion completion flag (ADF) may be set when the
 operating mode of the A-D converter is changed from the comparator mode to the A-D conversion mode. Accordingly, set a
 value to register Q2, and execute the SNZAD instruction to clear
 the ADF flag.

(16) Definition of A-D converter accuracy

The A-D conversion accuracy is defined below (refer to Figure 30).

- · Relative accuracy
 - ① Zero transition voltage (VoT)

This means an analog input voltage when the actual A-D conversion output data changes from "0" to "1."

② Full-scale transition voltage (VFST)

This means an analog input voltage when the actual A-D conversion output data changes from "1023" to "1022."

3 Linearity error

This means a deviation from the line between VoT and VFST of a converted value between VoT and VFST.

Differential non-linearity error

This means a deviation from the input potential difference required to change a converter value between VoT and VFST by 1 LSB at the relative accuracy.

Absolute accuracy

This means a deviation from the ideal characteristics between 0 to VDD of actual A-D conversion characteristics.

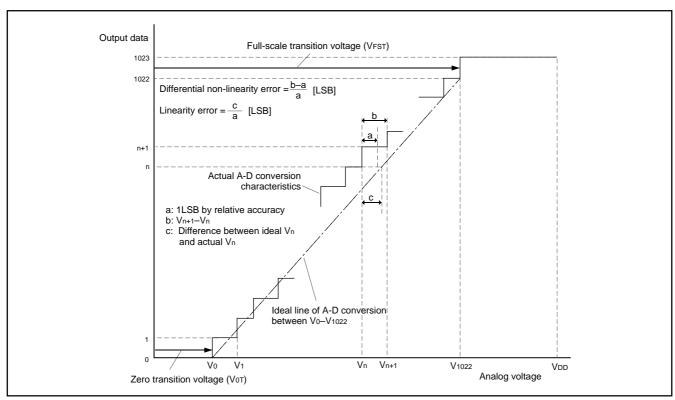


Fig. 30 Definition of A-D conversion accuracy

Vn: Analog input voltage when the output data changes from "n" to "n+1" (n = 0 to 1022)

- 1LSB at relative accuracy $\rightarrow \frac{VFST-V0T}{1022}$ (V)
- 1LSB at absolute accuracy $\rightarrow \frac{\text{VDD}}{1024}$ (V)



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

VOLTAGE COMPARATOR

The 4513/4514 Group has 2 voltage comparator circuits that perform comparison of voltage between 2 pins. Table 17 shows the characteristics of this voltage comparison.

Table 17 Voltage comparator characteristics

Parameter	Characteristics
Voltage comparator function	2 circuits (CMP0, CMP1)
Input pin	CMP0-, CMP0+
	(also used as AIN0, AIN1)
	CMP1-, CMP1+
	(also used as AIN2, AIN3)
Supply voltage	3.0 V to 5.5 V
Input voltage	0.3 VDD to 0.7 VDD
Comparison check error	Typ. 20 mV, Max.100 mV
Response time	Max. 20 μs

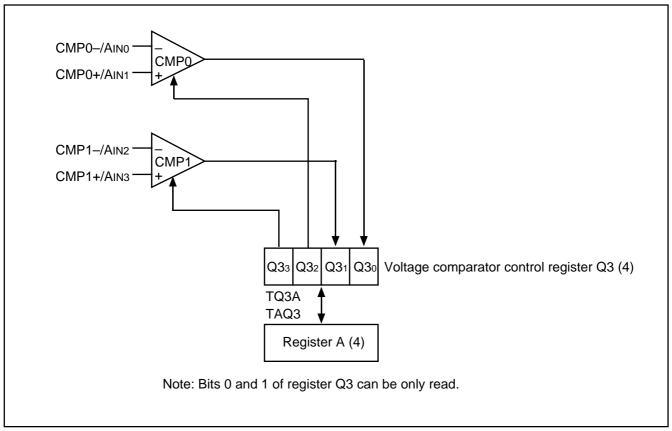


Fig. 31 Voltage comparator structure

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

Table 18 Voltage comparator control register Q3

Voltage comparator control register Q3 (Note 2)		at reset : 00002		at RAM back-up : state retained	R/W
Q33 Voltage comparator (CMP1) control bit		0	Voltage comparator	(CMP1) invalid	
		1	Voltage comparator	Voltage comparator (CMP1) valid	
Q32 Voltage comparator (CMP0) control bit	Voltage comparator (CMP0) control bit	0 Voltage comparator (CMP0) invalid			
	1	Voltage comparator	(CMP0) valid		
Q31	CMP4 comparison result stone bit		CMP1- > CMP1+		
Q31 CMP1 comparison result store bit		1	CMP1- < CMP1+		
Q30	CMD0 acres since requit atoms hit	0	CMP0- > CMP0+		
Q30	CMP0 comparison result store bit	1	CMP0- < CMP0+		

Notes 1: "R" represents read enabled, and "W" represents write enabled.

(1) Voltage comparator control register Q3

Register Q3 controls the function of the voltage comparator.

The function of the voltage comparator CMP0 becomes valid by setting bit 2 of register Q3 to "1," and becomes invalid by setting bit 2 of register Q3 to "0." The comparison result of the voltage comparator CMP0 is stored into bit 0 of register Q3.

The function of the voltage comparator CMP1 becomes valid by setting bit 3 of register Q3 to "1," and becomes invalid by setting bit 3 of register Q3 to "0." The comparison result of the voltage comparator CMP1 is stored into bit 1 of register Q3.

(2) Operation description of voltage comparator

The voltage comparator function becomes valid by setting each control bit of register Q3 to "1" and compares the voltage of the input pin. The comparison result is stored into each comparison result store bit of register Q3.

The comparison result is as follows;

- When CMP0- > CMP0+, Q30 = "0"
 When CMP0- < CMP0+, Q30 = "1"
- When CMP1- > CMP1+, Q31 = "0"
 When CMP1- < CMP1+, Q31 = "1"

(3) Precautions

When the voltage comparator is used, note the following;

Voltage comparator function

When the voltage comparator function is valid with the voltage comparator control register Q3, it is operating even in the RAM back-up mode. Accordingly, be careful about such state because it causes the increase of the operation current in the RAM back-up mode.

In order to reduce the operation current in the RAM back-up mode, invalidate (bits 2 and 3 of register Q3 = "0") the voltage comparator function by software before the POF instruction is executed.

Also, while the voltage comparator function is valid, current is always consumed by voltage comparator. On the system required for the low-power dissipation, invalidate the voltage comparator by software when it is unused.

• Register Q3

Bits 0 and 1 of register Q3 can be only read. Note that they cannot be written.

Reading the comparison result of voltage comparator
 Read the voltage comparator comparison result from register Q3
 after the voltage comparator response time (max. 20 μs) is
 passed from the voltage comparator function becomes valid.



^{2:} Bits 0 and 1 of register Q3 can be only read.

RESET FUNCTION

System reset is performed by applying "L" level to RESET pin for 1 machine cycle or more when the following condition is satisfied; the value of supply voltage is the minimum value or more of the recommended operating conditions.

Then when "H" level is applied to RESET pin, software starts from address 0 in page 0.

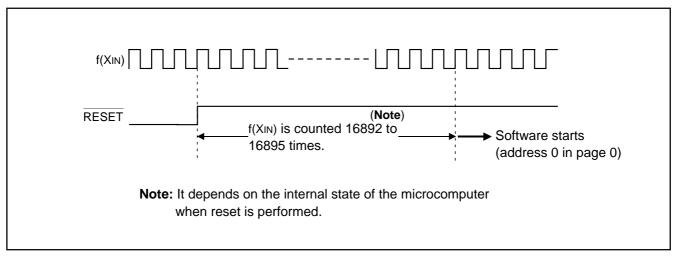


Fig. 32 Reset release timing

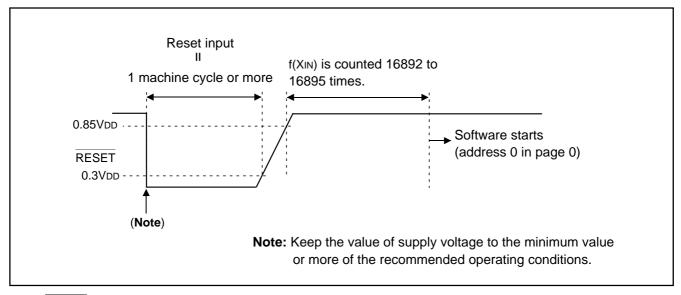


Fig. 33 RESET pin input waveform and reset operation



(1) Power-on reset

Reset can be performed automatically at power on (power-on reset) by connecting resistors, a diode, and a capacitor to RESET pin. Connect RESET pin and the external circuit at the shortest distance

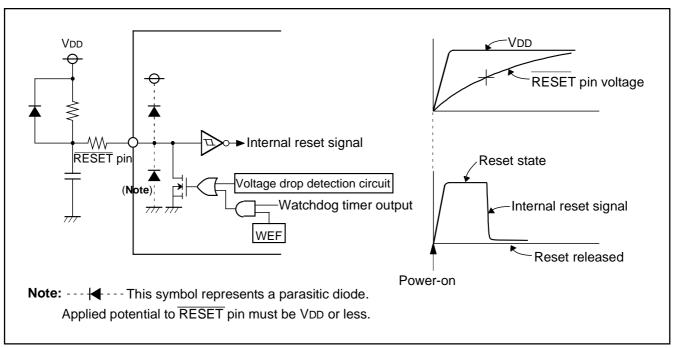


Fig. 34 Power-on reset circuit example

(2) Internal state at reset

Table 19 shows port state at reset, and Figure 35 shows internal state at reset (they are the same after system is released from reset). The contents of timers, registers, flags and RAM except shown in Figure 35 are undefined, so set the initial value to them.

Table 19 Port state at reset

Name	Function	State
D0-D5	D0-D5	High impedance (Note)
D6/CNTR0, D7/CNTR1	D6, D7	Tilgit impedance (Note)
P00-P03	P00-P03	High impedance (Notes 1, 2)
P10-P13	P10-P13	- Trigit impedance (Notes 1, 2)
P20/SCK, P21/SOUT, P22/SIN	P20-P22	High impedance
P30/INT0, P31/INT1	P30, P31	- High impedance (Note 1)
P32, P33 (Note 4)	P32, P33	- Trigit impedance (Note 1)
P40/AIN4-P43/AIN7 (Note 4)	P40-P43	High impedance (Note 1)
P50-P53 (Note 4)	P50-P53	High impedance (Note 3)

Notes 1: Output latch is set to "1."

- 2: Pull-up transistor is turned OFF.
- 3: After system is released from reset, port P5 is in the input mode. (Direction register FR0 = 00002)
- 4: The 4513 Group does not have these ports.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

Address 0 in page 0 is set to program counter	
	0
External 1 interrupt request flag (EXF1)	
Interrupt control register V1	
Interrupt control register V2	
Interrupt control register I1	,
Interrupt control register I2	
Timer 1 interrupt request flag (T1F)	
Timer 3 interrupt request flag (T3F)	0
	0
	0
Watchdog timer enable flag (WEF)	
Timer control register W1	
Timer control register W2	
Timer control register W3	
Timer control register W4	
Timer control register W6	
Clock control register MR	
Serial I/O transmission/reception completion fl	
Serial I/O mode register J1	0 0 0 0 (External clock selected and se
Serial I/O register SI	I/() nort not salected)
A-D conversion completion flag (ADF)	
A-D control register Q1	
A-D control register Q2	
Voltage comparator control register Q3	
Successive comparison register AD	
Comparator register	·
Key-on wakeup control register K0	
Pull-up control register PU0	0 0 0 0
Direction register FR0	
Carry flag (CY)	
Register A	
Register B	
Register D	
Register E	
Register X	
Register Y	
Register Z	
	1 1 1

Fig. 35 Internal state at reset



VOLTAGE DROP DETECTION CIRCUIT

The built-in voltage drop detection circuit is designed to detect a drop in voltage and to reset the microcomputer if the supply voltage drops below a set value.

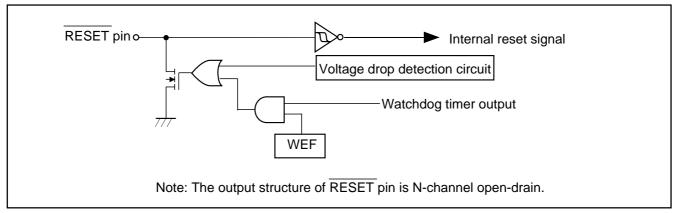


Fig. 36 Voltage drop detection reset circuit

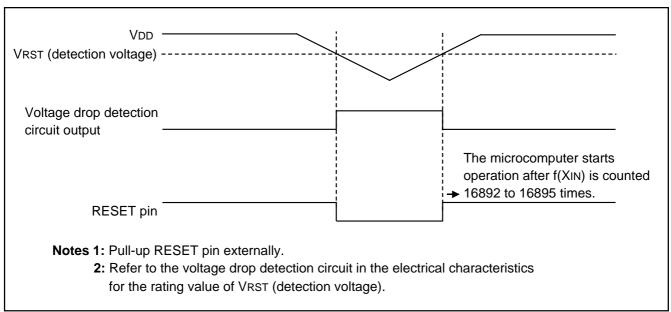


Fig. 37 Voltage drop detection circuit operation waveform

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

RAM BACK-UP MODE

The 4513/4514 Group has the RAM back-up mode.

When the EPOF and POF instructions are executed continuously, system enters the RAM back-up state. The POF instruction is equal to the NOP instruction when the EPOF instruction is not executed before the POF instruction.

As oscillation stops retaining RAM, the function of reset circuit and states at RAM back-up mode, current dissipation can be reduced without losing the contents of RAM. Table 20 shows the function and states retained at RAM back-up. Figure 38 shows the state transition.

(1) Identification of the start condition

Warm start (return from the RAM back-up state) or cold start (return from the normal reset state) can be identified by examining the state of the power down flag (P) with the SNZP instruction.

(2) Warm start condition

When the external wakeup signal is input after the system enters the RAM back-up state by executing the EPOF and POF instructions continuously, the CPU starts executing the program from address 0 in page 0. In this case, the P flag is "1."

(3) Cold start condition

The CPU starts executing the program from address 0 in page 0 when;

- reset pulse is input to RESET pin, or
- · reset by watchdog timer is performed, or
- voltage drop detection circuit detects the voltage drop. In this case, the P flag is "0."

Table 20 Functions and states retained at RAM back-up

Function	RAM back-up
Program counter (PC), registers A, B,	×
carry flag (CY), stack pointer (SP) (Note 2)	^
Contents of RAM	0
Port level	0
Timer control register W1	×
Timer control registers W2 to W4, W6	0
Clock control register MR	×
Interrupt control registers V1, V2	×
Interrupt control registers I1, I2	0
Timer 1 function	×
Timer 2 function	(Note 3)
Timer 3 function	(Note 3)
Timer 4 function	(Note 3)
A-D conversion function	×
A-D control registers Q1, Q2	0
Voltage comparator function	O (Note 5)
Voltage comparator control register Q3	0
Serial I/O function	×
Serial I/O mode register J1	0
Pull-up control register PU0	0
Key-on wakeup control register K0	0
Direction register FR0	0
External 0 interrupt request flag (EXF0)	×
External 1 interrupt request flag (EXF1)	×
Timer 1 interrupt request flag (T1F)	×
Timer 2 interrupt request flag (T2F)	(Note 3)
Timer 3 interrupt request flag (T3F)	(Note 3)
Timer 4 interrupt request flag (T4F)	(Note 3)
Watchdog timer flags (WDF1, WDF2)	X (Note 4)
Watchdog timer enable flag (WEF)	X (Note 4)
16-bit timer (WDT)	X (Note 4)
A-D conversion completion flag (ADF)	×
Serial I/O transmission/reception completion flag (SIOF)	×
Interrupt enable flag (INTE)	×
Notes 1:"O" represents that the function can be retained	d and "V" ransa

Notes 1:"O" represents that the function can be retained, and "X" represents that the function is initialized.

Registers and flags other than the above are undefined at RAM back-up, and set an initial value after returning.

- 2: The stack pointer (SP) points the level of the stack register and is initialized to "7" at RAM back-up.
- 3: The state of the timer is undefined.
- 4: Initialize the watchdog timer with the WRST instruction, and then execute the POF instruction.
- 5: The state is retained when the voltage comparator function is selected with the voltage comparator control register Q3.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

(4) Return signal

An external wakeup signal is used to return from the RAM back-up mode because the oscillation is stopped. Table 21 shows the return condition for each return source.

(5) Ports P0 and P1 control registers

- Key-on wakeup control register K0
 Register K0 controls the ports P0 and P1 key-on wakeup function. Set the contents of this register through register A with the TK0A instruction. In addition, the TAK0 instruction can be used to transfer the contents of register K0 to register A.
- Pull-up control register PU0
 Register PU0 controls the ON/OFF of the ports P0 and P1 pull-up transistor. Set the contents of this register through register A with the TPU0A instruction. In addition, the TAPU0 instruction can be used to transfer the contents of register PU0 to register A.

Table 21 Return source and return condition

Return source Return condition		Return condition	Remarks
edge input ("H"→"L").			Set the port using the key-on wakeup function selected with register K0 to "H" level before going into the RAM back-up state because the port P0 shares the falling edge detection circuit with port P1.
		"L" level input.	Select the return level ("L" level or "H" level) with the bit 2 of register I1 according to the external state before going into the RAM back-up state.
Exte	Port P31/INT1	Return by an external "H" level or "L" level input. The EXF1 flag is not set.	Select the return level ("L" level or "H" level) with the bit 2 of register I2 according to the external state before going into the RAM back-up state.



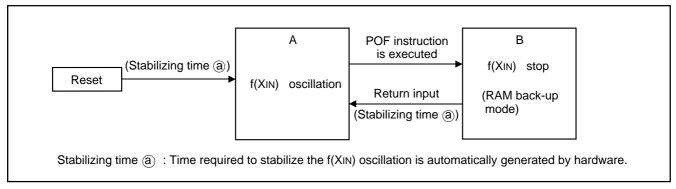


Fig. 38 State transition

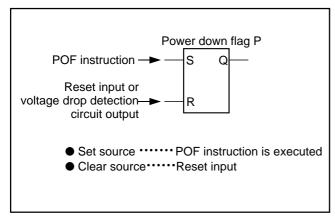


Fig. 39 Set source and clear source of the P flag

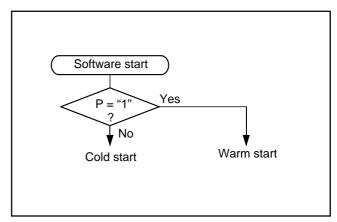


Fig. 40 Start condition identified example using the SNZP instruction

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

Table 22 Key-on wakeup control register, pull-up control register, and interrupt control register

	Key-on wakeup control register K0	at	reset: 00002	at RAM back-up : state retained	R/W						
I/Os	Pins P12 and P13 key-on wakeup	0	Key-on wakeup no	t used							
K03	control bit	1	Key-on wakeup use	ed							
1/0-	Pins P10 and P11 key-on wakeup	0	Key-on wakeup no	t used							
K02	control bit	1	Key-on wakeup use	Key-on wakeup used							
KO.	Pins P02 and P03 key-on wakeup	0	Key-on wakeup no	t used							
K01	control bit	1	Key-on wakeup use	ed							
I/Os	Pins P00 and P01 key-on wakeup	0	Key-on wakeup no	t used							
K0 0	control bit	1	Key-on wakeup use	ed							
	Pull-up control register PU0	at	reset : 00002	at RAM back-up : state retained	R/W						
D. 1.0	Pins P12 and P13 pull-up transistor	0	Pull-up transistor C) FF							
PU03	control bit	1	Pull-up transistor C	ON							
	Pins P10 and P11 pull-up transistor	0	Pull-up transistor C								
PU02	control bit	1	Pull-up transistor C	ON							
	Pins P02 and P03 pull-up transistor	0	Pull-up transistor C)FF							
PU01	control bit	1	Pull-up transistor C	ON							
	Pins P00 and P01 pull-up transistor	0	Pull-up transistor OFF								
PU0 ₀	control bit	1	Pull-up transistor C	ON							
	Interrupt control register I1	at	reset : 00002	at RAM back-up : state retained	R/W						
I1 3	Not used	0	This bit has no function, but read/write is enabled.								
	Interrupt valid waveform for INT0 pin/	0	Falling waveform ('instruction)/"L" leve	"L" level of INT0 pin is recognized with	the SNZI						
l12	return level selection bit (Note 2)	1	Rising waveform (" instruction)/"H" leve	H" level of INT0 pin is recognized with	the SNZI						
14.	INITO a la color de la color di constituire de la color de la colo	0	One-sided edge de	etected							
I1 1	INT0 pin edge detection circuit control bit	1	Both edges detected	ed							
14.5	INT0 pin	0	Disabled								
I1 0	timer 1 control enable bit	1	Enabled								
	Interrupt control register I2	at	reset : 00002	at RAM back-up : state retained	R/W						
I2 3	Not used	0	This bit has no fund	ction, but read/write is enabled.							
100	Interrupt valid waveform for INT1 pin/	0	Falling waveform ("instruction)/"L" leve	L" level of INT1 pin is recognized with tel	he SNZI1						
l2 2	return level selection bit (Note 3)	1	Rising waveform ("H" level of INT1 pin is recognized with the SNZI1 instruction)/"H" level								
10.	INITA ata adaa dataati ta ta ta ta ta	0	One-sided edge detected								
l21	INT1 pin edge detection circuit control bit	1	1 Both edges detected								
l20	INT1 pin	0	Disabled								

Notes 1: "R" represents read enabled, and "W" represents write enabled.



^{2:} When the contents of I12 is changed, the external interrupt request flag EXF0 may be set. Accordingly, clear EXF0 flag with the SNZ0 instruction.

^{3:} When the contents of 122 is changed, the external interrupt request flag EXF1 may be set. Accordingly, clear EXF1 flag with the SNZ1 instruction.

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

CLOCK CONTROL

The clock control circuit consists of the following circuits.

- System clock generating circuit
- · Control circuit to stop the clock oscillation

- Control circuit to switch the middle-speed mode and high-speed mode
- Control circuit to return from the RAM back-up state

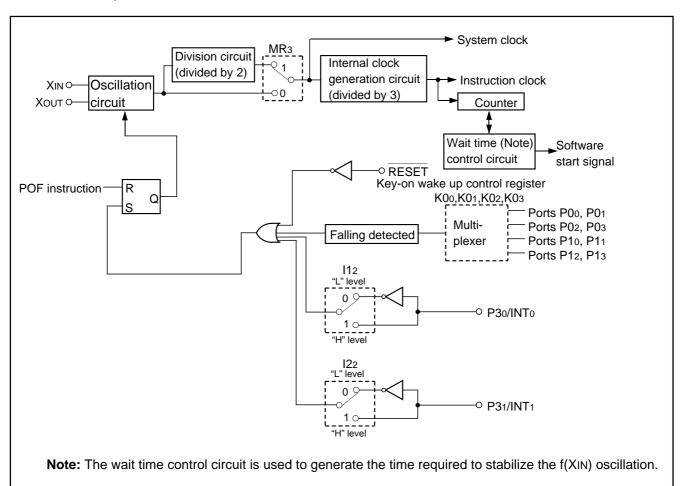


Fig. 41 Clock control circuit structure

Table 23 Clock control register MR

	Cicon common regional min									
	Clock control register MR	at	reset : 10002	at RAM back-up : 10002						
MR3	System clock solection bit	0	f(XIN) (high-speed mode)							
IVIK3	System clock selection bit	1	f(XIN)/2 (middle-speed mode)							
MR2	Not used	0	This bit has no function, but read/write is enabled.							
IVIK2	Not used	1	This bit has no function, but read/white is enabled.							
MR1	Not used	0	This hit has no fund	tion, but read/write is enabled.						
IVIK1	Not used	1	This bit has no fund	cion, but read/write is enabled.						
MRo	Not used	0	This hit has no fund	tion, but road/write is enabled						
IVIRO	Not used -	1	This bit has no function, but read/write is enabled.							

Note: "R" represents read enabled, and "W" represents write enabled.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

Clock signal f(XIN) is obtained by externally connecting a ceramic resonator.

Connect this external circuit to pins XIN and XOUT at the shortest distance. A feedback resistor is built in between pins XIN and XOUT. When an external clock signal is input, connect the clock source to XIN and leave XOUT open. When using an external clock, the maximum value of external clock oscillating frequency is shown in Table 24.

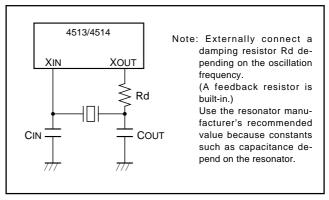


Fig. 42 Ceramic resonator external circuit

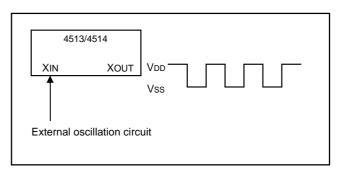


Fig. 43 External clock input circuit

Table 24 Maximum value of external clock oscillation frequency

		Supply voltage	Oscillation frequency (duty ratio)
Mask ROM version	Middle-speed mode	VDD = 2.0 V to 5.5 V	3.0 MHz (40 % to 60 %)
		VDD = 4.0 V to 5.5 V	3.0 MHz (40 % to 60 %)
Wask ROW Version	High-speed mode	VDD = 2.5 V to 5.5 V	1.0 MHz (40 % to 60 %)
		VDD = 2.0 V to 5.5 V	0.8 MHz (40 % to 60 %)
	Middle-speed mode	VDD = 2.5 V to 5.5 V	3.0 MHz (40 % to 60 %)
One Time PROM version	High-speed mode	VDD = 4.0 V to 5.5 V	3.0 MHz (40 % to 60 %)
	r light-speed mode	VDD = 2.5 V to 5.5 V	1.0 MHz (40 % to 60 %)

ROM ORDERING METHOD

- 1.Mask ROM Order Confirmation Form*
- 2.Mark Specification Form*
- Data to be written to ROM, in EPROM form (three identical copies) or one floppy disk.

*For the mask ROM confirmation and the mark specifications, refer to the "Mitsubishi MCU Technical Information" Homepage (http://www.infomicom.maec.co.jp/indexe.htm).



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

LIST OF PRECAUTIONS

① Noise and latch-up prevention

Connect a capacitor on the following condition to prevent noise and latch-up;

- connect a bypass capacitor (approx. 0.1 μ F) between pins VDD and Vss at the shortest distance,
- equalize its wiring in width and length, and
- use relatively thick wire.

In the One Time PROM version, CNVss pin is also used as VPP pin. Accordingly, when using this pin, connect this pin to Vss through a resistor about 5 $k\Omega$ in series at the shortest distance.

2 Prescaler

Stop the prescaler operation to change its frequency dividing ratio.

3 Timer count source

Stop timer 1, 2, 3, or 4 counting to change its count source.

4 Reading the count value

Stop timer 1, 2, 3, or 4 counting and then execute the TAB1, TAB2, TAB3, or TAB4 instruction to read its data.

©Writing to reload registers R1 and R3

When writing data to reload registers R1 or R3 while timer 1 or timer 3 is operating, avoid a timing when timer 1 or timer 3 underflows.

6P30/INT0 pin

When the interrupt valid waveform of the P30/INT0 pin is changed with the bit 2 of register I1 in software, be careful about the following notes.

- Clear the bit 0 of register V1 to "0" before the interrupt valid waveform of P30/INT0 pin is changed with the bit 2 of register I1 (refer to Figure 44①).
- Depending on the input state of the P3o/INT0 pin, the external 0 interrupt request flag (EXF0) may be set when the interrupt valid waveform is changed. Accordingly, clear bit 2 of register I1, and execute the SNZ0 instruction to clear the EXF0 flag after executing at least one instruction (refer to Figure 44[®])

Fig. 44 External 0 interrupt program example

②P31/INT1 pin

When the interrupt valid waveform of P31/INT1 pin is changed with the bit 2 of register I2 in software, be careful about the following notes.

- Clear the bit 1 of register V1 to "0" before the interrupt valid waveform of P31/INT1 pin is changed with the bit 2 of register I2 (refer to Figure 45³).
- Depending on the input state of the P31/INT1 pin, the external 1 interrupt request flag (EXF1) may be set when the interrupt valid waveform is changed. Accordingly, clear bit 2 of register I2 and execute the SNZ1 instruction to clear the EXF1 flag after executing at least one instruction (refer to Figure 45⁽⁴⁾).

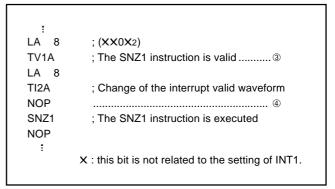


Fig. 45 External 1 interrupt program example

® One Time PROM version

The operating power voltage of the One Time PROM version is $2.5\ V$ to $5.5\ V$.

Multifunction

The input of D6, D7, P20–P22, I/O of P30 and P31, input of CMP0-, CMP0+, CMP1-, CMP1+, and I/O of P40–P43 can be used even when CNTR0, CNTR1, SCK, SOUT, SIN, INT0, INT1, AIN0–AIN3 and AIN4–AIN7 are selected.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

A-D converter-1

When the operating mode of the A-D converter is changed from the comparator mode to the A-D conversion mode with the bit 3 of register Q2 in a program, be careful about the following notes.

- Clear the bit 2 of register V2 to "0" to change the operating mode of the A-D converter from the comparator mode to the A-D conversion mode with the bit 3 of register Q2 (refer to Figure 46®).
- The A-D conversion completion flag (ADF) may be set when the operating mode of the A-D converter is changed from the comparator mode to the A-D conversion mode. Accordingly, set a value to register Q2, and execute the SNZAD instruction to clear the ADF flag.

Do not change the operating mode (both A-D conversion mode and comparator mode) of A-D converter with the bit 3 of register Q2 during operating the A-D converter.

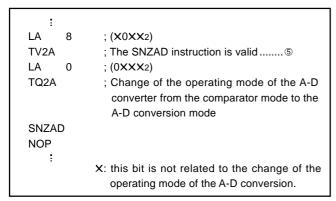


Fig. 46 A-D converter operating mode program example

[®]A-D converter-2

Each analog input pin is equipped with a capacitor which is used to compare the analog voltage. Accordingly, when the analog voltage is input from the circuit with high-impedance and, charge/discharge noise is generated and the sufficient A-D accuracy may not be obtained. Therefore, reduce the impedance or, connect a capacitor (0.01 μF to 1 μF) to analog input pins (Figure 47).

When the overvoltage applied to the A-D conversion circuit may occur, connect an external circuit in order to keep the voltage within the rated range as shown the Figure 48. In addition, test the application products sufficiently.

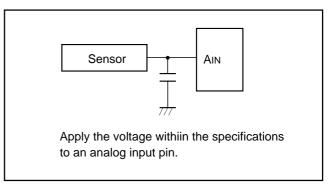


Fig. 47 Analog input external circuit example-1

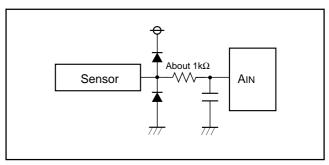


Fig. 48 Analog input external circuit example-2

@POF instruction

Execute the POF instruction immediately after executing the EPOF instruction to enter the RAM back-up.

Note that system cannot enter the RAM back-up state when executing only the POF instruction.

Be sure to disable interrupts by executing the DI instruction before executing the EPOF instruction.

Analog input pins

Note the following when using the analog input pins also for I/O port P4 functions:

- Even when P40/AIN4—P43/AIN7 are set to pins for analog input, they continue to function as P40—P43 I/O. Accordingly, when any of them are used as I/O port P4 and others are used as analog input pins, make sure to set the outputs of pins that are set for analog input to "1." Also, the port input function of the pin functions as an analog input is undefined.
- TALA instruction

When the TALA instruction is executed, the low-order 2 bits of register AD is transferred to the high-order 2 bits of register A, simultaneously, the low-order 2 bits of register A is "0."

13 Program counter

Make sure that the PCH does not specify after the last page of the built-in ROM.

®Port P3

In the 4513 Group, when the IAP3 instruction is executed, note that the high-order 2 bits of register A is undefined.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

[®] Voltage comparator function

When the voltage comparator function is valid with the voltage comparator control register Q3, it is operating even in the RAM back-up mode. Accordingly, be careful about such state because it causes the increase of the operation current in the RAM back-up mode.

In order to reduce the operation current in the RAM back-up mode, invalidate (bits 2 and 3 of register Q3 = "0") the voltage comparator function by software before the POF instruction is executed.

Also, while the voltage comparator function is valid, current is always consumed by voltage comparator. On the system required for the low-power dissipation, invalidate the voltage comparator when it is unused by software.

® Register Q3

Bits 0 and 1 of register Q3 can be only read. Note that they cannot be written.

® Reading the comparison result of voltage comparator

Read the voltage comparator comparison result from register Q3 after the voltage comparator response time (max. 20 μ s) is passed from the voltage comparator function become valid.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

SYMBOL

The symbols shown below are used in the following instruction function table and instruction list.

Symbol	Contents	Symbol	Contents
Α	Register A (4 bits)	T1F	Timer 1 interrupt request flag
В	Register B (4 bits)	T2F	Timer 2 interrupt request flag
DR	Register D (3 bits)	T3F	Timer 3 interrupt request flag
E	Register E (8 bits)	T4F	Timer 4 interrupt request flag
Q1	A-D control register Q1 (4 bits)	WDF1	Watchdog timer flag
Q2	A-D control register Q2 (4 bits)	WEF	Watchdog timer enable flag
Q3	Voltage comparator control register Q3 (4 bits)	INTE	Interrupt enable flag
AD	Successive comparison register AD (10 bits)	EXF0	External 0 interrupt request flag
J1	Serial I/O mode register J1 (4 bits)	EXF1	External 1 interrupt request flag
SI	Serial I/O register SI (8 bits)	Р	Power down flag
V1	Interrupt control register V1 (4 bits)	ADF	A-D conversion completion flag
V2	Interrupt control register V2 (4 bits)	SIOF	Serial I/O transmission/reception completion flag
I 1	Interrupt control register I1 (4 bits)		
12	Interrupt control register I2 (4 bits)	D	Port D (8 bits)
W1	Timer control register W1 (4 bits)	P0	Port P0 (4 bits)
W2	Timer control register W2 (4 bits)	P1	Port P1 (4 bits)
W3	Timer control register W3 (4 bits)	P2	Port P2 (3 bits)
W4	Timer control register W4 (4 bits)	P3	Port P3 (4 bits)
W6	Timer control register W6 (4 bits)	P4	Port P4 (4 bits)
MR	Clock control register MR (4 bits)	P5	Port P5 (4 bits)
K0	Key-on wakeup control register K0 (4 bits)		
PU0	Pull-up control register PU0 (4 bits)	x	Hexadecimal variable
FR0	Direction register FR0 (4 bits)	у	Hexadecimal variable
X	Register X (4 bits)	z	Hexadecimal variable
Υ	Register Y (4 bits)	р	Hexadecimal variable
Z	Register Z (2 bits)	n	Hexadecimal constant
DP	Data pointer (10 bits)	i	Hexadecimal constant
	(It consists of registers X, Y, and Z)	j	Hexadecimal constant
PC	Program counter (14 bits)	A3A2A1A0	Binary notation of hexadecimal variable A
РСн	High-order 7 bits of program counter		(same for others)
PCL	Low-order 7 bits of program counter		
SK	Stack register (14 bits X 8)	←	Direction of data movement
SP	Stack pointer (3 bits)	\leftrightarrow	Data exchange between a register and memory
CY	Carry flag	?	Decision of state shown before "?"
R1	Timer 1 reload register	()	Contents of registers and memories
R2	Timer 2 reload register	1-	Negate, Flag unchanged after executing instruction
R3	Timer 3 reload register	M(DP)	RAM address pointed by the data pointer
R4	Timer 4 reload register	а	Label indicating address a6 a5 a4 a3 a2 a1 a0
T1	Timer 1	р, а	Label indicating address a6 a5 a4 a3 a2 a1 a0
T2	Timer 2		in page p5 p4 p3 p2 p1 p0
Т3	Timer 3	С	Hex. C + Hex. number x (also same for others)
T4	Timer 4	+	
		х	

Note: The 4513/4514 Group just invalidates the next instruction when a skip is performed. The contents of program counter is not increased by 2. Accordingly, the number of cycles does not change even if skip is not performed. However, the cycle count becomes "1" if the TABP p, RT, or RTS instruction is skipped.



LIST OF INSTRUCTION FUNCTION

Group- ing	Mnemonic	Function	Group- ing	Mnemonic	Function	Group- ing	Mnemonic	Function
	TAB	$(A) \leftarrow (B)$	fer	XAMI j	$(A) \leftarrow \rightarrow (M(DP))$ $(X) \leftarrow (X)EXOR(j)$		SB j	(Mj(DP)) ← 1 j = 0 to 3
	ТВА	(B) ← (A)	er transf		$j = 0 \text{ to } 15$ $(Y) \leftarrow (Y) + 1$	ation	RB j	, (Mj(DP)) ← 0
	TAY	(A) ← (Y)	registe	TMA j	$(M(DP)) \leftarrow (A)$	Bit operation		j = 0 to 3
	TYA	(Y) ← (A)	RAM to register transfer		$(X) \leftarrow (X)EXOR(j)$ j = 0 to 15	ш	SZB j	(Mj(DP)) = 0 ? j = 0 to 3
sfer	TEAB	$(E7-E4) \leftarrow (B)$ $(E3-E0) \leftarrow (A)$		LA n	(A) ← n	son	SEAM	(A) = (M(DP)) ?
Register to register transfer	TABE	(B) ← (E7–E4) (A) ← (E3–E0)		ТАВР р	n = 0 to 15 $(SP) \leftarrow (SP) + 1$ $(SK(SP)) \leftarrow (PC)$	Comparison operation	SEA n	(A) = n? n = 0 to 15
ter to re	TDA	$(DR2-DR0) \leftarrow (A2-A0)$			$(PCH) \leftarrow p$ $(PCL) \leftarrow (DR2-DR0,$	_	Ва	(PCL) ← a6-a0
Regis	TAD	$ (A2-A0) \leftarrow (DR2-DR0) $ $ (A3) \leftarrow 0 $			A3-A0) $(B) \leftarrow (ROM(PC))7-4$ $(A) \leftarrow (ROM(PC))3-0$	Branch operation	BL p, a	(PCH) ← p (PCL) ← a6–a0
	TAZ	$(A_1, A_0) \leftarrow (Z_1, Z_0)$ $(A_3, A_2) \leftarrow 0$			$(PC) \leftarrow (SK(SP))$ $(SP) \leftarrow (SP) - 1$	Branch	BLA p	(PCH) ← p (PCL) ← (DR2–DR0, A3–A0)
	TAX	$(A) \leftarrow (X)$		AM	$(A) \leftarrow (A) + (M(DP))$		ВМа	(SP) ← (SP) + 1
	TASP	$ (A2-A0) \leftarrow (SP2-SP0) $ $ (A3) \leftarrow 0 $		AMC	$(A) \leftarrow (A) + (M(DP)) + (CY)$ $(CY) \leftarrow Carry$		DW Q	$(SK(SP)) \leftarrow (PC)$ $(PCH) \leftarrow 2$ $(PCL) \leftarrow a6-a0$
ses	LXY x, y	$(X) \leftarrow x, x = 0 \text{ to } 15$ $(Y) \leftarrow y, y = 0 \text{ to } 15$	Arithmetic operation	A n	$(A) \leftarrow (A) + n$ n = 0 to 15	Subroutine operation	BML p, a	(SP) ← (SP) + 1 (SK(SP)) ← (PC)
RAM addresses	LZ z	$(Z) \leftarrow z, z = 0 \text{ to } 3$	hmetic	AND	$(A) \leftarrow (A) \text{ AND } (M(DP))$	outine o		(PCH) ← p (PCL) ← a6-a0
RAM	INY	$(Y) \leftarrow (Y) + 1$	Arit	OR	$(A) \leftarrow (A) \ OR \ (M(DP))$	Subre	BMLA p	(SP) ← (SP) + 1
	DEY	(Y) ← (Y) − 1	-	sc	(CY) ← 1			$(SK(SP)) \leftarrow (PC)$ $(PCH) \leftarrow p$
	TAM j	$(A) \leftarrow (M(DP))$ $(X) \leftarrow (X)EXOR(j)$ j = 0 to 15		RC	(CY) ← 0			(PCL) ← (DR2–DR0, A3–A0)
transfeı	XAM j	$(A) \leftarrow \rightarrow (M(DP))$		szc	(CY) = 0 ?		RTI	$(PC) \leftarrow (SK(SP))$ $(SP) \leftarrow (SP) - 1$
RAM to register transfer		$(X) \leftarrow (X)EXOR(j)$ j = 0 to 15		CMA RAR	$(A) \leftarrow (\overline{A})$ $ \rightarrow \overline{CY} \rightarrow \overline{A3A2A1A0} \rightarrow$	peration	RT	$(PC) \leftarrow (SK(SP))$ $(SP) \leftarrow (SP) - 1$
RAM to	XAMD j	$(A) \leftarrow \rightarrow (M(DP))$ $(X) \leftarrow (X)EXOR(j)$ $j = 0 \text{ to } 15$ $(Y) \leftarrow (Y) - 1$			/OT /NONZAINU	Return operation	RTS	$(PC) \leftarrow (SK(SP))$ $(SP) \leftarrow (SP) - 1$



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

	TI CIN TO	RUCTION FUNCTION	JN (CC	ntinuea				
Group- ing	Mnemonic	Function	Group- ing	Mnemonic	Function	Group- ing	Mnemonic	Function
	DI	$(INTE) \leftarrow 0$		TAW4	(A) ← (W4)		SNZT1	(T1F) = 1 ? After skipping
	EI	(INTE) ← 1		TW4A	(W4) ← (A)			$(T1F) \leftarrow 0$
	SNZ0	(EXF0) = 1 ?		TAW6	(A) ← (W6)		SNZT2	(T2F) = 1 ?
		After skipping				L C		After skipping
		(EXF0) ← 0		TW6A	(W6) ← (A)	Timer operation		(T2F) ← 0
	SNZ1	(EXF1) = 1 ?		TAB1	(B) ← (T17–T14)	0 5	SNZT3	(T3F) = 1 ?
		After skipping			$(A) \leftarrow (T13-T10)$	<u> </u>		After skipping
		(EXF1) ← 0			(1.7)	-		(T3F) ← 0
		,		T1AB	(R17–R14) ← (B)			,
	SNZI0	I12 = 1 : (INT0) = "H" ?			(T17–T14) ← (B)		SNZT4	(T4F) = 1 ?
		I12 = 0 : (INT0) = "L" ?			(R13–R10) ← (A)			After skipping
i o		,			(T13–T10) ← (A)			(T4F) ← 0
nterrupt operation	SNZI1	I22 = 1 : (INT1) = "H" ?			, , ,			
g		I22 = 0 : (INT1) = "L" ?		TAB2	(B) ← (T27–T24)		IAP0	(A) ← (P0)
nbt		, ,			$(A) \leftarrow (T23-T20)$			
err	TAV1	(A) ← (V1)			· / · · · · · · · · · ·		OP0A	(P0) ← (A)
<u>=</u>				T2AB	(R27–R24) ← (B)			() ()
	TV1A	(V1) ← (A)			$(T27-T24) \leftarrow (B)$		IAP1	(A) ← (P1)
		(, (,			$(R23-R20) \leftarrow (A)$			(,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
	TAV2	(A) ← (V2)	ion		$(T23-T20) \leftarrow (A)$		OP1A	(P1) ← (A)
	TV2A	(V2) ← (A)	Timer operation	TAB3	(B) ← (T37–T34)		IAP2	$(A_2-A_0) \leftarrow (P2_2-P2_0)$
		(*=)	er o		$(A) \leftarrow (T33-T30)$			$(A3) \leftarrow 0$
	TAI1	(A) ← (I1)	Ë					,
				T3AB	(R37–R34) ← (B)		IAP3	(A) ← (P3)
	TI1A	(I1) ← (A)			(T37–T34) ← (B)			
					$(R33-R30) \leftarrow (A)$	l lo	OP3A	(P3) ← (A)
	TAI2	(A) ← (I2)			$(T33-T30) \leftarrow (A)$	rati		
						obe	IAP4*	(A) ← (P4)
	TI2A	(I2) ← (A)		TAB4	(B) ← (T47–T44)	ont		
					$(A) \leftarrow (T43-T40)$	Output operation	OP4A*	(P4) ← (A)
	TAW1	$(A) \leftarrow (W1)$						
				T4AB	$(R47\text{-}R44) \leftarrow (B)$	Input/	IAP5*	(A) ← (P5)
	TW1A	$(W1) \leftarrow (A)$			$(T47-T44) \leftarrow (B)$			
					$(R43\text{-}R40) \leftarrow (A)$		OP5A*	(P5) ← (A)
	TAW2	$(A) \leftarrow (W2)$			$(T43-T40) \leftarrow (A)$			
ion							CLD	(D) ← 1
Timer operation	TW2A	$(W2) \leftarrow (A)$		TR1AB	$(R17\text{-}R14) \leftarrow (B)$			
do					$(R13-R10) \leftarrow (A)$		RD	$(D(Y)) \leftarrow 0$
ner	TAW3	$(A) \leftarrow (W3)$						(Y) = 0 to 7
⊨				TR3AB	$(R37\text{-}R34) \leftarrow (B)$			
	TW3A	$(W3) \leftarrow (A)$			$(R33-R30) \leftarrow (A)$		SD	(D(Y)) ← 1
								(Y) = 0 to 7
							SZD	(D(Y)) = 0 ?
								(Y) = 0 to 7

^{*:} The 4513 Group does not have these instructions.



LIST OF INSTRUCTION FUNCTION (continued)

Group-		RUCTION FUNCTI	ON (Co Group-	ontinued)
ing	Mnemonic	Function	ing	Mnemonic	Function
<u>_</u>	TK0A	(K0) ← (A)		TABAD	$(A) \leftarrow (AD5-AD2)$ $(B) \leftarrow (AD9-AD6)$
peratic	TAK0	(A) ← (K0)			However, in the comparator mode,
utput o	TPU0A	(PU0) ← (A)			$ (A) \leftarrow (AD3-AD0) $ $ (B) \leftarrow (AD7-AD4) $
Input/Output operation	TAPU0	(A) ← (PU0)		TALA	$(A) \leftarrow (AD1, AD0, 0, 0)$
	TFR0A*	(FR0) ← (A)	Ē	TADAB	(AD3–AD0) ← (A)
	TABSI	$(A) \leftarrow (SI3-SI0)$ $(B) \leftarrow (SI7-SI4)$	peratic		(AD7–AD4) ← (B)
	TSIAB	$(SI3-SI0) \leftarrow (A)$	sion o	TAQ1	(A) ← (Q1)
ation	IOIAD	$(S17-S14) \leftarrow (B)$	A-D conversion operation	TQ1A	(Q1) ← (A)
ol oper	TAJ1	(A) ← (J1)	A-D	ADST	(ADF) ← 0 A-D conversion starting
Serial I/O control operation	TJ1A	(J1) ← (A)		SNZAD	(ADF) = 1 ?
0	SST	(SIOF) ← 0		SNZAD	After skipping
Seri		Serial I/O starting			(ADF) ← 0
	SNZSI	(SIOF) = 1 ?		TAQ2	(A) ← (Q2)
		After skipping (SIOF) ← 0		TQ2A	(Q2) ← (A)
				NOP	(PC) ← (PC) + 1
				POF	RAM back-up
				EPOF	POF instruction valid
				SNZP	(P) = 1 ?
			eration	WRST	$(WDF1) \leftarrow 0, (WEF) \leftarrow 1$
			Other operation	TAMR	$(A) \leftarrow (MR)$
			ō	TMRA	$(MR) \leftarrow (A)$
				TAQ3	(A) ← (Q3)
				TQ3A	$\begin{array}{l} (\text{Q33, Q32}) \leftarrow (\text{A3, A2}) \\ (\text{Q31}) \leftarrow (\text{CMP1 comparison result}) \\ (\text{Q30}) \leftarrow (\text{CMP0 comparison result}) \end{array}$

^{*:} The 4513 Group does not have these instructions.



INSTRUCTION CODE TABLE (for 4513 Group)

11131	1100	HON	COL	<u>/L /</u>	OLL	(101	4513	GIO	<u> </u>										
	D9-D4	000000	000001	000010	000011	000100	000101	000110	000111	001000	001001	001010	001011	001100	001101	001110		010000 010111	
D3-D0	Hex. notation	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10–17	18–1F
0000	0	NOP	BLA	SZB 0	BMLA	1	TASP	A 0	LA 0	TABP 0	TABP 16***	TABP 32**	TABP 48*	BML	BML***	BL	BL***	вм	В
0001	1	_	CLD	SZB 1	-	-	TAD	A 1	LA 1	TABP 1	TABP 17***	TABP 33**	TABP 49*	BML	BML***	BL	BL***	вм	В
0010	2	POF	-	SZB 2	_	-	TAX	A 2	LA 2	TABP 2	TABP 18***	TABP 34**	TABP 50*	BML	BML***	BL	BL***	вм	В
0011	3	SNZP	INY	SZB 3	_	1	TAZ	A 3	LA 3	TABP 3	TABP 19***	TABP 35**	TABP 51*	BML	BML***	BL	BL***	вм	В
0100	4	DI	RD	SZD	_	RT	TAV1	A 4	LA 4	TABP 4	TABP 20***	TABP 36**	TABP 52*	BML	BML***	BL	BL***	ВМ	В
0101	5	EI	SD	SEAn	_	RTS	TAV2	A 5	LA 5	TABP 5	TABP 21***	TABP 37**	TABP 53*	BML	BML***	BL	BL***	ВМ	В
0110	6	RC	-	SEAM	-	RTI	_	A 6	LA 6	TABP 6	TABP 22***	TABP 38**	TABP 54*	BML	BML***	BL	BL***	ВМ	В
0111	7	sc	DEY	_	_	_	_	A 7	LA 7	TABP 7	TABP 23***	TABP 39**	TABP 55*	BML	BML***	BL	BL***	ВМ	В
1000	8	_	AND	_	SNZ0	LZ 0	_	A 8	LA 8	TABP 8	TABP 24***	TABP 40**	TABP 56*	BML	BML***	BL	BL***	ВМ	В
1001	9	_	OR	TDA	SNZ1	LZ 1	_	A 9	LA 9	TABP 9	TABP 25***	TABP 41**	TABP 57*	BML	BML***	BL	BL***	ВМ	В
1010	Α	AM	TEAB	TABE	SNZI0	LZ 2	_	A 10	LA 10	TABP 10	TABP 26***	TABP 42**	TABP 58*	BML	BML***	BL	BL***	ВМ	В
1011	В	AMC	-	_	SNZI1	LZ 3	EPOF	A 11	LA 11	TABP 11	TABP 27***	TABP 43**	TABP 59*	BML	BML***	BL	BL***	ВМ	В
1100	С	TYA	СМА	_	_	RB 0	SB 0	A 12	LA 12	TABP 12	TABP 28***	TABP 44**	TABP 60*	BML	BML***	BL	BL***	вм	В
1101	D	_	RAR	_	ı	RB 1	SB 1	A 13	LA 13	TABP 13	TABP 29***	TABP 45**	TABP 61*	BML	BML***	BL	BL***	вм	В
1110	Е	ТВА	TAB	_	TV2A	RB 2	SB 2	A 14	LA 14	TABP 14	TABP 30***	TABP 46**	TABP 62*	BML	BML***	BL	BL***	ВМ	В
1111	F		TAY	szc	TV1A	RB 3	SB 3	A 15	LA 15	TABP 15	TABP 31***	TABP 47**	TABP 63*	BML	BML***	BL	BL***	вм	В

The above table shows the relationship between machine language codes and machine language instructions. D3–D0 show the low-order 4 bits of the machine language code, and D9–D4 show the high-order 6 bits of the machine language code. The hexadecimal representation of the code is also provided. There are one-word instructions and two-word instructions, but only the first word of each instruction is shown. Do not use code marked "–."

The codes for the second word of a two-word instruction are described below.

	The	secon	d word
BL	10	paaa	aaaa
BML	10	paaa	aaaa
BLA	10	pp00	pppp
BMLA	10	pp00	pppp
SEA	00	0111	nnnn
SZD	00	0010	1011

- *, **, and *** cannot be used in the M34513M2-XXXSP/FP.
- * and ** cannot be used in the M34513M4-XXXSP/FP.
- * and ** cannot be used in the M34513E4FP.
- * cannot be used in the M34513M6-XXXFP.



INSTRUCTION CODE TABLE (continued) (for 4513 Group)

IIVOI	RUC	HON	COL	/C <i>F</i>	OLE	(COII	illilue	;u) (ı	UI 43	13 G	roup)						
	D9-D4	100000	100001	100010	100011	100100	100101	100110	100111	101000	101001	101010	101011	101100	101101	101110	101111	110000 111111
D3-D0	Hex. notation	20	21	22	23	24	25	26	27	28	29	2A	2B	2C	2D	2E	2F	30–3F
0000	0	-	TW3A	OP0A	T1AB	-	TAW6	IAP0	TAB1	SNZT1	-	WRST	TMA 0	TAM 0	XAM 0	XAMI 0	XAMD 0	LXY
0001	1	-	TW4A	OP1A	T2AB	-	_	IAP1	TAB2	SNZT2	-	-	TMA 1	TAM 1	XAM 1	XAMI 1	XAMD 1	LXY
0010	2	TJ1A	_	_	ТЗАВ	TAJ1	TAMR	IAP2	TAB3	SNZT3	_	-	TMA 2	TAM 2	XAM 2	XAMI 2	XAMD 2	LXY
0011	3	_	TW6A	ОР3А	T4AB	_	TAI1	IAP3	TAB4	SNZT4	_	_	TMA 3	TAM 3	XAM 3	XAMI 3	XAMD 3	LXY
0100	4	TQ1A	-	-	_	TAQ1	TAI2	_	-	_	-	-	TMA 4	TAM 4	XAM 4	XAMI 4	XAMD 4	LXY
0101	5	TQ2A	_	-	-	TAQ2	_	-	-	_	_	_	TMA 5	TAM 5	XAM 5	XAMI 5	XAMD 5	LXY
0110	6	TQ3A	TMRA	-	-	TAQ3	TAK0	-	-	_	_	-	TMA 6	TAM 6	XAM 6	XAMI 6	XAMD 6	LXY
0111	7	-	TI1A	-	_	_	TAPU0	_	-	SNZAD	-	-	TMA 7	TAM 7	XAM 7	XAMI 7	XAMD 7	LXY
1000	8	Ī	TI2A	-	TSIAB	ı	_	-	TABSI	SNZSI	-	-	TMA 8	TAM 8	XAM 8	XAMI 8	XAMD 8	LXY
1001	9	_	_	_	TADAB	TALA	_	-	TABAD	_	_	_	TMA 9	TAM 9	XAM 9	XAMI 9	XAMD 9	LXY
1010	А	_	_	_	_	_	_	-	_	_	_	_	TMA 10	TAM 10	XAM 10	XAMI 10	XAMD 10	LXY
1011	В	_	TK0A	_	TR3AB	TAW1	_	-	_	_	_	_	TMA 11	TAM 11	XAM 11	XAMI 11	XAMD 11	LXY
1100	С	_	_	_	_	TAW2	_	-	_	_	_	_	TMA 12	TAM 12	XAM 12	XAMI 12	XAMD 12	LXY
1101	D	_	_	TPU0A	_	TAW3	_	-	_	_	_	_	TMA 13	TAM 13	XAM 13	XAMI 13	XAMD 13	LXY
1110	Е	TW1A	_	ı	1	TAW4	_	-	ı	_	SST	-	TMA 14	TAM 14	XAM 14	XAMI 14	XAMD 14	LXY
1111	F	TW2A	_	ı	TR1AB	_	_	_	-	_	ADST	_	TMA 15	TAM 15	XAM 15	XAMI 15	XAMD 15	LXY

The above table shows the relationship between machine language codes and machine language instructions. D3–D0 show the low-order 4 bits of the machine language code, and D9–D4 show the high-order 6 bits of the machine language code. The hexadecimal representation of the code is also provided. There are one-word instructions and two-word instructions, but only the first word of each instruction is shown. Do not use code marked "—."

The codes for the second word of a two-word instruction are described below.

	The	The second word											
BL	10	paaa	aaaa										
BML	10	paaa	aaaa										
BLA	10	pp00	pppp										
BMLA	10	pp00	pppp										
SEA	00	0111	nnnn										
SZD	00	0010	1011										



INSTRUCTION CODE TABLE (for 4514 Group)

	D9-D4	000000	000001	000010	000011	000100	000101	000110	000111	001000	001001	001010	001011	001100	001101	001110	001111	010000	
D3-D0	Hex. notation	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F		18–1F
0000	0	NOP	BLA	SZB 0	BMLA	_	TASP	A 0	LA 0	TABP 0	TABP 16	TABP 32	TABP 48*	BML	BML	BL	BL	ВМ	В
0001	1	_	CLD	SZB 1	_		TAD	A 1	LA 1	TABP 1	TABP 17	TABP 33	TABP 49*	BML	BML	BL	BL	ВМ	В
0010	2	POF	ı	SZB 2	_	_	TAX	A 2	LA 2	TABP 2	TABP 18	TABP 34	TABP 50*	BML	BML	BL	BL	ВМ	В
0011	3	SNZP	INY	SZB 3	_	_	TAZ	A 3	LA 3	TABP 3	TABP 19	TABP 35	TABP 51*	BML	BML	BL	BL	ВМ	В
0100	4	DI	RD	SZD	_	RT	TAV1	A 4	LA 4	TABP 4	TABP 20	TABP 36	TABP 52*	BML	BML	BL	BL	ВМ	В
0101	5	EI	SD	SEAn	_	RTS	TAV2	A 5	LA 5	TABP 5	TABP 21	TABP 37	TABP 53*	BML	BML	BL	BL	ВМ	В
0110	6	RC	-	SEAM	-	RTI	_	A 6	LA 6	TABP 6	TABP 22	TABP 38	TABP 54*	BML	BML	BL	BL	ВМ	В
0111	7	SC	DEY	_	-	_	_	A 7	LA 7	TABP 7	TABP 23	TABP 39	TABP 55*	BML	BML	BL	BL	ВМ	В
1000	8	1	AND	_	SNZ0	LZ 0	_	A 8	LA 8	TABP 8	TABP 24	TABP 40	TABP 56*	BML	BML	BL	BL	ВМ	В
1001	9	1	OR	TDA	SNZ1	LZ 1	_	A 9	LA 9	TABP 9	TABP 25	TABP 41	TABP 57*	BML	BML	BL	BL	ВМ	В
1010	Α	AM	TEAB	TABE	SNZI0	LZ 2	_	A 10	LA 10	TABP 10	TABP 26	TABP 42	TABP 58*	BML	BML	BL	BL	ВМ	В
1011	В	AMC	ı	_	SNZI1	LZ 3	EPOF	A 11	LA 11	TABP 11	TABP 27	TABP 43	TABP 59*	BML	BML	BL	BL	ВМ	В
1100	С	TYA	СМА	-	_	RB 0	SB 0	A 12	LA 12	TABP 12	TABP 28	TABP 44	TABP 60*	BML	BML	BL	BL	ВМ	В
1101	D	1	RAR	_	1	RB 1	SB 1	A 13	LA 13	TABP 13	TABP 29	TABP 45	TABP 61*	BML	BML	BL	BL	ВМ	В
1110	Е	ТВА	TAB	_	TV2A	RB 2	SB 2	A 14	LA 14	TABP 14	TABP 30	TABP 46	TABP 62*	BML	BML	BL	BL	ВМ	В
1111	F	_	TAY	szc	TV1A	RB 3	SB 3	A 15	LA 15	TABP 15	TABP 31	TABP 47	TABP 63*	BML	BML	BL	BL	ВМ	В

The above table shows the relationship between machine language codes and machine language instructions. D3–D0 show the low-order 4 bits of the machine language code, and D9–D4 show the high-order 6 bits of the machine language code. The hexadecimal representation of the code is also provided. There are one-word instructions and two-word instructions, but only the first word of each instruction is shown. Do not use code marked "–."

The codes for the second word of a two-word instruction are described below.

	The second word										
BL	10	paaa	aaaa								
BML	10	paaa	aaaa								
BLA	10	pp00	pppp								
BMLA	10	pp00	pppp								
SEA	00	0111	nnnn								
SZD	00	0010	1011								

• * cannot be used in the M34514M6-XXXFP.



INSTRUCTION CODE TABLE (continued) (for 4514 Group)

) - D.	400000	400004	400040	400044	400400	400404	400440	100111	404000	101001	101010	404044	404400	404404	404440	101111	110000
//r	09–D4 `	100000	100001	100010	100011	100100	100101	100110	100111	101000	101001	101010	101011	101100	101101	101110	101111	111111
D3-D0	Hex. notation	20	21	22	23	24	25	26	27	28	29	2A	2B	2C	2D	2E	2F	30–3F
0000	0	-	TW3A	OP0A	T1AB	_	TAW6	IAP0	TAB1	SNZT1	_	WRST	TMA 0	TAM 0	XAM 0	XAMI 0	XAMD 0	LXY
0001	1	-	TW4A	OP1A	T2AB	_	_	IAP1	TAB2	SNZT2	_	_	TMA 1	TAM 1	XAM 1	XAMI 1	XAMD 1	LXY
0010	2	TJ1A	-	_	ТЗАВ	TAJ1	TAMR	IAP2	TAB3	SNZT3	_	_	TMA 2	TAM 2	XAM 2	XAMI 2	XAMD 2	LXY
0011	3	-	TW6A	ОР3А	T4AB	_	TAI1	IAP3	TAB4	SNZT4	_	_	TMA 3	TAM 3	XAM 3	XAMI 3	XAMD 3	LXY
0100	4	TQ1A	-	OP4A	_	TAQ1	TAI2	IAP4	_	_	_	_	TMA 4	TAM 4	XAM 4	XAMI 4	XAMD 4	LXY
0101	5	TQ2A	-	OP5A	_	TAQ2	_	IAP5	_	_	_	_	TMA 5	TAM 5	XAM 5	XAMI 5	XAMD 5	LXY
0110	6	TQ3A	TMRA	_	_	TAQ3	TAK0	ı	_	_	_	_	TMA 6	TAM 6	XAM 6	XAMI 6	XAMD 6	LXY
0111	7	ı	TI1A	_	_	_	TAPU0	ı	_	SNZAD	_	_	TMA 7	TAM 7	XAM 7	XAMI 7	XAMD 7	LXY
1000	8	I	TI2A	TFR0A	TSIAB	_	I	I	TABSI	SNZSI	_	-	TMA 8	TAM 8	XAM 8	XAMI 8	XAMD 8	LXY
1001	9	I	I	-	TADAB	TALA	I	I	TABAD	_	_	-	TMA 9	TAM 9	XAM 9	XAMI 9	XAMD 9	LXY
1010	Α	ı	I	ı	ı	-	I	I	ı	_	_	-	TMA 10	TAM 10	XAM 10	XAMI 10	XAMD 10	LXY
1011	В	I	TK0A	-	TR3AB	TAW1	I	I	ı	-	_	-	TMA 11	TAM 11	XAM 11	XAMI 11	XAMD 11	LXY
1100	С	ı	_	_	_	TAW2	ı	_	_	_	_	-	TMA 12	TAM 12	XAM 12	XAMI 12	XAMD 12	LXY
1101	D	ı	ı	TPU0A	_	TAW3	ı	_	_	_	_	-	TMA 13	TAM 13	XAM 13	XAMI 13	XAMD 13	LXY
1110	E	TW1A	ı	_	_	TAW4	ı	ı	_	_	SST	_	TMA 14	TAM 14	XAM 14	XAMI 14	XAMD 14	LXY
1111	F	TW2A	_	_	TR1AB	_	_	_	_	_	ADST	_	TMA 15	TAM 15	XAM 15	XAMI 15	XAMD 15	LXY

The above table shows the relationship between machine language codes and machine language instructions. D3–D0 show the low-order 4 bits of the machine language code, and D9–D4 show the high-order 6 bits of the machine language code. The hexadecimal representation of the code is also provided. There are one-word instructions and two-word instructions, but only the first word of each instruction is shown. Do not use code marked "—."

The codes for the second word of a two-word instruction are described below.

	The second word										
BL	10	paaa	aaaa								
BML	10	paaa	aaaa								
BLA	10	pp00	pppp								
BMLA	10	pp00	pppp								
SEA	00	0111	nnnn								
SZD	00	0010	1011								



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

MACHINE INSTRUCTIONS

Parameter			Instruction code									er of Is	er of					
Type of instructions	Mnemonic	D9	D8	D7	D6	D5	D4	Dз	D2	D1	D ₀		ade otati	cimal on	Number of words	Number of cycles	Function	
	TAB	0	0	0	0	0	1	1	1	1	0	0	1	E	1	1	(A) ← (B)	
	ТВА	0	0	0	0	0	0	1	1	1	0	0	0	Е	1	1	$(B) \leftarrow (A)$	
	TAY	0	0	0	0	0	1	1	1	1	1	0	1	F	1	1	$(A) \leftarrow (Y)$	
	TYA	0	0	0	0	0	0	1	1	0	0	0	0	С	1	1	$(Y) \leftarrow (A)$	
Register to register transfer	TEAB	0	0	0	0	0	1	1	0	1	0	0	1	Α	1	1	$ \begin{array}{l} (E7\text{-}E4) \leftarrow (B) \\ (E3\text{-}E0) \leftarrow (A) \end{array} $	
egister	TABE	0	0	0	0	1	0	1	0	1	0	0	2	Α	1	1	$ \begin{array}{l} (B) \leftarrow (E7\text{-}E4) \\ (A) \leftarrow (E3\text{-}E0) \end{array} $	
er to r	TDA	0	0	0	0	1	0	1	0	0	1	0	2	9	1	1	$(DR2-DR0) \leftarrow (A2-A0)$	
Registe	TAD	0	0	0	1	0	1	0	0	0	1	0	5	1	1	1	$ \begin{array}{l} (A2\text{-}A0) \leftarrow (DR2\text{-}DR0) \\ (A3) \leftarrow 0 \end{array} $	
	TAZ	0	0	0	1	0	1	0	0	1	1	0	5	3	1	1	$(A_1, A_0) \leftarrow (Z_1, Z_0)$ $(A_3, A_2) \leftarrow 0$	
	TAX	0	0	0	1	0	1	0	0	1	0	0	5	2	1	1	$(A) \leftarrow (X)$	
	TASP	0	0	0	1	0	1	0	0	0	0	0	5	0	1	1	$ \begin{array}{l} (A2\text{-}A0) \leftarrow (SP2\text{-}SP0) \\ (A3) \leftarrow 0 \end{array} $	
	LXY x, y	1	1	х3	X2	X1	X 0	уз	y 2	y 1	у0	3	Х	у	1	1	$(X) \leftarrow x, x = 0 \text{ to } 15$ $(Y) \leftarrow y, y = 0 \text{ to } 15$	
resses	LZ z	0	0	0	1	0	0	1	0	Z1	Z0	0	4	8 +z	1	1	$(Z) \leftarrow z, z = 0 \text{ to } 3$	
RAM addresses	INY	0	0	0	0	0	1	0	0	1	1	0	1	3	1	1	(Y) ← (Y) + 1	
<u>~</u>	DEY	0	0	0	0	0	1	0	1	1	1	0	1	7	1	1	$(Y) \leftarrow (Y) - 1$	
	TAM j	1	0	1	1	0	0	j	j	j	j	2	С	j	1	1	$ \begin{array}{l} (A) \leftarrow (M(DP)) \\ (X) \leftarrow (X)EXOR(j) \\ j = 0 \text{ to } 15 \end{array} $	
ınsfer	XAM j	1	0	1	1	0	1	j	j	j	j	2	D	j	1	1	$ \begin{array}{l} (A) \leftarrow \rightarrow (M(DP)) \\ (X) \leftarrow (X)EXOR(j) \\ j = 0 \text{ to } 15 \end{array} $	
RAM to register transfer	XAMD j	1	0	1	1	1	1	j	j	j	j	2	F	j	1	1	$ \begin{array}{l} (A) \leftarrow \rightarrow (M(DP)) \\ (X) \leftarrow (X)EXOR(j) \\ j = 0 \text{ to } 15 \\ (Y) \leftarrow (Y) - 1 \end{array} $	
RAM to	XAMI j	1	0	1	1	1	0	j	j	j	j	2	Е	j	1	1	$ \begin{array}{l} (A) \leftarrow \rightarrow (M(DP)) \\ (X) \leftarrow (X)EXOR(j) \\ j = 0 \text{ to } 15 \\ (Y) \leftarrow (Y) + 1 \end{array} $	
	ТМА ј	1	0	1	0	1	1	j	j	j	j	2	В	j	1	1	$(M(DP)) \leftarrow (A)$ $(X) \leftarrow (X)EXOR(j)$ j = 0 to 15	



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

	<u> </u>	
Skip condition	Carry flag CY	Datailed description
_	-	Transfers the contents of register B to register A.
_	-	Transfers the contents of register A to register B.
_	-	Transfers the contents of register Y to register A.
_	_	Transfers the contents of register A to register Y.
-	-	Transfers the contents of registers A and B to register E.
-	_	Transfers the contents of register E to registers A and B.
-	_	Transfers the contents of register A to register D.
-	_	Transfers the contents of register D to register A.
-	-	Transfers the contents of register Z to register A.
_	_	Transfers the contents of register X to register A.
-	-	Transfers the contents of stack pointer (SP) to register A.
Continuous description	_	Loads the value x in the immediate field to register X, and the value y in the immediate field to register Y. When the LXY instructions are continuously coded and executed, only the first LXY instruction is executed and other LXY instructions coded continuously are skipped.
-	_	Loads the value z in the immediate field to register Z.
(Y) = 0	-	Adds 1 to the contents of register Y. As a result of addition, when the contents of register Y is 0, the next instruction is skipped.
(Y) = 15	-	Subtracts 1 from the contents of register Y. As a result of subtraction, when the contents of register Y is 15, the next instruction is skipped.
_	_	After transferring the contents of M(DP) to register A, an exclusive OR operation is performed between register X and the value j in the immediate field, and stores the result in register X.
-	-	After exchanging the contents of M(DP) with the contents of register A, an exclusive OR operation is performed between register X and the value j in the immediate field, and stores the result in register X.
(Y) = 15	_	After exchanging the contents of M(DP) with the contents of register A, an exclusive OR operation is performed between register X and the value j in the immediate field, and stores the result in register X. Subtracts 1 from the contents of register Y. As a result of subtraction, when the contents of register Y is 15, the next instruction is skipped.
(Y) = 0	_	After exchanging the contents of M(DP) with the contents of register A, an exclusive OR operation is performed between register X and the value j in the immediate field, and stores the result in register X. Adds 1 to the contents of register Y. As a result of addition, when the contents of register Y is 0, the next instruction is skipped.
_	_	After transferring the contents of register A to M(DP), an exclusive OR operation is performed between register X and the value j in the immediate field, and stores the result in register X.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

MACHINE INSTRUCTIONS (continued)

MIACIII	INE INS			110	143	, (C	UII		u c U	•/							
Parameter	r					In	stru	ction	cod	e					er of	er of	
Type of instructions	Mnemonic	D9	D8	D7	D6	D5	D4	Dз	D2	D1	D ₀		ade otat	cimal ion	Number of words	Number of cycles	Function
	LA n	0	0	0	1	1	1	n	n	n	n	0	7	n	1	1	(A) ← n n = 0 to 15
	TABP p	0	0	1	0	p 5	p4	рз	p2	p1	po	0	8 +p		1	3	$(SP) \leftarrow (SP) + 1$ $(SK(SP)) \leftarrow (PC)$ $(PCH) \leftarrow p$ $(PCL) \leftarrow (DR_2-DR_0, A_3-A_0)$ $(B) \leftarrow (ROM(PC))_{7-4}$ $(A) \leftarrow (ROM(PC))_{3-0}$ $(PC) \leftarrow (SK(SP))$ $(SP) \leftarrow (SP) - 1$ (Note)
	AM	0	0	0	0	0	0	1	0	1	0	0	0	Α	1	1	$(A) \leftarrow (A) + (M(DP))$
peration	AMC	0	0	0	0	0	0	1	0	1	1	0	0	В	1	1	$(A) \leftarrow (A) + (M(DP)) + (CY)$ $(CY) \leftarrow Carry$
Arithmetic operation	A n	0	0	0	1	1	0	n	n	n	n	0	6	n	1	1	(A) ← (A) + n n = 0 to 15
Arith	AND	0	0	0	0	0	1	1	0	0	0	0	1	8	1	1	$(A) \leftarrow (A) \text{ AND } (M(DP))$
	OR	0	0	0	0	0	1	1	0	0	1	0	1	9	1	1	$(A) \leftarrow (A) OR (M(DP))$
	sc	0	0	0	0	0	0	0	1	1	1	0	0	7	1	1	(CY) ← 1
	RC	0	0	0	0	0	0	0	1	1	0	0	0	6	1	1	(CY) ← 0
	szc	0	0	0	0	1	0	1	1	1	1	0	2	F	1	1	(CY) = 0 ?
	СМА	0	0	0	0	0	1	1	1	0	0	0	1	С	1	1	$(A) \leftarrow (\overline{A})$
	RAR	0	0	0	0	0	1	1	1	0	1	0	1	D	1	1	CY A3A2A1A0
uc	SB j	0	0	0	1	0	1	1	1	j	j	0	5	C +j	1	1	(Mj(DP)) ← 1 j = 0 to 3
Bit operation	RB j	0	0	0	1	0	0	1	1	j	j	0	4	C +j	1	1	$ \begin{aligned} & (Mj(DP)) \leftarrow 0 \\ & j = 0 \text{ to } 3 \end{aligned} $
Bit	SZB j	0	0	0	0	1	0	0	0	j	j	0	2	j	1	1	(Mj(DP)) = 0 ? j = 0 to 3
	SEAM	0	0	0	0	1	0	0	1	1	0	0	2	6	1	1	(A) = (M(DP))?
	SEA n	0	0	0	0	1	0	0	1	0	1	0	2	5	2	2	(A) = n ?
Comparison operation		0	0	0	1	1	1	n	n	n	n	0	7	n			n = 0 to 15

Note :p is 0 to 15 for M34513M2, p is 0 to 31 for M34513M4/E4, p is 0 to 47 for M34513M6 and M34514M6, and p is 0 to 63 for M34513M8/E8 and M34514M8/E8.



	T >-	Ţ
Skip condition	Carry flag CY	Datailed description
Continuous description	-	Loads the value n in the immediate field to register A. When the LA instructions are continuously coded and executed, only the first LA instruction is executed and other LA instructions coded continuously are skipped.
-	_	Transfers bits 7 to 4 to register B and bits 3 to 0 to register A. These bits 7 to 0 are the ROM pattern in address (DR2 DR1 DR0 A3 A2 A1 A0)2 specified by registers A and D in page p. When this instruction is executed, 1 stage of stack register is used.
_	_	Adds the contents of M(DP) to register A. Stores the result in register A. The contents of carry flag CY re-
		mains unchanged.
_	0/1	Adds the contents of M(DP) and carry flag CY to register A. Stores the result in register A and carry flag CY.
Overflow = 0	_	Adds the value n in the immediate field to register A. The contents of carry flag CY remains unchanged. Skips the next instruction when there is no overflow as the result of operation.
-	_	Takes the AND operation between the contents of register A and the contents of M(DP), and stores the result in register A.
_	_	Takes the OR operation between the contents of register A and the contents of M(DP), and stores the result in register A.
_	1	Sets (1) to carry flag CY.
_	0	Clears (0) to carry flag CY.
(CY) = 0	_	Skips the next instruction when the contents of carry flag CY is "0."
_	_	Stores the one's complement for register A's contents in register A.
-	0/1	Rotates 1 bit of the contents of register A including the contents of carry flag CY to the right.
_	_	Sets (1) the contents of bit j (bit specified by the value j in the immediate field) of M(DP).
-	_	Clears (0) the contents of bit j (bit specified by the value j in the immediate field) of M(DP).
(Mj(DP)) = 0 j = 0 to 3	_	Skips the next instruction when the contents of bit j (bit specified by the value j in the immediate field) of M(DP) is "0."
(A) = (M(DP))	_	Skips the next instruction when the contents of register A is equal to the contents of M(DP).
(A) = n	_	Skips the next instruction when the contents of register A is equal to the value n in the immediate field.
		ı



MACHINE INSTRUCTIONS (continued)

Parameter						In	stru	ction	cod	e					er of ds	er of	
Type of instructions	Mnemonic	D9	D8	D7	D6	D5	D4	Dз	D2	D1	D ₀			lecimal ation	Number of words	Number cycles	Function
	Ва	0	1	1	a 6	a5	a4	аз	a2	a1	ao	1		a a	1	1	(PCL) ← a6–a0
ration	BL p, a	0	0	1	1	1	p4	рз	p2	p 1	p 0	0		p p	2	2	(PCH) ← p (PCL) ← a6-a0
Branch operation		1	0	p 5	a 6	a 5	a4	аз	a2	a1	a 0	2		a ·a			(Note)
Brar	BLA p	0	0	0	0	0	1	0	0	0	0	0	1	0	2	2	(PCH) ← p (PCL) ← (DR2–DR0, A3–A0)
		1	0	p5	p4	0	0	рз	p2	p1	po	2	p	р			(Note)
	ВМ а	0	1	0	a 6	a 5	a4	a 3	a 2	a1	a 0	1	а	а	1	1	(SP) ← (SP) + 1 (SK(SP)) ← (PC) (PCH) ← 2 (PCL) ← a6-a0
Subroutine operation	BML p, a	0	0	1	1	0	p4	рз	p2	p 1	po	0		; р	2	2	$(SP) \leftarrow (SP) + 1$ $(SK(SP)) \leftarrow (PC)$ $(PCH) \leftarrow p$
outine		1	0	p5	a 6	a 5	a 4	a 3	a2	a1	a 0	2		a ·a			(PCL) ← a6–a0 (Note)
Subi	BMLA p	0	0	0	0	1	1	0	0	0	0	0	3	0	2	2	(SP) ← (SP) + 1 (SK(SP)) ← (PC)
		1	0	p5	p4	0	0	рз	p2	p1	p0	2	р	р			$(PCH) \leftarrow p$ $(PCL) \leftarrow (DR2-DR0,A3-A0)$ (Note)
ıtion	RTI	0	0	0	1	0	0	0	1	1	0	0	4	6	1	1	$(PC) \leftarrow (SK(SP))$ $(SP) \leftarrow (SP) - 1$
Return operation	RT	0	0	0	1	0	0	0	1	0	0	0	4	4	1	2	(PC) ← (SK(SP)) (SP) ← (SP) − 1
Retu	RTS	0	0	0	1	0	0	0	1	0	1	0	4	5	1	2	(PC) ← (SK(SP)) (SP) ← (SP) – 1
	DI	0	0	0	0	0	0	0	1	0	0	0	0	4	1	1	(INTE) ← 0
ıtion	EI	0	0	0	0	0	0	0	1	0	1	0	0	5	1	1	(INTE) ← 1
Interrupt operation	SNZ0	0	0	0	0	1	1	1	0	0	0	0	3	8	1	1	(EXF0) = 1 ? After skipping (EXF0) ← 0
Interr	SNZ1	0	0	0	0	1	1	1	0	0	1	0	3	9	1	1	(EXF1) = 1 ? After skipping (EXF1) ← 0

Note : p is 0 to 15 for M34513M2, p is 0 to 31 for M34513M4/E4, p is 0 to 47 for M34513M6 and M34514M6, and p is 0 to 63 for M34513M8/E8 and M34514M8/E8.

Skip condition	Carry flag CY	Datailed description
-	-	Branch within a page : Branches to address a in the identical page.
-	_	Branch out of a page : Branches to address a in page p.
_	_	Branch out of a page: Branches to address (DR2 DR1 DR0 A3 A2 A1 A0)2 specified by registers D and A in page p.
-	-	Call the subroutine in page 2 : Calls the subroutine at address a in page 2.
-		Call the subroutine: Calls the subroutine at address a in page p. Call the subroutine: Calls the subroutine at address (DR2 DR1 DR0 A3 A2 A1 A0)2 specified by registers D and A in page p.
-	_	Returns from interrupt service routine to main routine. Returns each value of data pointer (X, Y, Z), carry flag, skip status, NOP mode status by the continuous description of the LA/LXY instruction, register A and register B to the states just before interrupt.
_	_	Returns from subroutine to the routine called the subroutine.
Skip at uncondition	_	Returns from subroutine to the routine called the subroutine, and skips the next instruction at uncondition.
-	_	Clears (0) to the interrupt enable flag INTE, and disables the interrupt.
_	-	Sets (1) to the interrupt enable flag INTE, and enables the interrupt.
(EXF0) = 1		Skips the next instruction when the contents of EXF0 flag is "1." After skipping, clears (0) to the EXF0 flag.
(EXF1) = 1	_	Skips the next instruction when the contents of EXF1 flag is "1." After skipping, clears (0) to the EXF1 flag.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

MACHINE INSTRUCTIONS (continued)

Parameter						lr	nstru	ctior	cod	le					ir of s	ir of	
Type of instructions	Mnemonic	D9	D8	D7	D6	D5	D4	Dз	D2	D1	D ₀		ade otati	cimal on	Number of words	Number of cycles	Function
	SNZI0	0	0	0	0	1	1	1	0	1	0	0	3	Α	1	1	l12 = 1 : (INT0) = "H" ?
																	l12 = 0 : (INT0) = "L" ?
	SNZI1	0	0	0	0	1	1	1	0	1	1	0	3	В	1	1	I22 = 1 : (INT1) = "H" ?
ıtion																	I22 = 0 : (INT1) = "L" ?
Interrupt operation	TAV1	0	0	0	1	0	1	0	1	0	0	0	5	4	1	1	(A) ← (V1)
rupt	TV1A	0	0	0	0	1	1	1	1	1	1	0	3	F	1	1	(V1) ← (A)
Inter	TAV2	0	0	0	1	0	1	0	1	0	1	0	5	5	1	1	(A) ← (V2)
	TV2A	0	0	0	0	1	1	1	1	1	0	0	3	Ε	1	1	(V2) ← (A)
	TAI1	1	0	0	1	0	1	0	0	1	1	2	5	3	1	1	$(A) \leftarrow (I1)$
	TI1A	1	0	0	0	0	1	0	1	1	1	2	1	7	1	1	(I1) ← (A)
	TAI2	1	0	0	1	0	1	0	1	0	0	2	5	4	1	1	(A) ← (I2)
	TI2A	1	0	0	0	0	1	1	0	0	0	2	1	8	1	1	(I2) ← (A)
	TAW1	1	0	0	1	0	0	1	0	1	1	2	4	В	1	1	(A) ← (W1)
	TW1A	1	0	0	0	0	0	1	1	1	0	2	0	Ε	1	1	(W1) ← (A)
	TAW2	1	0	0	1	0	0	1	1	0	0	2	4	С	1	1	(A) ← (W2)
L C	TW2A	1	0	0	0	0	0	1	1	1	1	2	0	F	1	1	(W2) ← (A)
erati	TAW3	1	0	0	1	0	0	1	1	0	1	2	4	D	1	1	(A) ← (W3)
Timer operation	TW3A	1	0	0	0	0	1	0	0	0	0	2	1	0	1	1	(W3) ← (A)
ļ Ē	TAW4	1	0	0	1	0	0	1	1	1	0	2	4	Ε	1	1	(A) ← (W4)
	TW4A	1	0	0	0	0	1	0	0	0	1	2	1	1	1	1	(W4) ← (A)
	TAW6	1	0	0	1	0	1	0	0	0	0	2	5	0	1	1	(A) ← (W6)
	TW6A	1	0	0	0	0	1	0	0	1	1	2	1	3	1	1	(W6) ← (A)

	_	
Skip condition	Carry flag CY	Datailed description
(INT0) = "H" However, I12 = 1	_	When bit 2 (I12) of register I1 is "1": Skips the next instruction when the level of INT0 pin is "H."
(INT0) = "L" However, I12 = 0	_	When bit 2 (I12) of register I1 is "0": Skips the next instruction when the level of INT0 pin is "L."
(INT1) = "H" However, I22 = 1	_	When bit 2 (I22) of register I2 is "1": Skips the next instruction when the level of INT1 pin is "H."
(INT1) = "L" However, I22 = 0	_	When bit 2 (I22) of register I2 is "0": Skips the next instruction when the level of INT1 pin is "L."
-	_	Transfers the contents of interrupt control register V1 to register A.
_	-	Transfers the contents of register A to interrupt control register V1.
_	-	Transfers the contents of interrupt control register V2 to register A.
_	-	Transfers the contents of register A to interrupt control register V2.
_	_	Transfers the contents of interrupt control register I1 to register A.
_	_	Transfers the contents of register A to interrupt control register I1.
_	_	Transfers the contents of interrupt control register I2 to register A.
-	_	Transfers the contents of register A to interrupt control register I2.
_	-	Transfers the contents of timer control register W1 to register A.
_	-	Transfers the contents of register A to timer control register W1.
_	-	Transfers the contents of timer control register W2 to register A.
_	_	Transfers the contents of register A to timer control register W2.
_	_	Transfers the contents of timer control register W3 to register A.
_	_	Transfers the contents of register A to timer control register W3.
_	_	Transfers the contents of timer control register W4 to register A.
_	_	Transfers the contents of register A to timer control register W4.
_	_	Transfers the contents of timer control register W6 to register A.
-	_	Transfers the contents of register A to timer control register W6.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

MACHINE INSTRUCTIONS (continued)

Parameter						In	stru	ction	cod	e					er of	er of		
Type of instructions	Mnemonic	D9	D8	D7	D6	D5	D4	Dз	D2	D1	D ₀		ade otat	cimal ion	Number of words	Number of cycles	Function	
	TAB1	1	0	0	1	1	1	0	0	0	0	2	7	0	1	1	(B) ← (T17–T14) (A) ← (T13–T10)	
	T1AB	1	0	0	0	1	1	0	0	0	0	2	3	0	1	1	$(R17-R14) \leftarrow (B)$ $(T17-T14) \leftarrow (B)$ $(R13-R10) \leftarrow (A)$ $(T13-T10) \leftarrow (A)$	
	TAB2	1	0	0	1	1	1	0	0	0	1	2	7	1	1	1	(B) ← (T27–T24) (A) ← (T23–T20)	
	T2AB	1	0	0	0	1	1	0	0	0	1	2	3	1	1	1	$(R27-R24) \leftarrow (B)$ $(T27-T24) \leftarrow (B)$ $(R23-R20) \leftarrow (A)$ $(T23-T20) \leftarrow (A)$	
	TAB3	1	0	0	1	1	1	0	0	1	0	2	7	2	1	1	(B) ← (T37–T34) (A) ← (T33–T30)	
	ТЗАВ	1	0	0	0	1	1	0	0	1	0	2	3	2	1	1	$(R37-R34) \leftarrow (B)$ $(T37-T34) \leftarrow (B)$ $(R33-R30) \leftarrow (A)$ $(T33-T30) \leftarrow (A)$	
eration	TAB4	1	0	0	1	1	1	0	0	1	1	2	7	3	1	1	(B) ← (T47–T44) (A) ← (T43–T40)	
Timer operation	T4AB	1	0	0	0	1	1	0	0	1	1	2	3	3	1	1	$(R47-R44) \leftarrow (B)$ $(T47-T44) \leftarrow (B)$ $(R43-R40) \leftarrow (A)$ $(T43-T40) \leftarrow (A)$	
	TR1AB	1	0	0	0	1	1	1	1	1	1	2	3	F	1	1	(R17-R14) ← (B) (R13-R10) ← (A)	
	TR3AB	1	0	0	0	1	1	1	0	1	1	2	3	В	1	1	(R37–R34) ← (B) (R33–R30) ← (A)	
	SNZT1	1	0	1	0	0	0	0	0	0	0	2	8	0	1	1	(T1F) = 1? After skipping $(T1F) \leftarrow 0$	
	SNZT2	1	0	1	0	0	0	0	0	0	1	2	8	1	1	1	(T2F) = 1? After skipping $(T2F) \leftarrow 0$	
	SNZT3	1	0	1	0	0	0	0	0	1	0	2	8	2	1	1	(T3F) = 1? After skipping $(T3F) \leftarrow 0$	
	SNZT4	1	0	1	0	0	0	0	0	1	1	2	8	3	1	1	$ (T4F) = 1? $ After skipping $ (T4F) \leftarrow 0 $	



Skip condition	Carry flag CY	Datailed description
_	_	Transfers the contents of timer 1 to registers A and B.
-	_	Transfers the contents of registers A and B to timer 1 and timer 1 reload register.
-	_	Transfers the contents of timer 2 to registers A and B.
-	-	Transfers the contents of registers A and B to timer 2 and timer 2 reload register.
-	_	Transfers the contents of timer 3 to registers A and B.
-	_	Transfers the contents of registers A and B to timer 3 and timer 3 reload register.
-	-	Transfers the contents of timer 4 to registers A and B. Transfers the contents of registers A and B to timer 4 and timer 4 reload register.
-	_	Transfers the contents of registers A and B to timer 1 reload register.
-	_	Transfers the contents of registers A and B to timer 3 reload register.
(T1F) = 1	-	Skips the next instruction when the contents of T1F flag is "1." After skipping, clears (0) to T1F flag.
(T2F) =1	-	Skips the next instruction when the contents of T2F flag is "1." After skipping, clears (0) to T2F flag.
(T3F) = 1	_	Skips the next instruction when the contents of T3F flag is "1." After skipping, clears (0) to T3F flag.
(T4F) = 1	_	Skips the next instruction when the contents of T4F flag is "1." After skipping, clears (0) to T4F flag.



MACHINE INSTRUCTIONS (continued)

Parameter			Instruction code												er of Is	er of	
Type of instructions	Mnemonic	D9	D8	D7	D6	D5	D4	Dз	D2	D1	D ₀		ade otati	cimal on	Number of words	Number of cycles	Function
	IAP0	1	0	0	1	1	0	0	0	0	0	2	6	0	1	1	(A) ← (P0)
	OP0A	1	0	0	0	1	0	0	0	0	0	2	2	0	1	1	(P0) ← (A)
	IAP1	1	0	0	1	1	0	0	0	0	1	2	6	1	1	1	(A) ← (P1)
	OP1A	1	0	0	0	1	0	0	0	0	1	2	2	1	1	1	(P1) ← (A)
	IAP2	1	0	0	1	1	0	0	0	1	0	2	6	2	1	1	$(A_2-A_0) \leftarrow (P_{22}-P_{20})$ $(A_3) \leftarrow 0$
	IAP3	1	0	0	1	1	0	0	0	1	1	2	6	3	1	1	(A) ← (P3)
	ОРЗА	1	0	0	0	1	0	0	0	1	1	2	2	3	1	1	(P3) ← (A)
	IAP4*	1	0	0	1	1	0	0	1	0	0	2	6	4	1	1	(A) ← (P4)
	OP4A*	1	0	0	0	1	0	0	1	0	0	2	2	4	1	1	(P4) ← (A)
	IAP5*	1	0	0	1	1	0	0	1	0	1	2	6	5	1	1	(A) ← (P5)
eratic	OP5A*	1	0	0	0	1	0	0	1	0	1	2	2	5	1	1	(P5) ← (A)
ut op	CLD	0	0	0	0	0	1	0	0	0	1	0	1	1	1	1	(D) ← 1
Input/Output operation	RD	0	0	0	0	0	1	0	1	0	0	0	1	4	1	1	$ (D(Y)) \leftarrow 0 $ $ (Y) = 0 \text{ to } 7 $
dul	SD	0	0	0	0	0	1	0	1	0	1	0	1	5	1	1	$ (D(Y)) \leftarrow 1 $ $ (Y) = 0 \text{ to } 7 $
	SZD	0	0	0	0	1	0	0	1	0	0	0	2	4	2	2	(D(Y)) = 0 ? (Y) = 0 to 7
		0	0	0	0	1	0	1	0	1	1	0	2	В			(1) = 0 to 7
	TK0A	1	0	0	0	0	1	1	0	1	1	2	1	В	1	1	(K0) ← (A)
	TAK0	1	0	0	1	0	1	0	1	1	0	2	5	6	1	1	$(A) \leftarrow (K0)$
	TPU0A	1	0	0	0	1	0	1	1	0	1	2	2	D	1	1	(PU0) ← (A)
	TAPU0	1	0	0	1	0	1	0	1	1	1	2	5	7	1	1	(A) ← (PU0)
	TFR0A*	1	0	0	0	1	0	1	0	0	0	2	2	8	1	1	(FR0) ← (A)

^{*:} The 4513 Group does not have these instructions.

Skip condition	Carry flag CY	Datailed description
_	_	Transfers the input of port P0 to register A.
_	_	Outputs the contents of register A to port P0.
_	_	Transfers the input of port P1 to register A.
_	_	Outputs the contents of register A to port P1.
_	_	Transfers the input of port P2 to register A.
-	_	Transfers the input of port P3 to register A.
-	_	Outputs the contents of register A to port P3.
-	_	Transfers the input of port P4 to register A.
-	_	Outputs the contents of register A to port P4.
-	_	Transfers the input of port P5 to register A.
-	_	Outputs the contents of register A to port P5.
-	_	Sets (1) to port D.
_	-	Clears (0) to a bit of port D specified by register Y.
_	_	Sets (1) to a bit of port D specified by register Y.
(D(Y)) = 0 (Y) = 0 to 7	-	Skips the next instruction when a bit of port D specified by register Y is "0."
_	_	Transfers the contents of register A to key-on wakeup control register K0.
_	_	Transfers the contents of key-on wakeup control register K0 to register A.
_	_	Transfers the contents of register A to pull-up control register PU0.
_	_	Transfers the contents of pull-up control register PU0 to register A.
_	_	Transfers the contents of register A to direction register FR0.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

MACHINE INSTRUCTIONS (continued)

Parameter	INE INS	•						ction							of	Jo	
<u> </u>	Mnemonic		D9 D8 D7 D6 D5 D4 D3 D2 D1 D0		Number of words Number of cycles	Number of cycles	Function										
Type of \instructions		D9	D8	D7	D6	D5	D4	Dз	D2	D1	D ₀		otat		n >	ž	
	TABSI	1	0	0	1	1	1	1	0	0	0	2	7	8	1	1	$ \begin{array}{l} (A) \leftarrow (SI3\text{-}SI0) \\ (B) \leftarrow (SI7\text{-}SI4) \end{array} $
Serial I/O control operation	TSIAB	1	0	0	0	1	1	1	0	0	0	2	3	8	1	1	(SI3–SI0) ← (A) (SI7–SI4) ← (B)
do lo	TAJ1	1	0	0	1	0	0	0	0	1	0	2	4	2	1	1	(A) ← (J1)
contr	TJ1A	1	0	0	0	0	0	0	0	1	0	2	0	2	1	1	(J1) ← (A)
rial I/O	SST	1	0	1	0	0	1	1	1	1	0	2	9	Ε	1	1	(SIOF) ← 0 Serial I/O starting
S	SNZSI	1	0	1	0	0	0	1	0	0	0	2	8	8	1	1	(SIOF) = 1 ? After skipping (SIOF) ← 0
	TABAD	1	0	0	1	1	1	1	0	0	1	2	7	9	1	1	$ \begin{array}{l} (A) \leftarrow (AD5\text{-}AD2) \\ (B) \leftarrow (AD9\text{-}AD6) \\ However, in the comparator mode, \\ (A) \leftarrow (AD3\text{-}AD0) \\ (B) \leftarrow (AD7\text{-}AD4) \\ \end{array} $
_	TALA	1	0	0	1	0	0	1	0	0	1	2	4	9	1	1	$(A) \leftarrow (AD1, AD0, 0, 0)$
A-D conversion operation	TADAB	1	0	0	0	1	1	1	0	0	1	2	3	9	1	1	
ion	TAQ1	1	0	0	1	0	0	0	1	0	0	2	4	4	1	1	(A) ← (Q1)
Tvers	TQ1A	1	0	0	0	0	0	0	1	0	0	2	0	4	1	1	(Q1) ← (A)
A-D col	ADST	1	0	1	0	0	1	1	1	1	1	2	9	F	1	1	(ADF) ← 0 A-D conversion starting
	SNZAD	1	0	1	0	0	0	0	1	1	1	2	8	7	1	1	(ADF) = 1 ? After skipping (ADF) ← 0
	TAQ2	1	0	0	1	0	0	0	1	0	1	2	4	5	1	1	(A) ← (Q2)
	TQ2A	1	0	0	0	0	0	0	1	0	1	2	0	5	1	1	(Q2) ← (A)
	NOP	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	(PC) ← (PC) + 1
	POF	0	0	0	0	0	0	0	0	1	0	0	0	2	1	1	RAM back-up
	EPOF	0	0	0	1	0	1	1	0	1	1	0	5	В	1	1	POF instruction valid
ion	SNZP	0	0	0	0	0	0	0	0	1	1	0	0	3	1	1	(P) = 1 ?
Other operation	WRST	1	0	1	0	1	0	0	0	0	0	2	Α	0	1	1	(WDF1) ← 0 (WEF) ← 1
Other	TAMR	1	0	0	1	0	1	0	0	1	0	2	5	2	1	1	$(A) \leftarrow (MR)$
	TMRA	1	0	0	0	0	1	0	1	1	0	2	1	6	1	1	$(MR) \leftarrow (A)$
	TAQ3	1	0	0	1	0	0	0	1	1	0	2	4	6	1	1	(A) ← (Q3)
	TQ3A	1	0	0	0	0	0	0	1	1	0	2	0	6	1	1	(Q33, Q32) ← (A3, A2) (Q31) ← (CMP1 comparison result) (Q30) ← (CMP0 comparison result)



	_	
Skip condition	Carry flag CY	Datailed description
-	-	Transfers the contents of serial I/O register SI to registers A and B.
-	_	Transfers the contents of registers A and B to serial I/O register SI.
-	_	Transfers the contents of serial I/O mode register J1 to register A.
_	-	Transfers the contents of register A to serial I/O mode register J1.
_	-	Clears (0) to SIOF flag and starts serial I/O.
(SIOF) = 1	_	Skips the next instruction when the contents of SIOF flag is "1." After skipping, clears (0) to SIOF flag.
_	-	Transfers the high-order 8 bits of the contents of register AD to registers A and B.
-	_	Transfers the low-order 2 bits of the contents of register AD to the high-order 2 bits of the contents of register A. Simultaneously, the low-order 2 bits of the contents of the register A is "0."
-	-	Transfers the contents of registers A and B to the comparator register at the comparator mode.
-	_	Transfers the contents of the A-D control register Q1 to register A.
-	-	Transfers the contents of register A to the A-D control register Q1.
-	-	Clears the ADF flag, and the A-D conversion at the A-D conversion mode or the comparator operation at the comparator mode is started.
(ADF) = 1	_	Skips the next instruction when the contents of ADF flag is "1". After skipping, clears (0) the contents of ADF flag.
-	_	Transfers the contents of the A-D control register Q2 to register A.
-	-	Transfers the contents of register A to the A-D control register Q2.
	-	No operation
_	-	Puts the system in RAM back-up state by executing the POF instruction after executing the EPOF instruction.
_	_	Makes the immediate POF instruction valid by executing the EPOF instruction.
(P) = 1	-	Skips the next instruction when P flag is "1". After skipping, P flag remains unchanged.
_	-	Operates the watchdog timer and initializes the watchdog timer flag WDF1.
-	_	Transfers the contents of the clock control register MR to register A.
_	-	Transfers the contents of register A to the clock control register MR.
_	_	Transfers the contents of the voltage comparator control register Q3 to register A.
_	_	Transfers the contents of the high-order 2 bits of register A to the high-order 2 bits of voltage comparator control register Q3, and the comparison result of the voltage comparator is transferred to the low-order 2 bits of the register Q3.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

CONTROL REGISTERS

	Interrupt control register V1	at	reset : 00002	at RAM back-up : 00002	R/W	
V13	Timer 2 interrupt enable bit	0	Interrupt disabled	(SNZT2 instruction is valid)		
V 13	Timer 2 interrupt enable bit	1	Interrupt enabled ((SNZT2 instruction is invalid)		
V12	Timer 1 interrupt enable bit	0	Interrupt disabled	(SNZT1 instruction is valid)		
VIZ	Timer i interrupt enable bit	1	Interrupt enabled (SNZT1 instruction is invalid)			
V11	External 1 interrupt anable bit	0	Interrupt disabled	(SNZ1 instruction is valid)		
VII	External 1 interrupt enable bit	1	Interrupt enabled ((SNZ1 instruction is invalid)		
V10	External 0 interrupt enable bit	0	Interrupt disabled	(SNZ0 instruction is valid)		
V 10	External o interrupt enable bit	1	Interrupt enabled ((SNZ0 instruction is invalid)		
	Interrupt control register V2	at	reset : 00002	at RAM back-up : 00002	R/W	
V23	Social I/O interrupt anable bit	0	Interrupt disabled	(SNZSI instruction is valid)		
V Z 3	Serial I/O interrupt enable bit	1	Interrupt enabled ((SNZSI instruction is invalid)		
V22	A D interrupt anable bit	0	Interrupt disabled	(SNZAD instruction is valid)		
V Z 2	A-D interrupt enable bit	1	Interrupt enabled ((SNZAD instruction is invalid)		
V21	Timer 4 interrupt enable hit	0	Interrupt disabled	(SNZT4 instruction is valid)		
VZ1	Timer 4 interrupt enable bit	1	Interrupt enabled ((SNZT4 instruction is invalid)		
V20	Timer 2 interment enable hit	0	Interrupt disabled (SNZT3 instruction is valid)			
V20	Timer 3 interrupt enable bit	1	Interrupt enabled (SNZT3 instruction is invalid)			
	Interrupt control register I1	at	reset : 00002	at RAM back-up : state retained	R/W	
I 13	Not used	0	This bit has no fun	nction, but read/write is enabled.		
14.0	Interrupt valid waveform for INT0 pin/	0	Falling waveform ("L" level of INT0 pin is recognized with the SNZIC instruction)/"L" level			
l12	return level selection bit (Note 2)	1	Rising waveform ("H" level of INT0 pin is recognized with the SNZIC instruction)/"H" level			
14.	INITO min adapt detection singuit control bit	0	One-sided edge de	etected		
I1 1	INT0 pin edge detection circuit control bit	1	Both edges detect	ed		
14 -	INT0 pin	0	Disabled			
I1 0	timer 1 control enable bit	1	Enabled			
	Interrupt control register I2	at	reset : 00002	at RAM back-up : state retained	R/W	
I2 3	Not used	0	This bit has no fun	nction, but read/write is enabled.		
10-	Interrupt valid waveform for INT1 pin/	0	Falling waveform (instruction)/"L" leve	("L" level of INT1 pin is recognized well	ith the SNZI1	
l2 2	return level selection bit (Note 3)	1	Rising waveform (instruction)/"H" lev	"H" level of INT1 pin is recognized w	ith the SNZI1	
			One-sided edge detected			
	NIT	0	-			
l21	INT1 pin edge detection circuit control bit	1	Both edges detect			
I21 I20	INT1 pin edge detection circuit control bit INT1 pin					

Notes 1: "R" represents read enabled, and "W" represents write enabled.



^{2:} When the contents of I12 is changed, the external interrupt request flag EXF0 may be set. Accordingly, clear EXF0 flag with the SNZ0 instruction.

^{3:} When the contents of 122 is changed, the external interrupt request flag EXF1 may be set. Accordingly, clear EXF1 flag with the SNZ1 instruction.

SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

	Timer control register W1		at	reset : 00002	at RAM back-up : 00002	R/W
1874	Draggalar control bit)	Stop (state initialize	ed)	
W13	Prescaler control bit	1	1	Operating	•	
14/4	December dividies and a selection bit)	Instruction clock di	vided by 4	
W12	Prescaler dividing ratio selection bit	1	1	Instruction clock di	vided by 16	
10/4 .	Times description	()	Stop (state retained)		
W11	Timer 1 control bit	1	1	Operating		
10/4 -	Timer 1 count start synchronous circuit)	Count start synchro	onous circuit not selected	
W10	control bit	Count start synchronous circuit selected				
	Timer control register W2		at	reset : 00002	at RAM back-up : state retained	R/W
W23	Timer 2 control bit	(0	Stop (state retaine	d)	
VVZ3	Timer 2 control bit		1	Operating		
W22	Not used		0 1	This bit has no fun	ction, but read/write is enabled.	
		W21	W20		Count source	
W21		0	0	Timer 1 underflow	signal	
	Timer 2 count source selection bits W20		1	Prescaler output		<u> </u>
W20			0	CNTR0 input		
		1	1	16 bit timer (WDT)	underflow signal	
	Timer control register W3		at	reset : 00002	at RAM back-up : state retained	R/W
W33	Timer 3 control bit		0	Stop (state retaine	d)	
VV 33	Timer 3 control bit		1	Operating		
W32	Timer 3 count start synchronous circuit	(0	Count start synchr	onous circuit not selected	
VV32	control bit		1	Count start synchr	onous circuit selected	
		W31	W30	Count source		
W31		0	0 0 Timer 2 underflow signal		signal	
	Timer 3 count source selection bits	0	1	Prescaler output		
W30		1	0	Not available		
		1	1	Not available		
	Timer control register W4		at	reset : 00002	at RAM back-up : state retained	R/W
W43	Timer 4 control bit		0	Stop (state retaine	d)	
V V 43	Timor 4 control bit		1	Operating		
W42	Not used		0 1	This bit has no fun	ction, but read/write is enabled.	
		W41	W40		Count source	
W41		0	0	Timer 3 underflow	signal	
	Timer 4 count source selection bits	0	1	Prescaler output		
W40		1	0	CNTR1 input		
		1	1	Not available		
	Timer control register W6		at	reset : 00002	at RAM back-up : state retained	R/W
W63	CNTR1 output control bit		0		signal output divided by 2 htrol by timer 4 underflow signal divide	ad by 2
			0	D7(I/O)/CNTR1 inp		Ju Dy Z
W62	D7/CNTR1 function selection bit		1	CNTR1 (I/O)/D7(in		
		_	0		signal output divided by 2	
W61	CNTR0 output control bit	-	1			ad by 2
			0	·	ntrol by timer 2 underflow signal divide	ou by Z
W60	D6/CNTR0 output control bit		-	D6(I/O)/CNTR0 inp		
,			1	CNTR0 (I/O)/D6(input)		

Note: "R" represents read enabled, and "W" represents write enabled.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

	Serial I/O mode register J1			а	nt reset : 00002	at RAM back-up : state retained	R/W		
J13	Not used		0		This bit has no func	tion, but read/write is enabled.			
	Serial I/O internal clock dividing ratio		0		Instruction clock signal divided by 8				
J12	selection bit		1		Instruction clock sig	· · · · · · · · · · · · · · · · · · ·			
.,					Input ports P20, P2	-			
J11	Serial I/O port selection bit		1			, Sout, Sin/input ports P20, P21, P22 se	lected		
14			0		External clock				
J 10	Serial I/O synchronous clock selection bit		1		Internal clock (instru	uction clock divided by 4 or 8)			
A-D control register Q1				at	reset: 00002	at RAM back-up : state retained	R/W		
Q13	Note used		0		This bit has no func	tion, but read/write is enabled.			
		Q12	Q11	Q1 0		Selected pins			
Q12		0	0	0	AIN0				
		0	0	1	AIN1				
		0	1	0	AIN2				
Q11	Analog input pin selection bits (Note 2)	0	1	1	AIN3				
	Q10		0	0	AIN4 (Not available	for the 4513 Group)			
			0	1	AIN5 (Not available	for the 4513 Group)			
Q10			1	0	AIN6 (Not available	for the 4513 Group)			
				1	AIN7 (Not available	for the 4513 Group)			
A-D control register Q2				at	at reset : 00002 at RAM back-up : state retained				
022	A D appration mode selection bit		0		A-D conversion mod	de			
Q23	A-D operation mode selection bit		1		Comparator mode				
020	P43/AIN7 and P42/AIN6 pin function selec-	. 0			P43, P42	(read/write enabled for the 4513 Group))		
Q22	tion bit (Not used for the 4513 Group)		1		AIN7, AIN6/P43, P42	(read/write enabled for the 4513 Group))		
00.	P41/AIN5 pin function selection bit		0		P41	(read/write enabled for the 4513 Group)		
Q21	(Not used for the 4513 Group)		1		AIN5/P41	(read/write enabled for the 4513 Group))		
	P40/AIN4 pin function selection bit		0		P40	(read/write enabled for the 4513 Group))		
Q20	(Not used for the 4513 Group)		1			(read/write enabled for the 4513 Group)			
Co	mparator control register Q3 (Note 3)			at	reset: 00002	at RAM back-up : state retained	R/W		
			0		Voltage comparator (CMP1) invalid				
Q33	Voltage comparator (CMP1) control bit		1		Voltage comparator				
0	V II.		0		Voltage comparator				
Q32	Voltage comparator (CMP0) control bit		1		Voltage comparator	• •			
0	0454		0		CMP1- > CMP1+	. ,			
Q31	CMP1 comparison result store bit		1		CMP1- < CMP1+				
-			0		CMP0- > CMP0+				
Q30	CMP0 comparison reslut store bit		1		CMP0- < CMP0+				
	Clock control register MR			at	reset : 10002	at RAM back-up : 10002	R/W		
	Out the state of t		0		f(XIN) (high-speed n	node)			
MR3	System clock selection bit		1		f(XIN)/2 (middle-spe	-			
			0			•			
MR2	Not used		1		i his bit has no func	tion, but read/write is enabled.			
MR1	Not used		0		This bit has no func	tion, but read/write is enabled.			
MR0	Not used		0		This bit has no func	tion, but read/write is enabled.			
	represents read enabled "\N/" represents write enabled	1							

Notes 1: "R" represents read enabled, "W" represents write enabled.
2: Select AIN4—AIN7 with register Q1 after setting register Q2.

^{3:} Bits 0 and 1 of register Q3 can be only read.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

	Key-on wakeup control register K0	at	reset: 00002	at RAM back-up : state retained	R/W		
I/Os	Pins P12 and P13 key-on wakeup	0	Key-on wakeup not	tused			
K03	control bit	1	Key-on wakeup use	ed			
K02	Pins P10 and P11 key-on wakeup	0	Key-on wakeup not	used			
KU2	control bit	1	Key-on wakeup use	ed			
K01	Pins P02 and P03 key-on wakeup	0	Key-on wakeup not	used			
KU1	control bit	1	Key-on wakeup use	ed			
K0 0	Pins P00 and P01 key-on wakeup	0	Key-on wakeup not	used			
KU0	control bit	1	Key-on wakeup use	ed			
	Pull-up control register PU0	at	reset : 00002	at RAM back-up : state retained	R/W		
DLIOs	Pins P12 and P13 pull-up transistor	0	Pull-up transistor O)FF	•		
PU03	control bit	1	Pull-up transistor ON				
DI IO-	Pins P10 and P11 pull-up transistor		Pull-up transistor O	FF			
PU02	control bit	1	Pull-up transistor ON				
PU01	Pins P02 and P03 pull-up transistor	0	Pull-up transistor O	FF			
P001	control bit	1	Pull-up transistor O	N			
PU00	Pins P00 and P01 pull-up transistor	0	Pull-up transistor O	FF			
P000	control bit	1	Pull-up transistor O	N			
	Direction register FR0 (Note 2)	at	reset : 00002	at RAM back-up : state retained	W		
EDO-	Dest DEstination to a stable it	0	Port P53 input		•		
FR03	Port P53 input/output control bit	1	Port P53 output				
ED0s	Port DEs input/output control hit	0	Port P52 input				
FR02	Port P52 input/output control bit	1	Port P52 output				
FR01	Port DE4 input/output control hit	0	Port P51 input				
FKU1	Port P51 input/output control bit	1	Port P51 output				
FR00	Port PEs input/output control hit	0	Port P50 input				
FKU0	Port P50 input/output control bit	1	Port P50 output				

Notes 1: "R" represents read enabled, and "W" represents write enabled.
2: The 4513 Group does not have the direction register FR0.



BUILT-IN PROM VERSION

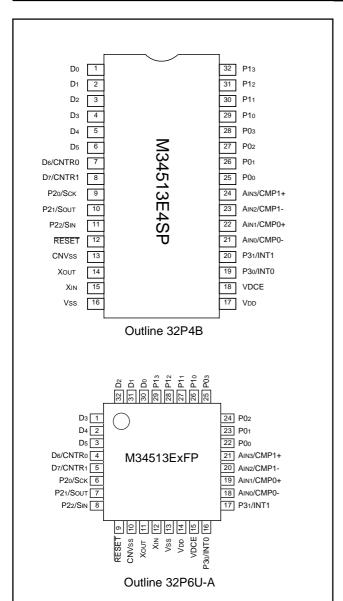
In addition to the mask ROM versions, the 4513/4514 Group has programmable ROM version software compatible with mask ROM. The built-in PROM of One Time PROM version can be written to and not be erased.

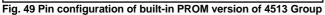
The built-in PROM versions have functions similar to those of the mask ROM versions, but they have PROM mode that enables writing to built-in PROM.

Table 25 shows the product of built-in PROM version. Figure 49 and 50 show the pin configurations of built-in PROM versions.

Table 25 Product of built-in PROM version

Product	PROM size (X 10 bits)	RAM size (X 4 bits)	Package	ROM type
M34513E4SP/FP	4096 words	256 words	SP: 32P4B FP: 32P6U-A	One Time DDOM version
M34513E8FP	8192 words	384 words	32P6B-A	One Time PROM version
M34514E8FP	8192 words	384 words	42P2R-A	[shipped in blank]





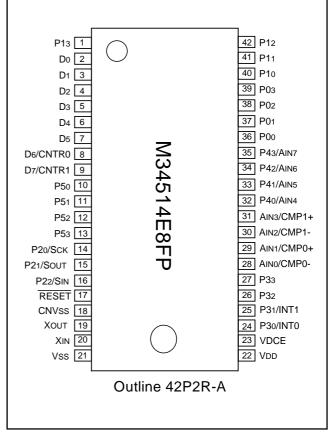


Fig. 50 Pin configuration of built-in PROM version of 4514 Group



(1) PROM mode

The built-in PROM version has a PROM mode in addition to a normal operation mode. The PROM mode is used to write to and read from the built-in PROM.

In the PROM mode, the programming adapter can be used with a general-purpose PROM programmer to write to or read from the built-in PROM as if it were M5M27C256K. Programming adapters are listed in Table 26.Contact addresses at the end of this sheet for the appropriate PROM programmer.

Writing and reading of built-in PROM
 Programming voltage is 12.5 V. Write the program in the PROM of the built-in PROM version as shown in Figure 51.

(2) Notes on handling

- ① A high-voltage is used for writing. Take care that overvoltage is not applied. Take care especially at turning on the power.
- ② For the One Time PROM version shipped in blank, Mitsubishi Electric corp. does not perform PROM writing test and screening in the assembly process and following processes. In order to improve reliability after writing, performing writing and test according to the flow shown in Figure 52 before using is recommended (Products shipped in blank: PROM contents is not written in factory when shipped).

Table 26 Programming adapters

Microcomputer	Programming adapter
M34513E4SP	PCA7442SP
M34513E4FP, M34513E8FP	PCA7442FP
M34514E8FP	PCA7441

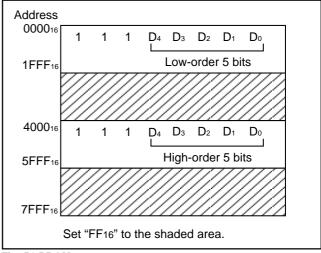


Fig. 51 PROM memory map

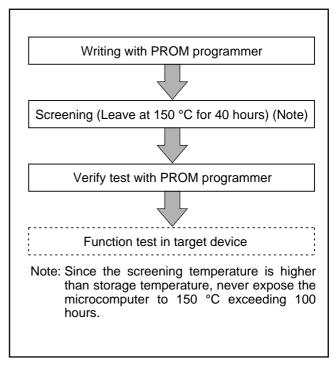


Fig. 52 Flow of writing and test of the product shipped in blank



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	С	onditions	Ratings	Unit	
VDD	Supply voltage			-0.3 to 7.0	V	
VI	Input voltage P0, P1, P2, P3, P4, P5, RESET, XIN, VDCE			-0.3 to VDD+0.3	V	
Vı	Input voltage Do-D7			-0.3 to 13	V	
Vı	Input voltage AIN0-AIN7			-0.3 to VDD+0.3	V	
Vo	Output voltage P0, P1, P3, P4, P5, RESET	0		-0.3 to VDD+0.3	V	
Vo	Output voltage D0-D7	Output transisto	rs in cut-on state	-0.3 to 13	V	
Vo	Output voltage Xout			-0.3 to VDD+0.3	V	
			Package: 42P2R	300		
Pd	Power dissipation	Ta = 25 °C	Package: 32P6U	300	mW	
			Package: 32P4B	1100		
Topr	Operating temperature range		1	-20 to 85	°C	
Tstg	Storage temperature range			-40 to 125	°C	



RECOMMENDED OPERATING CONDITIONS 1

(Mask ROM version:Ta = -20 °C to 85 °C, VDD = 2.0 V to 5.5 V, unless otherwise noted) (One Time PROM version:Ta = -20 °C to 85 °C, VDD = 2.5 V to 5.5 V, unless otherwise noted)

Cumbal	Doromotor	Condition	20	Limits			
Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
		Mask ROM version	$f(XIN) \le 4.2 \text{ MHz}$	2.5		5.5	
		Middle-speed mode	$f(XIN) \le 3.0 \text{ MHz}$	2.0		5.5	
		Mask ROM version	$f(XIN) \le 4.2 \text{ MHz}$	4.0		5.5	
			$f(XIN) \le 2.0 \text{ MHz}$	2.5		5.5	1
VDD	Supply voltage	High-speed mode	$f(XIN) \le 1.5 \text{ MHz}$	2.0		5.5	V
		One Time PROM version	f(V)) < 4.0 MHz	2.5			1
		Middle-speed mode	$f(XIN) \le 4.2 \text{ MHz}$	2.5		5.5	
		One Time PROM version	$f(XIN) \le 4.2 \text{ MHz}$	4.0		5.5	1
		High-speed mode	$f(XIN) \le 2.0 \text{ MHz}$	2.5		5.5	1
\/	RAM back-up voltage	Mask ROM version		1.8			
VRAM	(at RAM back-up mode)	One Time PROM version	ı	2.0			V
Vss	Supply voltage				0		V
VIH	"H" level input voltage	P0, P1, P2, P3, P4, P5, >	(IN, VDCE	0.8VDD		VDD	V
VIH	"H" level input voltage	D0-D7		0.8VDD		12	V
VIH	"H" level input voltage	RESET		0.85VDD		VDD	V
VIH	"H" level input voltage	CNTR0, CNTR1, Sin, Sc	κ, INT0, INT1	0.85VDD		VDD	V
VIL	"L" level input voltage	P0, P1, P2, P3, P4, P5, D	0		0.2VDD	V	
VIL	"L" level input voltage	RESET		0		0.3VDD	V
VIL	"L" level input voltage	CNTR0, CNTR1, Sin, Sc	κ, INT0, INT1	0		0.15VDD	V
1011/22212 (11712			VDD = 5.0 V	-20			T .
Iон(peak)	ı(peak) "H" level peak output current	P5	VDD = 3.0 V	-10			mA.
1011/2112	(4.19)	DE (Nata)	VDD = 5.0 V	-10			A
Iон(avg)	"H" level average output current	P5 (Note)	VDD = 3.0 V	-5			mA
lo. (= = = l-)	(II II I I I I I I I I I I I I I I I I	Do DEOFT	VDD = 5.0 V			10	A
IoL(peak)	"L" level peak output current	P3, RESET	VDD = 3.0 V			4	mA.
12. (1.)	(II II I I I I I I I I I I I I I I I I	D- D-	VDD = 5.0 V			40	
IoL(peak)	"L" level peak output current	D6, D7	VDD = 3.0 V			30	→ mA
12. (1.)	(1.11.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1	D- D-	VDD = 5.0 V			24	
IoL(peak)	"L" level peak output current	D0-D5	VDD = 3.0 V			12	→ mA
10. (1)	(4.9)	P0, P1, P4, P5, Sck,	VDD = 5.0 V			24	
IoL(peak)	"L" level peak output current	Sout	VDD = 3.0 V			12	mA.
lo. (aa.)	(i) 11 1 1	D2 DECET (Note)	VDD = 5.0 V			5	
IoL(avg)	"L" level average output current	P3, RESET (Note)	VDD = 3.0 V			2	mA
12. ()	(i) 11 1 1	Do De (Note)	VDD = 5.0 V			30	
IoL(avg)	"L" level average output current	D6, D7 (Note)	VDD = 3.0 V			15	→ mA
lo. ()	(I !! I I	Do De (Note)	VDD = 5.0 V			15	
IoL(avg)	"L" level average output current	D0-D5 (Note)	VDD = 3.0 V			7	mA.
lou (acces)	(1.2.1	P0, P1, P4, P5, SCK,	VDD = 5.0 V			12	^
IoL(avg)	"L" level average output current	Sout (Note)	VDD = 3.0 V			6	mA
ΣIOH(avg)	"H" level total average current	P5		-30			
Zlor (ove)	"I " lovel total everess surrest	P5, D, RESET, SCK, SOUT				80	mA
ΣloL(avg)	"L" level total average current	P0, P1, P3, P4				80	1

Note: The average output current (IOH, IOL) is the average value during 100 ms.



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

RECOMMENDED OPERATING CONDITIONS 2

(Mask ROM version:Ta = -20 °C to 85 °C, VDD = 2.0 V to 5.5 V, unless otherwise noted) (One Time PROM version:Ta = -20 °C to 85 °C, VDD = 2.5 V to 5.5 V, unless otherwise noted)

Symbol	Parameter	Condit	ione		Limits		Unit
Syllibol	Faiailletei	Condit	10115	Min.	Тур.	Max.	Offic
		Mask ROM version	VDD = 2.5 V to 5.5 V			4.2	
		Middle-speed mode	VDD = 2.0 V to 5.5 V			Max. 4.2 3.0 4.2 4.2 2.0 1.5 4.2 2.0 3.0 3.0	
		One Time PROM version	VDD = 2.5 V to 5.5 V			12	
f(XIN)	Oscillation frequency	Middle-speed mode	VDD = 2.5 V to 5.5 V			4.2	
I(VIIV)	(with a ceramic resonator)	Mask ROM version	VDD = 4.0 V to 5.5 V			4.2	MHz
		High-speed mode	VDD = 2.5 V to 5.5 V			2.0	
		High-speed mode	VDD = 2.0 V to 5.5 V			1.5	
		One Time PROM version	VDD = 4.0 V to 5.5 V			4.2	
		High-speed mode	VDD = 2.5 V to 5.5 V			2.0	
		Mask ROM version	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\			0.0	
		Middle-speed mode	VDD = 2.0 V to 5.5 V			3.0	
		One Time PROM version	V== 0.5.V t= 5.5.V			0.0	
	On all last transport	Middle-speed mode	VDD = 2.5 V to 5.5 V			3.0	
f(XIN)	Oscillation frequency	Mark BOM accession	VDD = 4.0 V to 5.5 V			3.0	MHz
	(with external clock input)	Mask ROM version	VDD = 2.5 V to 5.5 V			1.0	
		High-speed mode	VDD = 2.0 V to 5.5 V			0.8	
		One Time PROM version	VDD = 4.0 V to 5.5 V			3.0	
		High-speed mode	VDD = 2.5 V to 5.5 V			1.0	
		Mook DOM version	VDD = 4.0 V to 5.5 V	1.5			
		Mask ROM version	VDD = 2.0 V to 5.5 V				
		Middle-speed mode	VDD = 2.0 V to 5.5 V	4.0			μs
		One Time PROM version	VDD = 4.0 V to 5.5 V	1.5			
(0-11)	Serial I/O external clock period	Middle-speed mode	VDD = 2.5 V to 5.5 V	3.0			
tw(Sck)	("H" and "L" pulse width)	Mark BOM accession	VDD = 4.0 V to 5.5 V	750			ns
		Mask ROM version	VDD = 2.5 V to 5.5 V	1.5			
		High-speed mode	VDD = 2.0 V to 5.5 V	2.0			μs
		One Time PROM version	VDD = 4.0 V to 5.5 V	750			ns
		High-speed mode	VDD = 2.5 V to 5.5 V	1.5		4.2 3.0 4.2 2.0 1.5 4.2 2.0 3.0 3.0 1.0 0.8 3.0	μs
		Mark DOM comics	VDD = 4.0 V to 5.5 V	1.5			
		Mask ROM version	VDD = 2.5 V to 5.5 V	3.0			
		Middle-speed mode	VDD = 2.0 V to 5.5 V	4.0			μs
		One Time PROM version	VDD = 4.0 V to 5.5 V	1.5			
	Timer external input period	Middle-speed mode	VDD = 2.5 V to 5.5 V	3.0			
tw(CNTR)	R) ("H" and "I " nulse width)	Mook DOM	VDD = 4.0 V to 5.5 V	750			ns
		Mask ROM version	VDD = 2.5 V to 5.5 V	1.5			
		High-speed mode	VDD = 2.0 V to 5.5 V	2.0			μs
		One Time PROM version	VDD = 4.0 V to 5.5 V	750			ns
		High-speed mode	VDD = 2.5 V to 5.5 V	1.5			μs



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

ELECTRICAL CHARACTERISTICS

(Mask ROM version:Ta = -20 °C to 85 °C, VDD = 2.0 V to 5.5 V, unless otherwise noted) (One Time PROM version:Ta = -20 °C to 85 °C, VDD = 2.5 V to 5.5 V, unless otherwise noted)

Cymhal	F	Daramatar.	Toot oo	anditions.		Limits		- Unit	
Symbol	F	Parameter	lest co	onditions	Min.	Тур.	Max.	Unit	
Mari	#1 12 Lavel autout	veltare DC	VDD = 5 V	IOH = -10 mA	3			- v	
Vон	"H" level output	voltage P5	VDD = 3 V	IOH = -5 mA	2			\ \	
\/o.	"I" laval avitavit	uelte en DO DA DA DE	VDD = 5 V	IOL = 12 mA			2	V	
Vol	L level output	voltage P0, P1, P4, P5	VDD = 3 V	IOL = 6 mA			0.9	\ \	
Vol	"I " lovel output	voltage P3, RESET	VDD = 5 V	IOL = 5 mA			2	V	
VOL	L level output	Vollage P3, RESET	VDD = 3 V	IOL = 2 mA			0.9	\ \	
			VDD = 5 V	IOL = 30 mA			2	V	
Vol	"L" level output	voltago Do Dz	VDD = 5 V	IOL = 10 mA			0.9		
VOL	L level output	voltage D6, D7	VDD = 3 V	IOL = 15 mA			2	V	
			VDD = 3 V	IOL = 5 mA			0.9	v	
Vol	"L" level output	voltago Do De	VDD = 5 V	IOL = 15 mA			2	V	
VOL	L level output	voltage D0-D5	VDD = 3 V	IOL = 3 mA			0.9	L v	
liн	"H" level input c	urrent	VI = VDD, port P4 select	ted,			1	μA	
ш	P0, P1, P2, P3,	P4, P5, RESET, VDCE	port P5: input state			1	μ		
liH	"H" level input c	urrent D0-D7	VI = 12 V			1	μA		
lıL	"L" level input cu	urrent	VI = 0 V No pull-up of ports P0 and P1, port P4 selected, port P5: input state		_1				
IIL	P0, P1, P2, P3,	P4, P5, RESET, VDCE			-'			μΑ	
lıL	"L" level input cu	urrent Do-D7	VI = 0 V		-1			μA	
			VDD = 5 V	f(XIN) = 4.0 MHz		1.8	5.5	-	
			Middle-speed mode	f(XIN) = 400 kHz		0.5	1.5		
		at active mode	VDD = 3 V	f(XIN) = 4.0 MHz		0.9	2.7		
			Middle-speed mode	f(XIN) = 400 kHz		0.2	0.6		
			VDD = 5 V	f(XIN) = 4.0 MHz		3.0	9.0	mA	
IDD	Supply current		High-speed mode	f(XIN) = 400 kHz		0.6	1.8		
			VDD = 3 V	f(XIN) = 2.0 MHz		0.9	2.7		
			High-speed mode	f(XIN) = 400 kHz		0.3	0.9		
			Ta = 25 °C			0.1	1		
		at RAM back-up mode	VDD = 5 V				10	μP	
			VDD = 3 V				6		
-	Dull on mariatan		VDD = 5 V	V: 0.V	20	50	125		
RPU	Pull-up resistor	value	VDD = 3 V	VI = 0 V	40	100	250	k⊆	
<i>t</i> - > <i>t</i> -	Hysteresis INT0	, INT1, CNTR0, CNTR1,	VDD = 5 V			0.3		.,	
/T+ – VT–	SIN, SCK		VDD = 3 V			0.3		V	
, ,,			VDD = 5 V			1.5		.,	
VT+ – VT–	Hysteresis RESE	: I	VDD = 3 V			0.6		V	



SINGLE-CHIP 4-BIT CMOS MICROCOMPUTER

A-D CONVERTER RECOMMENDED OPERATING CONDITIONS

(Comparator mode included, Ta = -20 °C to 85 °C, unless otherwise noted)

Symbol	Parameter	Conditions		Limits		Unit
Syllibol	Farameter	Conditions	Min.	Тур.	Max.	Onit
VDD	Supply voltage		2.7		5.5	V
VIA	Analog input voltage		0		VDD	V
f(XIN)	Oscillation frequency	Middle-speed mode, VDD ≥ 2.7 V	0.8			MHz
I(XIIV)	Oscillation frequency	High-speed mode, VDD ≥ 2.7 V	0.4			MHz

A-D CONVERTER CHARACTERISTICS

(Ta = -20 °C to 85 °C, unless otherwise noted)

Cumbal	Dorometer		Test conditions		Limits		Unit
Symbol	Parameter		Min.	Тур.	Max.	Offic	
-	Resolution				10	bits	
	Line a mitter a mana	Ta = 25 °C, VDD =	= 2.7 V to 5.5 V				LSB
	Linearity error	Ta = -25 °C to 85	5 ° C, VDD = 3.0 V to 5.5 V			±2	LOB
	Differential and Property	Ta = 25 °C, VDD =	= 2.7 V to 5.5 V			0.0	LSB
_	Differential non-linearity error	Ta = -25 °C to 85	5 ° C, VDD = 3.0 V to 5.5 V			±0.9	LOD
\/o _	Zana transition valtana	VDD = 5.12 V	0	5	20	mV	
V ₀ T	Zero transition voltage	VDD = 3.072 V	0	3	15] '''	
\/===	Full cools transition valtage	VDD = 5.12 V		5105	5115	5125	mV
VFST	Full-scale transition voltage	VDD = 3.072 V		3060	3069	3075	'''
1455	A D aparating aurent	VDD = 5.0 V	f(XIN) = 0.4 MHz to 4.0 MHz		0.7	2.0	- mA
IADD	A–D operating current	VDD = 3.0 V	f(XIN) = 0.4 MHz to 2.0 MHz		0.2	0.4	111/4
Tookii	A D conversion time	f(XIN) = 4.0 MHz,	Middle-speed mode			93.0	116
TCONV	A-D conversion time	f(XIN) = 4.0 MHz, High-speed mode				46.5	μs
-	Comparator resolution	Comparator mod	е			8	bits
	Compositor array (Note)	VDD = 5.12 V				±20	mV
_	Comparator error (Note)	VDD = 3.072 V				±15	1111
-	Comparator comparison time	f(XIN) = 4.0 MHz,	Middle-speed mode			12	116
	Comparator comparison time	f(XIN) = 4.0 MHz, High-speed mode				6	μs

Note: As for the error from the ideal value in the comparator mode, when the contents of the comparator register is n, the logic value of the comparison voltage Vref which is generated by the built-in DA converter can be obtained by the following formula.

Logic value of comparison voltage Vref—

$$V_{ref} = \frac{V_{DD}}{256} \times n$$

n = Value of register AD (n = 0 to 255)

VOLTAGE DROP DETECTION CIRCUIT CHARACTERISTICS

(Ta = -20 °C to 85 °C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Тур.	Max.	Offic
VRST	Detection voltage		2.7		4.1	V
		Ta = 25 °C	3.3	3.5	3.7	
IRST	Operation current of voltage drop detection circuit	VDD = 5.0 V		50	100	μΑ



VOLTAGE COMPARATOR RECOMMENDED OPERATING CONDITIONS

(Ta = -20 °C to 85 °C, unless otherwise noted)

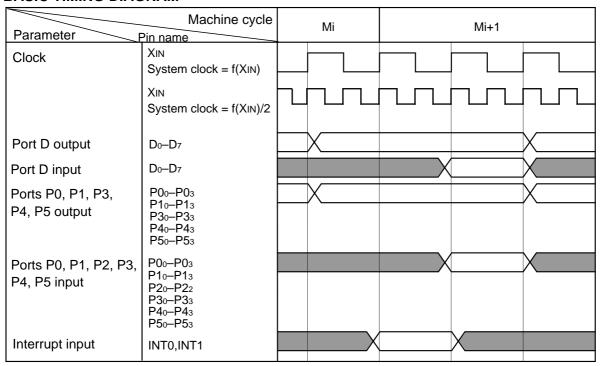
Symbol	Parameter	Conditions	Limits			Unit
			Min.	Тур.	Max.	Cill
VDD	Supply voltage		3.0		5.5	V
VINCMP	Voltage comparator input voltage	VDD = 3.0 V to 5.5 V	0.3VDD		0.7Vdd	V
tCMP	Voltage comparator response time	VDD = 3.0 V to 5.5 V			20	μs

VOLTAGE COMPARATOR CHARACTERISTICS

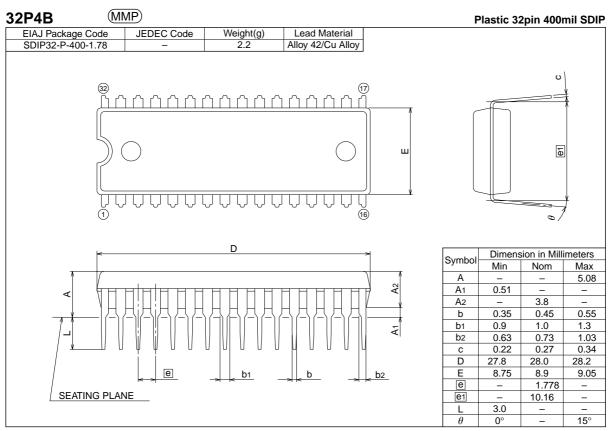
(Ta = -20 °C to 85 °C, VDD = 3.0 V to 5.5 V, unless otherwise noted)

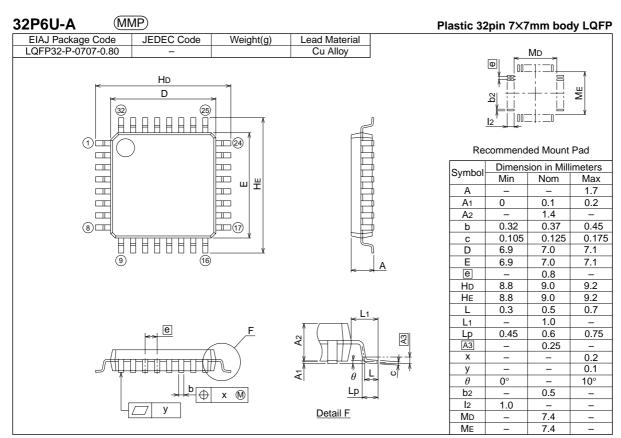
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Тур.	Max.	Oilit
-	Comparison decision voltage error	CMP0- > CMP0+, CMP0- < CMP0+ CMP1- > CMP1+, CMP1- < CMP1+		20	100	mV
ICMP	Voltage comparator operation current	VDD = 5.0 V		15	50	μΑ

BASIC TIMING DIAGRAM

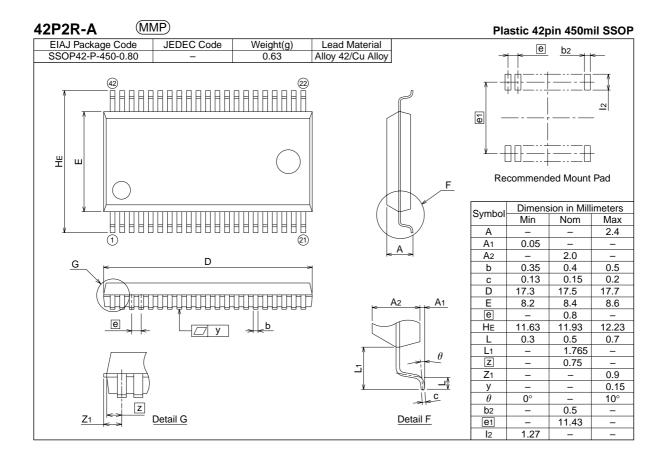


PACKAGE OUTLINE









Renesas Technology Corp.

Nippon Bldg.,6-2,Otemachi 2-chome,Chiyoda-ku,Tokyo,100-0004 Japan

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-llammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

- These materials are intended as a reference to assist our customers in the selection of the Mitsubishi semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property
- rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party.

 Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples
- Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.

 All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Mitsubishi Electric Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for the latest product information before purchasing a product listed herein.

 The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors. Please also pay attention to information published by Mitsubishi Electric Corporation assumes including the Mitsubishi Semiconductor home page (http://www.mitsubishicips.com).

 When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information contained herein.

 Mitsubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or underease repeater use.

 The prior written approval of Mitsubishi Elec

- If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved
- destination.
 Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
 Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for further details on these materials or the products contained therein.



REVISION DESCRIPTION LIST

4513/4514 GROUP DATA SHEET

Rev. No.	Revision Description	Rev. date
1.0	First Edition	980807
1.1	Page 1: APPLICATION revised, Table "Under development" eliminated.	010724
	Pages 10 to 14: PORT BLOCK DIAGRAMS revised.	
	Page 24: Fig. 17 revised.	
	Page 28: Table 9 Timer 1 structure and Timer 3 structure revised.	
	Page 29: Fig. 19 revised.	
	Page 32: (10) Count start synchronous circuit (timer 1 and 3) revised.	
	Page 38: Table 13 Slave (reception); line 6; received \rightarrow transmitted	
	Page 39: Fig. 26 AIN8 $ ightarrow$ AIN4, AIN9 $ ightarrow$ AIN5, AIN10 $ ightarrow$ AIN6, AIN11 $ ightarrow$ AIN7	
	Page 56: ROM ORDERING METHOD revised.	
	Mask ROM Order Confirmation Form, Mark Specification Form eliminated.	
	As for Mask ROM Order Confirmation Form and Mark Specification Form, refer to	
	http://www.infomicom.maec.co.jp/rom/efram/romtopf.htm	
	32P6B-A package is changed to 32P6U-A package.	
	Pages 94 and 95: All packages renewed.	